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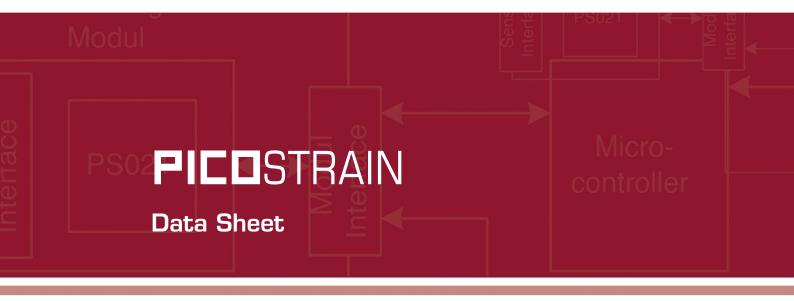
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Single Chip Solution for Strain Gauges

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## PSØ81



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1.1	Features
1.2	Advantages
1.3	Applications
1.4	General Description
1.5	Functional Block Diagram

# **FICO**STRAIN

# PSØ81

## 1 Overview

- 1.1 Features
- RMS noise:
  - 20.1nV fast settle, 5 Hz
  - 11.5 nV SINC3, 5 Hz
  - 8.9 nV SINC5, 5 Hz
- Up to 250,000 peak-peak divisions in weighing applications (2 mV/V strain)
- Scalable udapte rate from < 1 Hz to 1000 Hz
- Current consumption:
  - ~ 0.39 mA PSØ81 itself (at maximum speed)
  - ~ 0.005 mA PSØ81 itself (at low current configuration)
  - ~ 0.001 mA standby current
- Power supply voltage: 2.1 V to 3.6 V
- Converter type: Time-to-digital converter (TDC)
- Resolution: 28 bit ENOB (RMS) or 25.8 bit noise-free (peak-to-peak)
- 24-Bit internal microprocessor with 2 KB reprogrammable EEPROM
- Internal LCD controller for 4x14, 3x15 and 2x16 segments
- 4-wire serial SPI interface
- Internal very low current 10 kHz oscillator
- 6 I/O pins, configurable up to 21 inputs or 5 outputs
- Very high power supply rejection ratio (PSRR)
- Very low gain and offset drift
- Embedded charge pump for driving the LCD
- Embedded bandgap voltage reference for low battery detection
- Watchdog timer

- 1.2 Advantages
- Single-chip solution for weighing applications
- Converter, microcontroller and LCD controller in one chip
- Extreme low total system current (down to 15µA including strain gages)
- Very low self heating of teh sensor
- Gain and offset correction of the load cell
- Available as dice (115 µm pitch) or packaged (QFN56, 7x7 mm<sup>2</sup>)
- 1.3 Applications

## Industrial

- Torque wrenches
- Pressure indicators
- Legal for trade scales
- Counting scales

## Consumer

- Pure solar driven scales
- Body scales
- Kitchen scales
- Pocket scales
- Hanging scales
- Postal scales
- Package scales
- 1.4 General Description

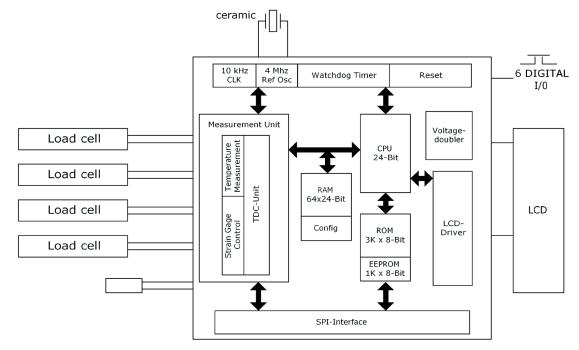
The PSØ81 is a system-on-chip for ultra lowpower and high resolution applications. It was designed especially for weight scales but fits also to any kind of force or torque measurements based on metal strain gages. It takes full advantage of the digital measuring principle of PICOS-TRAIN. Thus, it combines the performance of a 28-Bit signal converter with a 24-Bit microprocessor. Additional elements like an LCD driver, 3K ROM with many complex pre-defined functions,



2K EEPROM program memory and an integrated 10 kHz oscillator round off the device. A small amount of external components is sufficient to build a complete weighing electronic. The part operates with a power supply from 2.1V to 3.6V and has a very low current consumption. As per configuration the current consumption ranges between 0.005 mA and 0.4 mA approximately. The update rate is scalable in a wide range from < 1 Hz up to 1000 Hz. With a maximum of mor then 1 million internal divisons (28 bit ENOB RMS) the resolution lies in the top range of today's converters. This high resolution is only comparable to the one of high-end AD converters, but at a much lower current consumption. Equipped with these features, a variety of scale electronics can be served with PSØ81. On the resolution side, it allows to build scales with up to

1.5 Functional Block Diagram Figure 1.1 Block Diagram

250,000 stable peak-peak divisons (at 2mV/V)! On the other hand, a sophisticiated power management and the special features of the PICOS-TRAIN measuring principle can reduce the total current of the system down to  $15 \,\mu$ A, including the sensor current. This way, it is the first time possible to build pure solar driven weigh scales based on metal strain gages. Of course, the benefits can be combined, e.g. building a high resolution scale with a low current such as a legal for trade scale that runs more than 1.500 operating hours with 2x AA batteries. Throwing a glance at further features like software adjustment of the offset and gain compensation or the possibility to operate only one half bridge reveals that the PSØ81 opens the door to new and innovative product solutions.



## PSØ81



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# 2 Characteristics and Specifications

## 2.1 Absolute Maximum Ratings

Table 2.1 Maximum Ratings

Symbol	Parameter	Conditions	Min	Max	Unit
Vcc Vcc_load Vcc_osc Vcc_LCD	Supply voltage	Vcc vs. GND	-0.5	5.0	V
Vin	DC input voltage		-0.5	Vcc + 0.5	V
ESD Rating	FICDM	All pins	2		kV
Tstg	Storage Temperature	Plastic package	-55	150	°C

## 2.2 Normal Operating Conditions

Table 2.2 Operating Conditions

Symbol	Parameter	Conditions	Min	Max	Unit
Vcc	Supply voltage	Vcc vs. GND	2.1	3.6**	V
Vcc_load			(1.5*)		
Vcc_osc		(* without EEPROM programming,			
Vcc_LCD		voltage measurement and LCD)			
Vin	DC input voltage		0.0	Vcc	V
Vout	Output voltage		0.0	Vdd	V
Тор	Operating temperature		-40	125	°C
Tstg	Storage temperature	Plastic package	-55	150	°C

\*\* 4.5 V for highest resolution within limited temperature range

## 2.3 Electrical Characterization

Table 2.3 Electrical Characterization

Symbol	Parameter	Conditions	Min	Тур.	Max	Unit
Vil	Input low voltage	CMOS			0.3Vcc	V
Vih	Input high voltage	CMOS	0.7Vcc			
Vhyst	Input hysteresis	Vcc = 3.6 V Vcc = 3.0 V Vcc = 2.7 V Vcc = 2.2 V Vcc = 1.8 V		400 280 225 150 80		mV
Voh	Output high voltage		0.8			V
Vol	Output low voltage				0.2Vcc	V
Vlbat	Low battery voltage detect		2.2		2.9	V
LCD_COM LCD_SEG	LCD driver Voltage stabilized	lcd_vlt = 0 lcd_vlt = 1 lcd_vlt = 2		2.0 2.5 3.0		V
lq	Quiescent current	No oscillator, no TDC		150		nA
losc	Current 4 MHz oscillator continuously on	Vcc = 3.6 V Vcc = 3.0 V Vcc = 2.1 V		200 130 65		μA



## 2.4 Converter Precision

Table 2.4 Performance at Vcc = 3.3V with external comparator

	ENOB <b>dR/R</b> strain resistance				
Frequency	No filter	SINC3	SINC5		
(Hz)					
500	23.8	24.8	25.2		
250	24.4	25.2	25.7		
100	25.2	25.8	26.1		
50	25.5	26.2	26.5		
20	26.0	26.8	27.0		
10	26.6	27.4	27.7		
5	27.2	27.9	28.3		

Table 2.5 Performance at Vcc = 3.3V with external comparator, related to 2 mV/V strain (weigh scale)

	Resolution @ 2 mV/V max. out, Fast settle *						
Frequency	ENOB	Divisions	Noise nV	Noise nV			
(Hz)		effective	rms	peak-peak			
500	14.8	28,000	231	1,386			
250	15.4	44,000	148	891			
100	16.2	74,000	89	535			
50	16.5	95,000	69	416			
20	17.0	133,000	49	297			
10	17.6	200,000	33	198			
5	18.2	294,000	22	135			

\* Fast settle = without filter

Table 2.6 Performance at Vcc = 3.3V with external comparator, related to 2mV/V strain (weigh scale) With SINC3 and SINC5 filter (rolling average of 3 respectively 5)

Resolution @ <b>2 mV/V</b> max. out, <b>SINC3 Filter</b>				Resolution @ 2 mV/V max. out, SINC5 Filter				
Frequency	ENOB	Divisions	Noise nV	Noise nV	ENOB	Divisions	Noise nV	Noise nV
(Hz)		effective	rms	peak-peak		effective	rms	peak-peak
500	15.8	55,000	118	713	16.2	74,000	89	535
250	16.2	74,000	89	535	16.7	105,000	62	376
100	16.8	114,000	57	347	17.1	142,000	46	277
50	17.2	153,000	42	257	17.5	181,000	36	218
20	17.8	222,000	29	178	18.0	266,000	24	149
10	18.4	344,000	19	115	18.7	416,000	15	95
5	18.9	476,000	13	83	19.3	625,000	10	63

#### Table 2.7 Performance at Vcc = 3.3V with internal comparator

	ENOB dR/	R strain resi	ENOB <i>2mV/V</i> , <i>Fast settle</i> *	
Frequency	No filter	SINC3	SINC5	
(Hz)				
500	23.0	24.0	24.4	14.0
250	23.6	24.4	25.1	14.6
100	24.4	25.0	25.3	15.4
50	24.7	25.4	25.7	15.7
20	25.2	26.0	26.2	16.2
10	25.8	26.6	26.9	16.8
5	26.4	27.1	27.5	17.4

Table 2.8 General parameters

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
INL	Integral Non-linearity	Supply Voltage 3.0V to 3.6V		0.01*		μV/V
	Offset drift Gain drift over -20°C +70°C	Total system, 350 Ω SG Full-bridge Wheatstone Total System. 350 Ω SG, 5V		± 10 < 1 ~ 1		nV/V/K nV/V/K ppm/K
PSSR	Power Supply Rejec- tion Ratio Vcc	1.8V or 3.3 V +-0.3 V	106 @1.8V	130 @3.3V		dB

\* equals to ± 1.25 ppm of A/D-Converters with PGA setting 128

\* \* using full bridge wiring for minimum zero drift

#### 2.5 Integral Nonlinearity

The integral nonlinearity (INL) of PSO81 can be specified to  $\pm$  0.01 µV (1.25 ppm). Expressed in divisions this corresponds to  $\pm$  1: 200,000. This is a tremendous high linearity compared to the one of nowadays latest A/D converters. Ordinary A/D converts have a linearity in the range of  $\pm$  0.12µV/V (15 ppm), better A/D converters reach a linearity of  $\pm$  0.4 µV (5ppm).

Of course, you can only determine the linearity of the electronics itself, if you can provide a sensor which is accurate and linear enough to measure it. We used for this purpose the revised version of the acam load cell simulator (ALCS350-V2) which offers comfortable methods to investigate not only the linearity, but also variations over temperature or voltage. The linearity of ALCS350-V2 is  $\pm$  0.01  $\mu$ V/V (1:200,000) with PICOSTRAIN wiring and  $\pm$  0.04  $\mu$ V/V with Wheatstone wiring and therefore much more linear than an ordinary load cell. Linearity investigations with the PS081 and the ALCS350-V2 as a sensor are shown in the following tables. More details about the possibilities and the limitations of the load cell simulator are provided in the ALCS350-V2 datasheet.





Figure 2.1 Non-linearity over supply voltage

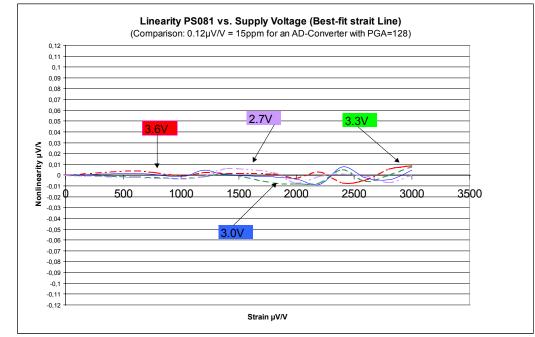
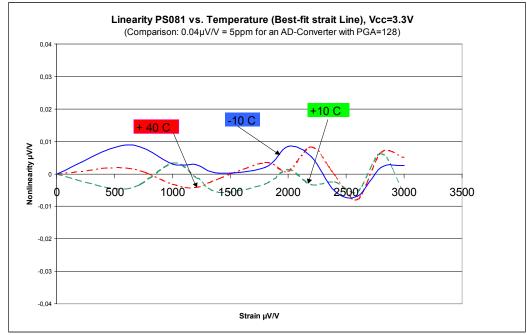


Figure 2.2 Non-linearity over temperature



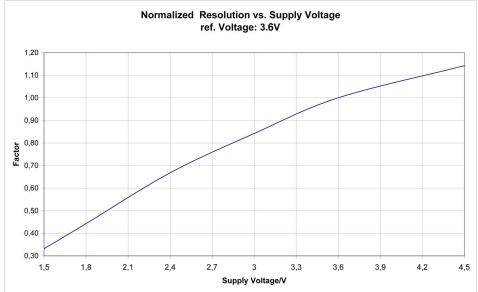
#### Note:

Best linearity is achieved with a supply voltage in the range of 3.0 V to 3.6 V. The linearity also depends on the setting for the cycle time. The measurements shown above are done with a cycle time setting of cytime = 85 (equals  $170 \ \mu$ s).

## PSØ81

## 2.6 Resolution vs. Supply Voltage

PSØ81 can be driven over a very large supply voltage range. The resolution depends on the supply voltage. The higher the supply voltage the higher the achievable resolution. The diagram below shows the resolution vs. supply voltage which can be achieved with PSØ81. The values refer to 3.6 V. Figure 2.3 Resolution vs. supply voltage



Following diagram shows how the input equivalent noise depends on the supply voltage. The lowest input noise is archived between 2.4 V and 3.6 V. The maximum differential input voltage (e.g. 6.6 mV @ 2mV/V and 3.3 V supply voltage) divided by the input noise gives the effective resolution.

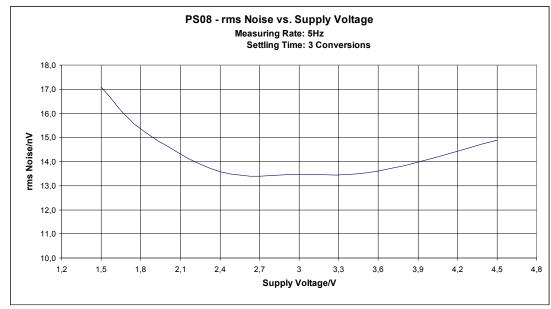


Figure 2.4 RMS-noise vs. supply voltage



## 2.7 Current Consumption

The following table shows the total system current of the scale (including current through sensor)

Divisions *	Update Rate	Double Tara *	Operating C	urrent @ 3V	Scale type	Operating hours
2,000	3 Hz	1 mV/V	1 kOhm	15 μΑ	Solar	
2,000	5 Hz	1 mV/V	1 kOhm 350 Ohm	30 μΑ 70 μΑ	Postal, Body, Kitchen , Pocket	3,000 hours (1xCR2032)
5,000	5 Hz	1 mV/V	1 kOhm 350 Ohm	80 μΑ 180 μΑ	High-end postal, Kitchen, Pocket	1,500 hours (1xCR2032)
10,000	5 Hz	1 mV/V	1 kOhm 350 Ohm	300 μA 700 μA	High-end pocket, Coun- ting	2,000 hours (1xCR2430)
80,000	5 Hz	2 mV/V	1 kOhm 350 Ohm	1.9 mA 4.5 mA	Counting	1,500hours 2 x AA

Table 2.9 Current consumption at different resolutions

\* Divisions are peak-peak values with 5 Sigma (e.g. 80.000 divisions are 400.000 bits of effective resolution)

#### 2.8 Timings

All timings specified at 3.3V  $\pm$ 0.3V, Ta  $-40^{\circ}$ C to  $+85^{\circ}$ C unless otherwise specified.

#### Table 2.10 Oscillator timing

Symbol	ymbol Parameter		Тур	Max	Units
Clk10kHz	10 kHz reference oscillator		10		kHz
CIkHS	High-speed reference oscillator		4		MHz
toHSst	Oscillator start-up time with ceramic resonator		50	150	μs

#### Table 2.11 Serial Interface Timing (SPI)

Symbol	Parameter	Min	Тур	Max	Units
fclk	Serial clock frequency			1	MHz
tpwh	Serial clock, pulse width high	500			ns
tpwl	Serial clock, pulse width low	500			ns
tsussn	SSN enable to valid latch clock	500			ns
tpwssn	SSN pulse width between write cycles	500			ns
thssn	SSN hold time after SCLK falling				
tsud	Data set-up time prior to SCLK falling	30			ns
thd	Data hold time before SCLK falling	30			ns
tvd	Data valid after SCLK rising				ns

## Serial Interface (SPI compatible, Clock Phase Bit = 1, Clock Polarity Bit = 0)

Figure 2.5 SPI - Write access

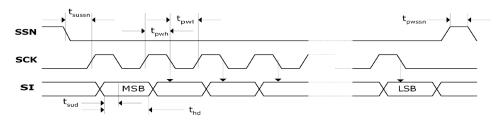
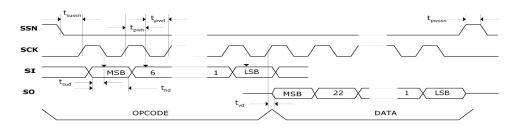


Figure 2.6 SPI-Read access



## 2.9 Pin Assignment

PSØ81 is avaliable as Die or in QFN56 package. The following pictures and tables show the pin assignment and the pin description.

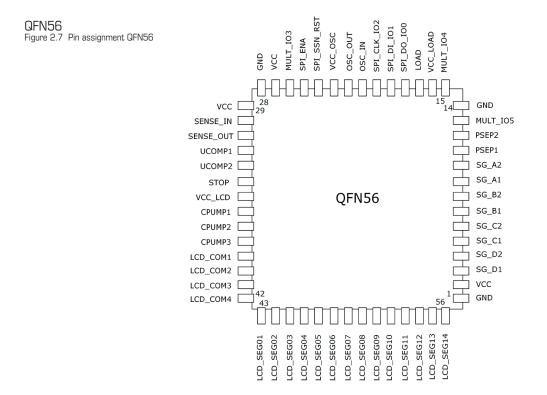






Table 2.12 Pin Description QFN56

#QFN	Name	Description	Туре	
1	GND	Ground		
2	Vcc	Supply voltage digital part , I/O, 4MHz-osc.		
3	SG_D1	B_D1 Port 1 halfbridge D N Op		
4	SG_D2	Port 2 halfbridge D	N Open Drain	
5	SG_C1	Port 1 halfbridge C	N Open Drain	
6	SG_C2	Port 2 halfbridge C	N Open Drain	
7	SG_B1	Port 1 halfbridge B	N Open Drain	
8	SG_B2	Port 2 halfbridge B	N Open Drain	
9	SG_A1	Port 1 halfbridge A	N Open Drain	
10	SG_A2	Port 2 halfbridge A	N Open Drain	
11	PSEP1	Port 1 temperature measurement	N Open Drain	
12	PSEP2	Port 2 temperature measurement	N Open Drain	
13	MULT_I05	Multi purpose I/O no. 5	Mult-IO	
14	GND	Ground		
	1			
15	MULT_IO4	Multi purpose I/O no. 4	Mult-IO	
16	Vcc_load	Power supply load output pin		
17	Load	Load output to measuring capacitor	P Open Drain	
18	SPI_DO_IOO	Output serial SPI interface or IOO	Mult-IO	
19	SPI_DI_IO1	Input serial SPI interface or IO1	Mult-IO	
20	SPI_CLK_IO2	Clock serial SPI interface or IO2	Mult-IO	
21	OSC_IN	Input to 4MHz ceramic resonator		
22	OSC_OUT	Output to 4MHz ceramic resonator		
23	VCC_OSC	4MHz Oscillator supply voltage		
24	SPI_CSN_RST SPI_SSN_RST	Slave select or RST input (High active)	Input with pull-down	
25	SPI_ENA	Serial SPI interface enable		
26	MULT_IO3	Select for Wheatstone comparator MUX or Interrupt or Multi purpose I/O no. 3	Wheatstone select Mult-IO	
27	Vcc	Supply voltage digital part , I/O, 4MHz-osc.		
28	GND	GND		
29	Vcc	Supply voltage digital part , I/O, 4MHz-osc.		
29 30	SENSE IN	Input internal CMOS comparator, connect to Vcc if not	Analog In	
30		used		
31	SENSE_OUT	Output internal CMOS comparator	Analog Out	
32	UCOMP1	External comparator circuit connection	Analog Out	
33	UCOMP2	External comparator circuit connection	Analog Out	
34	STOP	Stop input measuring signal		
35	VCC_LCD	Supply voltage LCD, 10kHz osc., bandgap		
36	CPUMP1	LCD voltage doubling and stabilization	Analog Out	
37	CPUMP2	LCD voltage doubling and stabilization	Analog Out	
38	CPUMP3	LCD voltage doubling and stabilization	Analog Out	
39	LCD_COM1	LCD line driver for 1/2, 1/3, 1/4 duty	LCD Buffer	

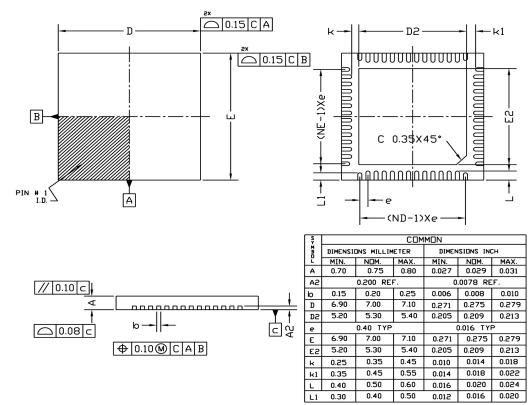
40	LCD_COM2	LCD line driver for 1/2, 1/3, 1/4 duty	LCD Buffer
41	LCD_COM3	LCD line driver for 1/3, 1/4 duty, row driver for 1/2 duty	LCD Buffer
42	LCD_COM4	LCD line driver for 1/4 duty, row driver for 1/2, 1 /3 duty	LCD Buffer
43	LCD_SEG1	LCD row driver	LCD Buffer
44	LCD_SEG2	LCD row driver	LCD Buffer
45	LCD_SEG3	LCD row driver	LCD Buffer
46	LCD_SEG4	LCD row driver	LCD Buffer
47	LCD_SEG5	LCD row driver	LCD Buffer
48	LCD_SEG6	LCD row driver	LCD Buffer
49	LCD_SEG7	LCD row driver	LCD Buffer
50	LCD_SEG8	LCD row driver	LCD Buffer
51	LCD_SEG9	LCD row driver	LCD Buffer
52	LCD_SEG10	LCD row driver	LCD Buffer
53	LCD_SEG11	LCD row driver	LCD Buffer
54	LCD_SEG12	LCD row driver	LCD Buffer
55	LCD_SEG13	LCD row driver	LCD Buffer
56	LCD_SEG14	LCD row driver	LCD Buffer

**PSØ81** 

## QFN56 Package Outline

QFN56, 7x7 mm<sup>2</sup>, 0.4mm Pitch

Figure 2.8 Package outline (QFN56)

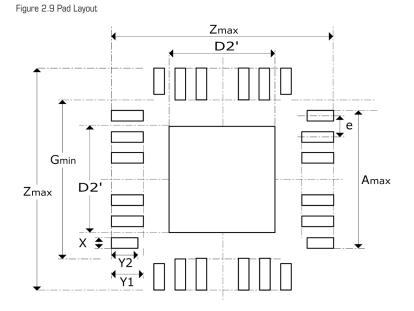




## QFN56 Recommended Pad Layout

		mm	inch
е	=	0.4	0.016
Gmin	=	6.3	0.248
Zmax	=	8.0	0.315
D2'	=	5.4	0.213
Amax	=	5.45	0.215
Х	=	0.25	0.010
Y1	=	0.85	0.033
Y2	=	0.75	0.030

Note: Size of ground plane may not be reduced. It should not contain any vias.



RoHS:	PSO81FN in QFN56 is Ro	HS compliant		
	Material list:	Lead frame		C194 Cu with PPF finish (NiPdAU)
		Die Attach		Ablebond 8600, ABlestik
		Bond wires		Gold
		Mold		CEL9220HF13H, Hitachi
		Marking	Laser	
Moisture Sensiti	ivity Level 1 (JEDEC J-STD	-020,033)		

Reflow Soldering Profile	Average ramp-up rate (TL to Tp)	3 °C/second max.	
	Preheat		
	- Temperature Min (TSmir	ו) 140 °C	
	- Temperature Max (TSma	) XE	200 °C
	- Time (min to max) ts		60 - 120 seconds
	Tsmax to TL		
	- Ramp-up rate		3 °C/second max.
	Time maintained above:		
	- Temperature (TL)		220 °C
	- time (tL)		30 seconds
	Peak Temperature (Tp)	245 +0	) -5 °C
	Time within 5°C of actual	Peak 10 sec	onds

Figure 2.10 Pad assignment Die

Die

SPI\_SSN\_RST SPI\_CLK\_I02 SPI\_DI\_IO1 SPI\_D0\_IO0 MULT\_IO3 SPI\_ENA LOAD1 VCC\_LOAD GND 18 18 VCC\_OSC OSC\_OUT OSC\_IN LOAD2 VCC GND GND PS081 34 17 MULT\_IO5 35 VCC vcc VCC PSEP2 SENSE\_IN PSEP1 SENSE\_OUT GND UCOMP1 SG\_A2 UCOMP2 PS081 Dice SG\_A1 STOP GND GND SG\_B2 VCC\_LCD 3470µm x 2370µm SG\_B1 CPUMP1 CPUMP2 CPUMP3 GND SG\_C2 SG\_C1 LCD\_COM1 LCD\_COM2 GND SG\_D2 LCD\_COM3 SG\_D1 GND 52 66 1 vcc 51 LCD\_COM4 LCD\_SEG7 LCD\_SEG8 LCD\_SEG9 LCD\_SEG10 LCD\_SEG10 LCD\_SEG11 LCD\_SEG12 LCD\_SEG13 LCD\_SEG14 LCD\_SEG1 LCD\_SEG2 LCD\_SEG3 LCD\_SEG4 LCD\_SEG5 LCD\_SEG5 GND coordinates х zero-point

Table 2.13 Pad assignment and location Die

#Pad	Name	Description	Туре	X-Pos Center	Y-Pos. Center
Right	L		1		
1	VCC	Supply voltage digital part, I/O, 4MHz-osc.		3392	193.8
2	SG_D1	Port 1 halfbridge D	N Open Drain	3392	316
3	SG_D2	Port 2 halfbridge D	N Open Drain	3392	431
4	GND	Ground		3392	546
5	SG_C1	Port 1 halfbridge C	N Open Drain	3392	661
6	SG_C2	Port 2 halfbridge C	N Open Drain	3392	776
7	GND	Ground		3392	891
8	SG_B1	Port 1 halfbridge B	N Open Drain	3392	1006
9	SG_B2	Port 2 halfbridge B	N Open Drain	3392	1121
10	GND	Ground		3392	1236
11	SG_A1	Port 1 halfbridge A	N Open Drain	3392	1351
12	SG_A2	Port 2 halfbridge A	N Open Drain	3392	1466
13	GND	Ground		3392	1581
14	PSEP1	Port 1 temperature measurement	N Open Drain	3392	1696
15	PSEP2	Port 2 temperature measurement	N Open Drain	3392	1811
16	VCC	Supply voltage digital part , I/O, 4MHz-osc.		3392	1926
17	MULT_I05	Multi purpose I/O no. 5	Mult-IO	3392	2151
Тор					
18	MULT_IO4	Multi purpose I/O no. 4	Mult-IO	2862	2286
19	GND	Ground		2730	2286
20	VCC_LOAD	Power supply load output pins 1 and 2		2115	2286
21	LOAD1	Load output to measuring capacitor	P Open Drain	1976.6	2286
22	LOAD2	Load output to measuring capacitor	P Open Drain	1835	2286
23	SPI_DO_IOO	Output serial SPI interface or IOO	Mult-IO	1656.2	2286
24	SPI_DI_IO1	Input serial SPI interface or IO1	Mult-IO	1544.2	2286

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25	SPI_CLK_IO2	Clock serial SPI interface or IO2	Mult-IO	1432.2	2286
26	GND	Ground		1320.2	2286
27	OSC_IN	Input to 4MHz ceramic resonator		1208.2	2286
28	OSC_OUT	Output to 4MHz ceramic resonator		1096.2	2286
29	VCC_OSC	4MHz Oscillator supply voltage		984.2	2286
30	SPI_CSN_RST SPI_SSN_RST	Slave select or RST input (High active)	Input with pull-down	872.2	2286
31	SPI_ENA	Serial SPI interface enable		760.2	2286
32	MULT_IO3	Select for Wheatstone comparator MUX or Interrupt or Multi purpose I/O no. 3	Wheatstone select Mult-IO	648.2	2286
33	GND	Ground		536.2	2286
34	Vcc	Supply voltage digital part , I/O, 4MHz-osc.		424.2	2286
Left					
35	Vcc	Supply voltage digital part , I/O, 4MHz-osc.		83	2003.3
36	Vcc-SENSE	Supply voltage SENSE pins		83	1891.3
37	SENSE_IN	Input internal CMOS comparator, connect to Vcc if not used	Analog In	83	1779.3
38	SENSE_OUT	Output internal CMOS comparator	Analog Out	83	1667.3
39	UCOMP1	External comparator circuit connection	Analog Out	83	1555.3
40	UCOMP2	External comparator circuit connection	Analog Out	83	1443.3
41	STOP	Stop input measuring signal		83	1331.3
42	GND	Ground		83	1219.3
43	VCC_LCD	Supply voltage LCD, 10kHz osc., bandgap		83	1045
44	CPUMP1	LCD voltage doubling and stabilization	Analog Out	83	933
45	CPUMP2	LCD voltage doubling and stabilization	Analog Out	83	821
46	CPUMP3	LCD voltage doubling and stabilization	Analog Out	83	709
47	LCD_COM1	LCD line driver for 1/2, 1/3, 1/4 duty	LCD Buffer	83	597
48	LCD_COM2	LCD line driver for 1/2, 1/3, 1/4 duty	LCD Buffer	83	485
49	LCD_COM3	LCD line driver for 1/3, 1/4 duty, row driver for 1/2 duty	LCD Buffer	83	373
50	GND	Ground		83	261
51	LCD_COM4	LCD line driver for 1/4 duty, row driver for 1/2, 1 /3 duty	LCD Buffer	83	149
Bottom	l				
52	LCD_SEG1	LCD row driver	LCD Buffer	612.6	83
53	LCD_SEG2	LCD row driver	LCD Buffer	724.6	83
54	LCD_SEG3	LCD row driver	LCD Buffer	836.6	83
55	LCD_SEG4	LCD row driver	LCD Buffer	948.6	83
56	LCD_SEG5	LCD row driver	LCD Buffer	1060.6	83
57	LCD_SEG6	LCD row driver	LCD Buffer	1172.6	83
58	LCD_SEG7	LCD row driver	LCD Buffer	1347	83
59	LCD_SEG8	LCD row driver	LCD Buffer	1459	83
60	LCD_SEG9	LCD row driver	LCD Buffer	1571	83
61	LCD_SEG10	LCD row driver	LCD Buffer	1683	83
62	LCD_SEG11	LCD row driver	LCD Buffer	1795	83
63	LCD_SEG12	LCD row driver	LCD Buffer	1907	83
64	LCD_SEG13	LCD row driver	LCD Buffer	2019	83
65	LCD_SEG14	LCD row driver	LCD Buffer	2131	83
66	GND	Ground		2928	83



Dimensions and Pad Opening

The exact Die size is 2.37 x 3.47 mm, the Wafer thickness 725 $\mu$ m. The IC is expected to be used predominantly as Chip On Board (COB). Therefore it is essential to have a Pad Opening that is suitable for bonding machines: Width: 90 $\mu$ m

Height: 116µm



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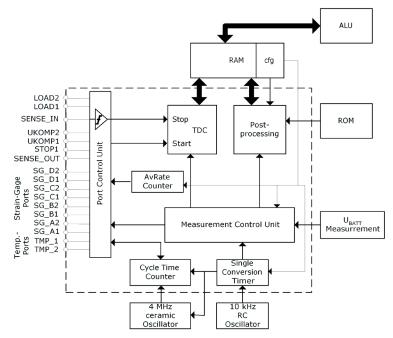
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## PSØ81

## 3 Converter Front End

3.1 Overview

Figure 3.1 Overview

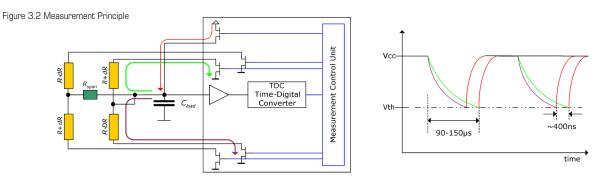


The PICOSTRAIN based converter has the strain gage ports (SG\_Ax to SG\_Dx) to measure:

- 4 independent half bridges (quattro mode)
- 2 half bridges that form a full bridge
- 2 independent half bridges
- 1 classical Wheatstone bridge
- 1 single half bridge

## 3.2 Measurement Principle

The strain itself is measured by means of discharge time measurements. The discharge time is defined by the strain gauge resistance and the capacitor Cload. Both, the strain gauge with positive change and the one with negative change are measured. The ratio of the two discharge times provides the strain information. The precision of the time measurement is done with about 15 ps resolution (0.5 ps with averaging).





This chapter will explain the components of the front-end, the parameters to set and how to dimension external components.

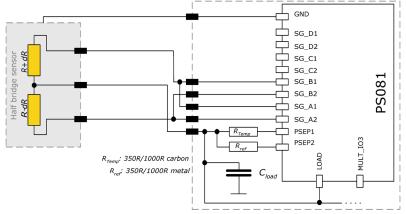
There are many ways to connect your strain gage sensor to  $PS\emptyset 81$ . In this section we show how to connect them.

#### 3.3 Connecting the Strain Gauges

Caution: To get good results it is mandatory to connect the load cell body to GND of the electronic. A simple standard wire is sufficient.

#### 3.3.1 Half Bridge

Figure 3.3 Connecting a half bridge



#### Note:

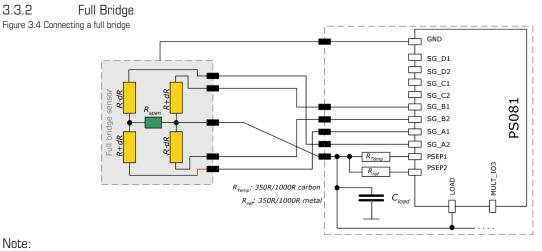
The half bridge is connected like a full bridge to get a better zero drift behavior. This requires the bridge setting = 1 (register 3, bridge[1:0] = 1)

The multiplication factors should have positive sign, e.g.  $Mult_Hb1 = +1$ ,  $Mult_Hb2 = +1$ . With this kind of connection the zero drift of the electronic is the same as in full bridge mode and deeply within OIML specification.

For maximum speed it may be helpful to connect the half bridge as a half bridge and not as a full bridge (register 3, bridge[1:0] = 0, pins SG\_A1 & SG\_A2 only). With AVRate = 2 the maximum speed is possible and up to 1 kHz can be reached. An additional systematic zero drift will occur which is nearly the same on all devices. The value of this zero drift is approx.  $\pm$  6 nV/V/K. This zero drift is a result of a longer bond wire on SG\_A2 compared to SG\_A1. The bond wire resistance is not compensated by the RDSON compensation of the chip. Therefore, this systematic drift can be compensated on the PCB by a longer wire on SG\_A1.

When using a standard PCB with cooper layers 35 µm thick, the SG A1 trace on the PCB from the chip to the connecting pads of the load cell should be (t.b.d.) mm longer than the SG\_A2 trace (if a width of 8 mil is used). This compensation method is very reliable and stable an gives a zero drift behavior deeply within OIML specifications.

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Note:

3.3.2

This is the standard PICOSTRAIN bridge (a full bridge made of 2 half bridges with a single Rspan resistor optionally). The bridge setting is 1 (register 3, bridge[1:0] = 1).

The multiplication factors should have positive sign, e.g.  $Mult_Hb1 = +1$ ,  $Mult_Hb2 = +1$ . Therefore, it is necessary to follow exactly the wiring with respect to positive and negative strain.

Existing sensors with Wheatstone bridge connection can be adopted easily by changing the wiring in the patch-field of the load cell as shown in the following picture:

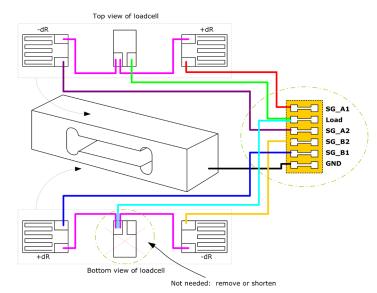


Figure 3.5 Adapted load cell wiring



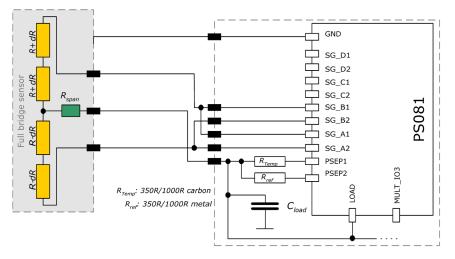
The advantage of the PICOSTRAIN full bridge compared with the Wheatstone bridge is a higher resolution of approximately 0.6 bits (factor 1.5 higher).

## 3.3.3 Full Bridge Parallel (zero drift optimized)

This mode is not recommended any longer (canceled in December 2009). Please see bug report (Section 7.1) for further details.

## 3.3.4 Full Bridge connected as Half Bridge (Current Saving Connection)

Figure 3.6 Current saving full bridge wiring



## Note:

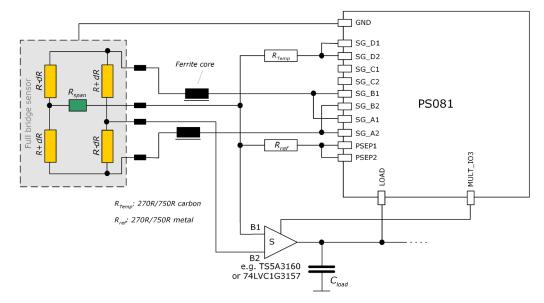
This wiring is suited if all strain gages are on the same site (top OR bottom) of the load cell. Then 2 strain gage resistors can be connected in series to get a 2 kOhm half bridge. This way, the current into the sensor is reduced by factor 2 and therefore this wiring is especially suited for minimum current e.g. solar driven applications.

The bridge setting is 1 (register 3, bridge[1:0] = 1). The multiplication factors should have positive sign, e.g.  $Mult_Hb1 = +1$ ,  $Mult_Hb2 = +1$ .

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## 3.3.5 Wheatstone Bridge

Figure 3.7 Connecting a Wheaston bridge



For Wheatstone bridges an additional external analog switch is needed. We recommend TS5A3160 because it has a good behavior even at supply voltages lower than 2.7 V. For supply voltages of 3.0 V or higher 74LVC1G3157 is a good choice, too.

Note:

In Wheatstone mode the system looses 0.6 bit of resolution. Because of this, Wheatstone connection is only recommended for applications with long wires (> 1 m) and for first tests if you don't want to modify your load cell wiring.

The bridge setting is 1 (register 3, bridge[1:0] = 1).

The multiplication factors must have opposite sign, e.g.  $Mult_Hb1 = +1$ ,  $Mult_Hb2 = -1$ .

If the Wheatstone bridge has a gain compensation resistor (Rspan) the standard setting for TKGain is 0.75 (ConfigReg08). The factor 0.75 doesn't modify the span compensation behavior of the load cell. In any case "Mod\_Rspan" has to be set to 1 (ConfigReg01, Bit 6)

To avoid reflections in the Wheatstone bridge we do strongly recommend the use of ferrite cores.

They are placed in the two lines which are connected directly to PSO81. Ordinary (SMD-)ferrite cores with a damping of 1000hm @ 100MHz with a low DC resistance (<0.10hm) can be used. As a consequence a lower offset drift and better EMI behavior can be expected.

#### Caution:

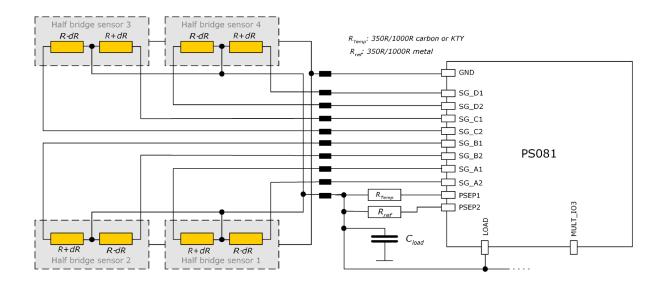
Only Wheatstone bridges with one Rspan or without Rspan (uncompensated) can be used. PICOS-TRAIN cannot work properly with Wheatstone bridges that have two Rspan.





## 3.3.6 Quattro Bridge (4 sensors)

Figure 3.8 Connecting a quattro bridge



In some cases four sensors are used. Then, each half bridge is connected to one port. This is a typical connection e.g. for quattro body scales. The result of each half bridge can be read but also the overall result.

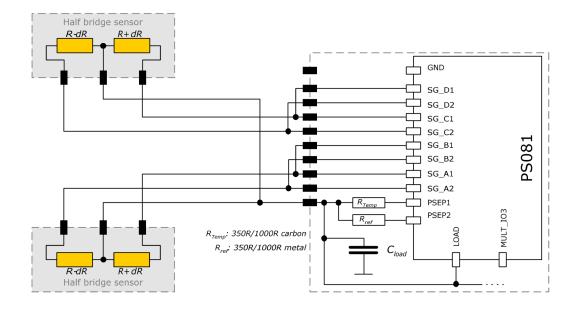
The bridge setting is 3 (register 3, bridge[1:0] = 3).

Each half bridge is assigned its own multiplication factor. This allows to trim the gain of the four load cells just by software. All multiplication factors should have positive sign, e.g.  $Mult_Hb1 = +1$ ,  $Mult_Hb2 = +1$ ,  $Mult_Hb3 = +1$ ,  $Mult_Hb4 = +1$ .

## PSØ81

#### 3.3.7 2 Half Bridges separately

Figure 3.9 Connecting 2 separate half bridges



Note:

Normally, two half bridges are wired as full bridge (one result). Nevertheless, sometimes the result of the half bridge is of interest and the two half bridges shall be measured separately. In this case, the two half bridges can be connected in the quattro mode as shown in the picture above and so the results can be read separately. Connecting this way guarantees that the results are gain-compensated. The result of each half bridge can be calculated then as follows:

HB1 = (A-B) / 2 and HB2 = (C-D) / 2.

If you want to read 2 half bridges separately but with a low offset drift, please connect like suggested in ,Full bridge' and contact the acam team for further steps.

The bridge setting is 3 (register 3, bridge[1:0] = 3).

All multiplication factors should have positive sign, e.g. Mult\_Hb1 = +1, Mult\_Hb2 = +1, Mult\_Hb3 = +1, Mult\_Hb4 = +1.





## 3.3.8 6-wire Technology

PSO81 may be connected to the load cell also in 6-wire technology. Figures 3.11 and 3.12 show the wiring. 6-wire technology is used to compensate the resistance of the sensor cable. With PSO81 the cable resistance is compensated as part of the comparator gain compensation (Mult\_PP, see also section 3.6.2).

Figure 3.10 6-wire technology with PICOSTRAIN wiring

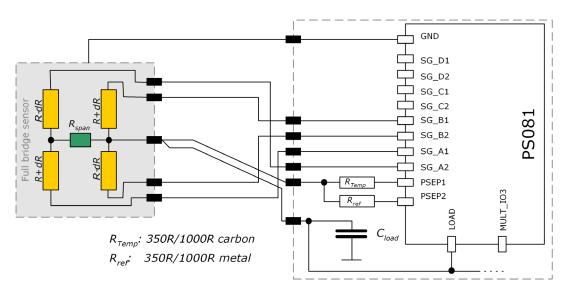
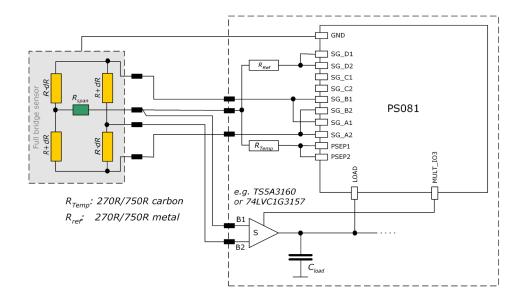


Figure 3.11 6-wire technology with Wheatstone wiring



## 3.4 Capacitor, Cycle Time, Averaging

3.4.1 Load Capacitor (Cload)

The load capacitor is an important part of the circuit and has direct influence on the quality of the measurement and the temperature stability. Therefore, we recommend the following values and materials:

Rsg = 350R ──► Cload = 300nF to 400nF
Rsg = 1000R ──► Cload = 100nF to 150nF

Cload can be calculated by = 0.7 x Rsg x Cload  $\approx~100~\mu s - 150~\mu s$ 

## Recommended materials:

- COG\* for highest accuracy
- CFCAP good, but not as good as COG
- X7R with some minor losses in temperature stability
- Polyester with some minor losses in temperature stability

We do not recommend the use of ZOG capacitors !

 $^{\ast}$  COG capacitor up to 100nF are available by Murata GRM31 series

\*\* Multi layer ceramic capacitor from Taiyo Yuden

#### Note:

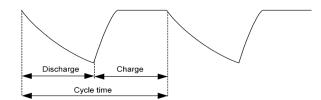
COG capacitors are definitely the best choice for high end applications (e.g. 6000 divisions (or higher) legal-for-trade scales). CFCAP are also a good choice for high end scales and legal-for-trade scales. For consumer scales X7R are the first choice because of their low cost. But they introduce additional gain drift at lower temperatures ( < +5 °C ).

For consumer applications also a lot of other capacitors are well suited (e.g. Polyester).

## 3.4.2 Cycle Time (cytime)

The cycle time is the time interval between subsequent discharge time measurements. It covers the discharge time and the time to charge again Cload. Following figure illustrates this relation.

Figure 3.12 Cycle time





The discharge time is given by the value of the strain gage resistor and the given capacitor Cload. The recommended discharge time is in the range of 80 to 150  $\mu$ s (at 3.3V). The charge time has to be long enough to provide a full recharge of Cload and is typically 30% of the cycle time. If the cycle time is set too small (in the range of the discharge time or smaller) an overflow will occur.

The cycle time is set in register 2, cytime[13:4]. The cycle time is normally generated by the high speed clock and can be set in steps of 2  $\mu$ s. The only exception is the "Stretched Mode" (see chapter ,Modes' 3.5) where the cycle time is generated by the internal 10 kHz oscillator and therefore configurable in steps of 100  $\mu$ s.

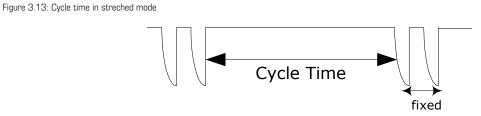
#### Example:

cytime[13:4] = 80	$\rightarrow$	$80 \times 2 \mu s = 160 \mu s$ cycle time in all modes except stretched mode
cytime[13:4] = 10	$\rightarrow$	10 x 100 $\mu$ s = 1 ms cycle time in stretched mode

The recommended minimum cycle time setting is 1.4 times the discharge time. E.g. 140  $\mu s$  if the discharge time is 100  $\mu s.$ 

## 3.4.3 Cycle Time in Stretched Mode

In stretched mode the parameter cyctime has a special function. In this case, it does NOT define the time of discharging + charging, instead it defines the time between 2 discharging cycles in multiples of 100  $\mu$ s:



There are several parameters to adjust in stretched mode. Please have a look at Stretched Mode settings in section 3.5.3.

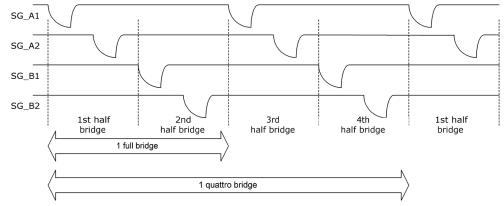
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## 3.4.4 Averaging (avrate)

The number of strain gages respectively half bridges connected defines how many discharging cycles are needed to make one complete ratio measurement:

Half bridge	$\rightarrow$	2 cycles
Full bridge	$\rightarrow$	4 cycles
Quattro bridge	$\rightarrow$	8 cycles

Figure 3.14 Discharge cycles for a complete measurement

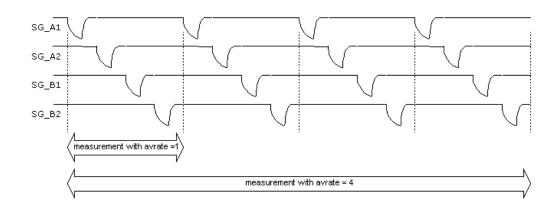


Those numbers of cycles for each mode together define 1 sample (avrate=1). This is also the minimum needed for one complete ratio measurement.

#### 3.4.5 Better resolution by averaging

In PSO81, the resolution can be increased by internal averaging. The sample size of the averaging is specified by parameter avrate in register 2. The standard deviation of the result will be improved by nearly the square root of the sample size. The following picture shows the correlation for a full bridge:

Figure 3.15 Averaging





One sequence in this example is made of 4 samples, each made of 4 discharge cycles. So in total 1 measurement takes 16 discharge cycles.

Besides the discharging cycles given by the sample there are additional measurements like gain compensation or fake measurements for better stability. All those measurements together form in total then a measurement sequence. In other words, a sequence contains all measurements needed to get the final result. It also defines the total conversion time. For more details on conversion time please see the chapters ,Conversion Time' 3.5.5 and ,Modes' 3.5.

Of course, the sample size of averaging dominates the update rate. While the resolution is improved by a factor  $1/\sqrt{a}$  averate, the maximum update rate is reduced by the factor averate.

sample size (avrate)  $\nearrow \rightarrow$  Resolution  $\nearrow$ 

 $\rightarrow$  Max. update rate  $\searrow$ 

Also the lowest possible current consumption is influenced by the sample size. It grows by a factor avrate.

sample size (avrate)  $\nearrow \rightarrow$  Minimum current

Recommendation: We strongly recommend not to use avrate = 1. In principle it works but the drift significantly increases and it can be used only for low end resolution applications. The recommended minimum sample size is avrate = 2. It is also not recommended to use odd numbers at lower avrate up to 50. E.g., do not use avrate = 7, use instead avrate = 8 or avrate = 6. Important: At low avrates (<= 32) the factor ps081adjust (Configreg\_03, Bit [9:4]) should be set to

2x avrate. Example: avrate = 8 --> set psO81adjust to 16

## 3.4.6 Resolution and Converter Precision

In this document the terms resolution and converter precision are often used in the same context, however, there is a difference in their meaning:

- Resolution: refers to the digital value which can be displayed (or resolved) within the chip. This is basically the HBO register in a 24-bit format, where the MSB is indicating a negative number (two's complement). Expressed in numbers the result can be shown from -8388608 (0x800000) to +8388607 (0x7FFFFF). One LSB has thereby the valency of 10nV/V (2mV/V divided by 200,000). Example: at 3V the valency of 1 LSB is 10nV/V x 3V = 30nV.
- Converter Precision (sometimes also referred to as "accuracy"): this is the accuracy given by the converter, normally defined by the standard deviation or RMS (root mean square) noise. The value of the precision is normally given in effective number of bits (ENOB). With PSO81 an RMS

noise as low as 10nV at 3.3V can be achieved, or expressed in ENOB up to19.5 Bits (related to 2mV/V). An overview of the converter precision at different update rates is given in several tables in section 2.4. However, a rough estimation can be done by the equations given in the following.

PS1/281

The base converter precision for a half bridge at avrate = 1 (only for calculation purposes, not recommended to be used) and a recommended discharge time of 90 to 150  $\mu$ s in fast settling mode and 2 mV/V excitation is:

With internal comparator:13.3 Bit eff.With external bipolar comparator:13.8 Bit eff.

At higher values of avrate[] the resolution is calculated as:

$$ENOB = ENOB[AVRate=1] + \frac{\ln(\sqrt{AVRate*Bridgefactor})}{\ln(2)}$$

The Bridge-factor is:

2 for full bridges

4 for quattro bridges

Example 1:

avrate = 12, Quattro bridge, internal comparator

 $ENOB = 13.3 + \ln(\sqrt{(12*4)})/\ln(2) = 13.3 + 2.8 = 16.1$  Bit eff. = 70,000 effective divisions = 10,000 peak-peak divisions in fast settle mode (without SINC-filter).

Example 2: avrate = 450, Full bridge, external comparator ENOB =  $13.8 + \ln (\sqrt{450*2})/\ln(2) = 13.8 + 4.9 = 18.7$  Bit eff. = 425,000 effective divisions = 70,000 peak-peak divisions in fast settle mode (without SINC filter).

Example 3:

avrate = 100, Full bridge, external comparator, expressed in nV RMS ENOB = 13.8 + ln ( $\sqrt{(100*2)}/\ln(2) = 13.8 + 3.8 = 17.6$  Bit eff. 2^17.6 = 198,700 eff. divisions with a 2mV/V sensor operated at 3V  $\rightarrow$  3V x 2mV/V = 6000µV divided by 198,700 = 30.2nV RMS

Note: The effective number of bits (ENOB) in the equation are related to 2mV/V sensitivity of the sensor. If the sensitivity is different with your sensor, the result needs to be corrected by the reduction in sensitivity. E.g.: you calculate 18.7 bit with the equation, but your sensor has only 1mV/V



instead of 2mV/V. Then this corresponds to a reduction by factor 2, which is 1-bit, so the ENOB is 17.7 bit in this case.

The effective resolution (ENOB) is also reduced when Wheatstone connection is used instead of PICOSTRAIN connection. The reason for that is the reduction of the strain by 1/3 because when discharging over 1 strain gage of the bridge the other 3 strain gages are in parallel and lower the extension/strain of the gage to measure. Expressed in ENOB the reduction is -0.6 bit.

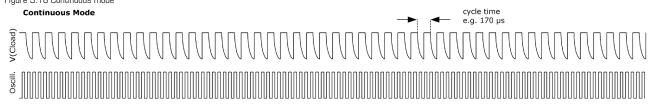
#### 3.5 Modes and Timings

The PSO81 has 3 basic operating modes as well as combinations of them. They are related to the sampling frequency and the active time of the 4 MHz oscillator. Therefore, the selection has influence on the stability of the result and the current consumption.

The basic modes are:

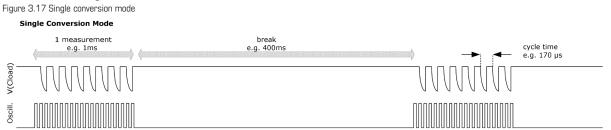
- Continuous Mode
- Single Conversion Mode
- Stretched Mode

#### 3.5.1 Continuous Mode Figure 3.16 Continuous mode



The chip is making continuously discharge time measurements. The oscillator is on all the time. This mode is the choice for applications targeting highest resolution. It is the standard mode for all applications that allow a current consumption  $> 500 \ \mu$ A.

#### 3.5.2 Single Conversion Mode



The chip makes a complete measurement sequence and then goes to sleep mode. The oscillator is

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on only for the sequence. This mode offers the lowest current consumption and is best choice for body scales.

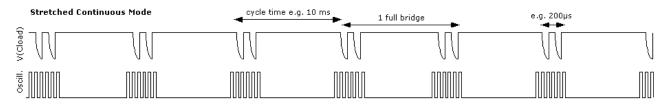
Pure Single Conversion Mode should be used only in mechanically stable systems like body scales, because it implies undersampling. The consequence of undersampling is that mechanical oscillations of the weighing system will end up in unstable data.

#### 3.5.3 Stretched Mode

Streched Mode combines the advantage of a few measurements (to save current) and a reasonable distribution of these measurements for avoiding undersampling. Hence, the discharge cycles are stretched in a way that the total number is not increased but the distribution is improved.

#### 3.5.3.1 Stretched Continuous Mode

Figure 3.18 Stretched continuous mode



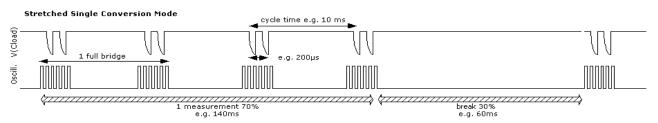
Stretched Conitnuous Mode combines stretched mode and continuous mode. There are longer intervals between the discharge time measurements for the half bridges. The oscillator is activated only for each half bridge measurement.

This mode is used in applications that target high resolution at low current (< 500  $\mu$ A). It also has a good frequency response (e.g. load cell vibrations) on the input signal. The response can easily be calculated by the Nyquist theorem. This mode together with a good software anti-vibration filter gives best vibration suppression at lowest current. This mode is recommended e.g. for battery driven solar kitchen scales.

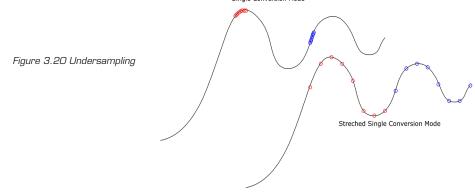


#### 3.5.3.2 Stretched Single Conversion Mode

Figure 3.19 Stretched single conversion mode



For mechanically sensitive weigh scales like kitchen scales the PSO81 provides the stretched mode combined with the single conversion mode. In this mode the two resistors of a half bridge are measured subsequently, but the next pair of discharge time measurements follows delayed. Therefore, the sample points of a single sequence can cover minimum a full period of the mechanical oscillation. Thanks to the integration of the samples within one sequence the result will normally be stable if the break is <30% of the time.



Again, the oscillator is switched on only for each discharge time measurement. But, as the oscillator needs some time to reach the full amplitude, the total active time of the oscillator is longer than for pure Single Conversion Mode. The current consumption in stretched single conversion mode is therefore a little bit increased compared to the single conversion mode.

Four major parameters define the operation mode:

single_conversion	n: Selects between continuous operation and single separated measurements.
stretch:	Selects between 4 MHz oscillator continuously running while measuring and
	running the oscillator only for the duration of 1 or 2 discharge cycles (recom
	mended 2 discharge cycles)
cycletime:	Defines the time interval between single or pairs of discharge cycles. It is
	based on the 4 MHz clock or in stretched mode on the 10 kHz clock.
avrate:	Sample size of averaging. Defines the number of complete ratio measure
	ments that make a single measurement sequence (internal averaging).

	. ,	
sinale	_conversion /	continuous
0		0011011101010

Register 2, Bit 2: single_conversion
Selects continuous mode. In this mode the PSØ81 is continuously
measuring. The 4 MHz oscillator is on continuously. This takes about
130 μA @ 3.0 V.
Selects single conversion mode. In this mode the PSØ81 makes one
complete measurement and then switches off the 4 MHz oscillator for
the duration of the single conversion counter.
, Bits 12, 13: stretch
oscillator is on only for the duration of a single discharge time measure
cycle time (time between subsequent discharge time measurements) is
on the basis of the 10 kHz oscillator.
nmended -
oscillator is on only for the duration of a single half bridge measure-
discharge time measurements). The cycle time (time between subse-
bridge time measurements) is calculated on the basis of the 10 kHz
The time interval between the two discharge time measurement for a
is 200 $\mu s$ in case stretch = 2 or 300 $\mu s$ in case stretch = 3

#### Stretched Mode Settings

In stretched mode there are several parameters which configure the mode, these are:

stretch[13:12] in Configreg\_03

cytime[13:4] in Configreg\_02

sel\_start\_osz[19:17] in Configreg\_03

single\_conversion [2] in Configreg\_02

tdc\_conv\_cnt[23:16] in Configreg\_00

Those parameters set the stretch mode. The

following 2 pictures show how the parameters are

applied, one showing the continious stretched the

other the single conversion stretched mode.

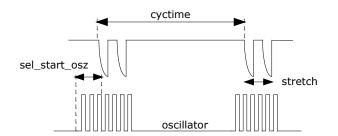
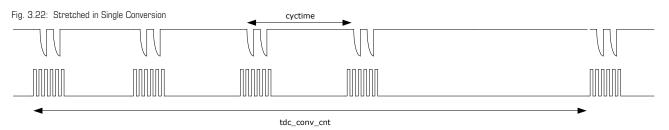


Fig. 3.21: Parameters in continious stretched mode



The cyctime-parameter defines the time waited for the next discharging. By the parameter stretch, the time between 2 discharging cycles can be defined. The parameter sel\_start\_osz defines what time the oscillator is started before the discharging cycles are coming.



Basically in Single Conversion Stretched mode the parameters remain the same. But tdc\_conv\_cnt defines additionally the time between measurement sequences.

#### 3.5.4 Mode Selection Criteria Table 3.1 Mode Selection criteria

Applications	Mo	de	Parameters	Description
Highest resolution with no		Continuous	single_conversion = 0	Continuously measuring,
current limitation		mode	stretch = 0	4 MHz oscillator on all the
Standard mode for all ap-				time
plications with $> 500 \ \mu A$	sno			
current capability	tinu			
High resolution but lower	Con	Stretched	single_conversion = 0	Continuously measuring. 4
current	 Stretched / Continuous	continuous	stretch = 2 or 3	MHz oscillator on only during
	etch	mode	cycle time =	the discharge time measure-
	Str		cytime*100µs	ment.
Lowest current consumption		Single	single_conversion = 1	option with lowest current
Mechanically stable applica-		conversion	stretch = 0	consumption, undersampling
tions like pressure sensors		mode		-> no suppression of me-
				chanical vibrations
High resolution but low cur-		Stretched	single_conversion = 0	option with low current con-
rent,	Ę	mode	stretch = 2	sumption and oversampling
e.g. battery driven legal-	ersio		cycle time =	for suppression of mechani-
for-trade scales with 3000	conversion		cytime*100µs	cal vibrations.
divisions	je c			
High resolution but lowest	Single (	Stretched	single_conversion = 1	option with very low current
current,	led /	single	stretch = 2 or 3	consumption and overs-
e.g. solar scales	Stretched /	conversion	cycle time =	ampling for suppression of
	Str	mode	cytime*100µs	mechanical vibrations.

3.5.5 C	3.5.5 Conversion Time / Measuring Rate (Continuous Mode)		
The time for one	The time for one complete measurement can be calculated by means of following formula:		
Tconversion = C	CycleTime*(2*avrate * Bridge-factor + 6 +N	IFake*2 + 1)	
Mfake = #Fake	measurements, Temperature measurement	on	
Mfake-Register	#Fake Measurements	Note:	
0	0	Fake measurements are necessary	
1	2	to avoid that the next measurement	
2	4	starts while the ALU is still processing	
3	16	data from the former measurement.	
Example1:	Cycle time = 110 µs		
	AVRate =12		
	Quattro bridge		
Mfake = 1			
Tconversion = 110 µs*(2*12*4 + 6 + 2 + 1) =11.55 ms			
The maximum measuring rate is 86.6 Hz			
Example2:	Cycle time = 110 µs		
	AVRate = 450		
	Full bridge		
	Mfake = 2		
	Tconversion = 110	1 + 1) =199.21 ms	
	The maximum measuring rate is 5.02 Hz		
3.5.6 C	onversion Time / Measuring Rate (Single Co	onversion Mode)	
lf PSØ81 is con	figured to run in Single Conversion Mode (B	it 4 in configreg_02), the measuring rate	
is defined by the	is defined by the value in tdc_conv_cnt[23:16] in configreg_00. This value corresponds directly to the		
conversion time	conversion time (multiplied by 6.4ms).		

Example:

configreg_00: 0x158200	$\rightarrow$ tdc_conv_cnt[23:16] = 0x15 = 21 decimal
	→ 21 x 6.4ms = 0.1344 second
	$\rightarrow$ measuring rate = 1 / 0.1344 second = 7.44 Hz

Note:

In case you use single conversion the time needed for one complete measurement should fit into the time slot given through the conversion counter (tdc\_conv\_cnt).

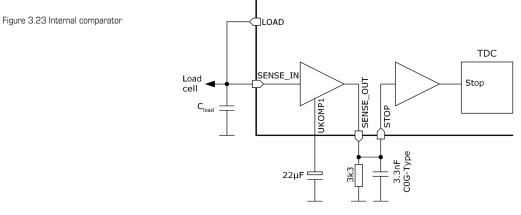


#### 3.5.7 Comparator

The end of the discharge cycle is triggered by a comparator. PSØ8 offers an internal low noise comparator. Alternatively, an external comparator might be used.

#### 3.5.7.1 Internal Comparator

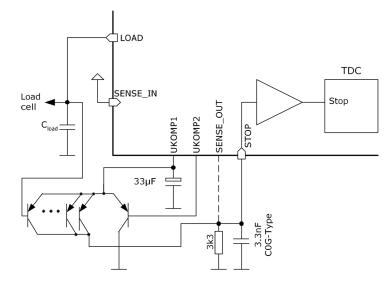
The internal comparator is selected by setting reg11, sel\_compint = 1. By means of the internal comparator it is possible to get about 60,000 divisions peak-peak at 2 mV/V, 5 Hz update rate and MEDIAN 5 software filter.



#### 3.5.7.2 External Comparator

Figure 3.24 External comparator

The precision of the measurement can be improved by using an external bipolar comparator. With an external bipolar comparator it is possible to get up to 150k divisions at 5Hz update rate.



#### Recommendations:

Low-noise PNP transistors like 2N5087 / CMKT5087 or BC859 should be used. 5 transistors in parallel should be connected at the LOAD side. It is not necessary to have matched transistors. Use a COG-type capacitor for the low-pass filter capacitance.

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## PSØ81

#### 3.5.7.3 When should an external comparator be used?

There are three reasons for the choice of an external comparator:

#### a) Very high resolution

The user is looking for the best possible resolution in his application, e.g. in counting scales, high end legal-for-trade scales.

#### b) Lowest current

The user is looking for the lowest possible current consumption in his application, e.g. in solar scales. Because of the lower noise, the AVRate can be reduced at a given resolution and therefore the operating current is reduced. With the bipolar comparator the operating current can be more than halved compared to the internal comparator.

#### c) Ultra low voltage

In case the user wants to run his application down to < 2.1 V Vcc, e.g. with 1.55 V silver oxide batteries. Then the bipolar comparator shows significantly better results.

#### 3.5.7.4 Comparator Control

The comparator can be switched on for only the duration of the measurement for current saving reasons or continuously (con\_comp[1:0]). Further, the working resistance of the internal comparator can be changed (sel\_compr[1:0]).

We recommend the following settings:

CON_COMP	= 'b10 $\rightarrow$ on during measurement
SEL_COMPR	= 'b10 $\rightarrow$ 7k resistor selected

If CON\_COMP is set to 'b11 (on) the comparator needs approx. 130  $\mu A @$  3.0 V of constant current.

#### Capacitors at UCOMP1 and STOP:

The capacitors at UCOMP1 and STOP are important for the low noise figure. For best performance we recommend 33  $\mu$ F for  $C_{_{UCOMP1}}$  and 3.3 nF for  $C_{_{STOP}}$ . For Cucomp1 an ordinary electrolytic capacitor can be used. As  $C_{_{STOP}}$  a X7R capacitor can be used.

In case the internal comparator is used  $\rm C_{_{UCOMP1}}$  and  $\rm C_{_{STOP}}$  have to be connected as well as the 4.7k Ohm resistor. Nevertheless, smaller values are possible, too.



#### Recommended values:

Example:

$$\label{eq:C_ucompt} \begin{split} C_{\text{ucomP1}} &= 1 \; \mu F \quad \mbox{a} \quad C_{\text{stop}} < 1 \; \mu F/3000 \; \rightarrow \; 330 \; \text{pF selected}. \end{split}$$
 The noise will slightly increase by about 0.3 – 0.5 Bit.

#### 3.5.7.5 Correction of Comparator Delay

The focus of the comparator performance is on ultra low noise, and therefore it has a delay which cannot be neglected. This delay depends on temperature and results in a gain error which is too high for precise weight scale applications. The two resistors Rtemp and Rref are used to measure the delay time periodically during the operation. The PSØ81 corrects the measuring result with the measured delay.

The delay of the comparator depends on the value of  $C_{UCOMP1}$  and  $C_{STOP}$ . Because these values can be changed by the user there is a possibility to adjust the correction routine by the register Mult\_ PP[7:0]. A good value for the recommended  $C_{UCOMP1}$  and  $C_{STOP}$  values (33 µF and 3.3 nF) is Mult\_PP = 1.28 (160 or 0xA3). If the capacitor values are increased, the correct Mult\_PP value has to be higher or vice versa. If the selected Mult\_PP value is too low the gain will decrease with higher temperature or lower voltage.

At the correct value of Mult\_PP the gain of the electronic is absolutely stable over a very wide temperature and voltage range. The temperature drift of the gain is <1 ppm/K. The power supply rejection ratio (PSRR) is >130 dB. See also section 3.6.2.

#### 3.5.8 Temperature Measurement

PSO81 has the possibility to measure the temperature by means of an external, temperature dependent resistor. The temperature information can be used to correct the gain drift of uncompensated load cells. This we call rspan-by-temp compensation.

Temperature measurement is done by measuring the ratio of the discharge times of two resistors, Rtemp and Rref, a temperature dependent one and a temperature stable one. The change of the ratio is used by an implemented hardware algorithm to correct the gain drift of an uncompensated load cell. Of course, the temperature coefficient of the resistor pair needs to match the load cell's temperature coefficient. This can be done by a factor TKGain (configreg\_08), which scales the result

from the temperature measurement before it is used for the correction of the strain measurement.

Make sure that the bits mod\_rspan & rspan\_by\_temp are set (configreg\_01, bit 6 and 8, page ALU in the evaluation software).

#### 3.5.8.1 Resistors Rtemp and Rref

The sensitive resistor may be a carbon film resistor with a temperature coefficient in the range of 200-300ppm/K. The reference resistor can be a metal film resistor which have typically <50ppm/K. Please make sure, that the temperature coefficient of the carbon resistor is not <200ppm/K because in this case the temperature measurement will not work properly.

The values for Rtemp and Rref have to be adjusted to the strain gage resistance and the kind of bridge.

Therefore the resistors should have following values:

Normal :	R = Rsg (e.g. 1000 Ohm with 1000 Ohm bridges)
(= Half-, Full-, Quattro Bridge)	

Wheatstone Bridge:	R = 0.75*Rsg	(e.g. 750 Ohm with '	1000 Ohm Bridges)
--------------------	--------------	----------------------	-------------------

#### Note:

The two resistors have to be connected in any case as they are used also for the comparator delay correction. In case of no temperature measurement both resistors can be of the same type (e.g. carbon resistors).

The sensitive resistor may be a carbon film resistor with a temperature coefficient in the range of 200-300ppm/K. The reference resistor can be a metal film resistor which have typically <50ppm/K. Please make sure, that the temperature coefficient of the carbon resistor is not <200ppm/K because in this case the temperature measurement will not work properly.

For more information about this method of gain drift correction see application note ANO21.



#### 3.6 Post-processing

At the end of a measurement the converter does the post-processing of the measurement by means of ROM based routines. It stores the readily calibrated and scaled results in the result registers in the RAM. Afterwards, in case epr\_usr\_prg =1, the EEPROM program is started.

Specialties of the post-processing are:

- The results of the four half-bridges have independent multiplication factors. This offers the possibility to do a software correction for off-center weights in quattro applications.
- The strain sensors and the span compensation resistor are separated. The gain compensation
  resistor can therefore be adjusted by software. Even the temperature measurement can be used
  instead of the span compensation resistor. By this method it is possible to make high-quality load
  cells out of standard load cells just by software.
- As a consequence, with PICOSTRAIN the offset is not affected by the span compensation. The
  offset can be corrected by software.
- The corrected result may further be multiplied by correction factors depending on the battery voltage. This supports power supply rejection and allows an operation directly from a battery without regulation.

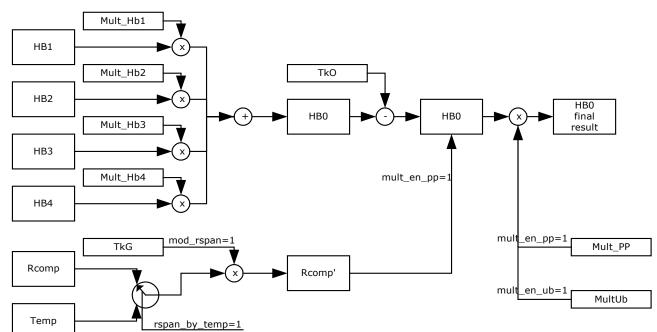


Figure 3.25 Post-processing

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A simple example program to display the results could be:

ramadr	20	; HBO result
move	Х,Г	; Load x-Accu with the result
move	у, 2	; Load y-Accu with the comma position
no2lcd	x , 2	; Convert into 7-segment display
newlcd		; Indicate new value to the LCD-driver
clrwdt		; setback the watchdog
stop		; Hold the $\mu C$

#### 3.6.1 Off-center Correction for Quattro Scales

Several scales like body scales have four load cells, each with a half-bridge sensor on it. The indicated weight might vary with the position on the platform in case the load cells do not all have exactly the same sensitivity. PSØ81 allows to correct the gain of the half bridges just by software without trimming or adding an additional trim circuit. Each half bridge result is assigned its own multiplication factor (MULT\_HB1 to MULT\_HB4). By simply four measurements it is possible to calculate the multiplication factors for the correction. Therefore a nominal load has to be put on each corner of the scale. Please contact acam for the algorithm to calculate the factors MULT\_HB1 to MULT\_HB4.

3.6.2 Compensation of Load Cell Gain & Offset Drift (Mult\_TKG, Mult\_TkO) Todays high end converters have a very good zero drift and gain drift bevavior. It is about 5 to 10 times better than for a good load cell itself. The real goal is an optimized complete system (scale) and not only a very good electronic. Therefore, with the PICOSTRAIN family acam has indroduced a method which is also able to correct the zero drift and the gain drift of the load cell by software without touching the load cell. This method works only if the load cell has just <u>one</u> compensation resistor (Rspan)<sup>1</sup>.

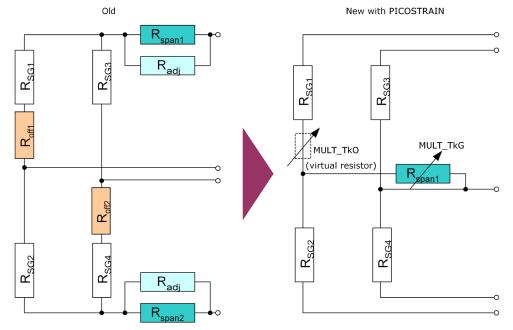
PSO81 can measure this resistor and correct it by an algorithm in the  $\mu$ P, based on factors Mult\_TkG for the gain drift and Mult\_TKO for the zero drift. This can be done after the production of the load cell is completed. It is no longer necessary to have a precise compensation resistor on the load cell. It is not necessary to trim Rspan manually.

A further consequence of this possibility is that it is no longer necessary to trim the load cell exactly to zero, no zero offset compensation resistors are needed.

<sup>1</sup> see also 3.6.4 Nonlinearity of gain drift over temperature. It may be necessary to add a resistor in parallel to Rspan to reduce nonlinearity.



Figure 3.26 Correction of Gain and Offset Drift



By doing this, the gain and offset behavior of the load cell can be improved by PSO81. This is a very comfortable method to improve the quality of the complete scale without modifying the load cell or the electronic. If this possibility is combined with an intelligent digital load cell concept the production can be simplified at higher quality level and lower cost.

Some examples how to use Mult\_TKO, Mult\_TKO:

- If the compensation resistor is matched to the sensor, but the bridge has an offset drift, this offset drift can be eliminated by software.
- If the gain error of the load cell is known (e.g. stable over production lot but wrong) it can be corrected directly by PSO81 without going into a climate chamber.
- If a run in the temperature drift chamber is done, the correction factors for Mult\_TkG and Mult\_ TkO can be determined very appropriate. In this case the compensation of the whole system can be improved significantly. With such a method of post correction after fabrication of the scale, the complete scale can be offset and gain adjusted nearly perfect and much better than required for high end scale. (e.g. gain drift < 1 ppm/K and offset drift < 10 nV/K for the complete scale have been achieved as best performance).

acam has written a special whitepaper (WPOO2) that explains in detail the many possibilities and the importance of this option. Furthermore it provides a step-by-step guidance how to make the temperature compensation by using Mult\_TkG and Mult\_TkO.

PSØ81

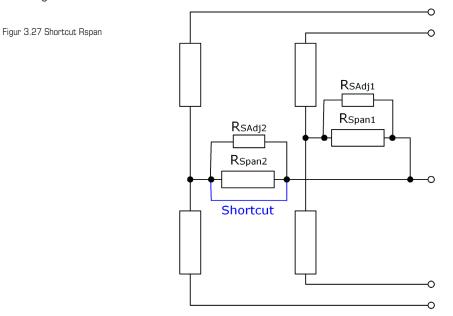
PSO81 can correct uncompensated load cells (cells without a gain compensation resistor Rspan), too. It therefore uses the temperature measurement information instead of the Rspan value. This mode is activated by setting rspan\_by\_temp = 1 in register 1. Again, the adjustments are done by means of factors Mult\_TKO and Mult\_TKG. The accuracy of this compensation depends mainly on the accuracy and Tk of the resistors used for the temperature measurement. Improvements by a factor 6 to 8 compared to the uncompensated load cell can be achieved. This is normally sufficient for making a simple temperature correction for commercial scales. For high-end scales or legal for trade scales we recommend to use an ordinary Rspan in combination with the here described Mult\_TkG and Mult\_TkO method.

In application note ANO21 we describe the method of the temperature compensation by the means of 2 resistors (Rspan\_by\_temp) and the scope of its use in detail.

#### 3.6.3 Annotations Rspan

PICOSTRAIN needs only one Rspan resistor. As the common mode rejection ratio (CMRR) of the PICOSTRAIN products is nearly infinite (up to 135dB) there is no need to use two Rspan resistors. Indeed, PICOSTRAIN can not handle bridges with two Rspan resistors.

The easiest is to use load cells which natively have only 1 Rspan resistor. Nevertheless, if you want to make a first tests with a load cell which has 2 Rspan you simply can shortcut one of them in the following manner:

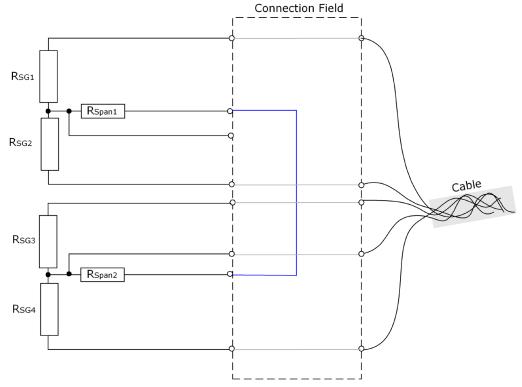


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A more convenient way to change a load cell with 2 Rspan is to switch them in series. This is possible if the connections of the Rspan resistors are available as illustrated in the following picture:





Please note: You are not touching the strain gage sensors or the Rspan resistors directly. Instead you make any re-wiring proposed in the connection field of the load cell. This is true for the changes regarding Rspan as well as the change from Wheatstone-wiring to PICOSTRAIN-wiring (please see also chapter 3.3.2).

#### 3.6.4 Nonlinearity of gain drift over temperature

Scope of this item: Only important for calibrated scales, e.g. according to OIML specification.

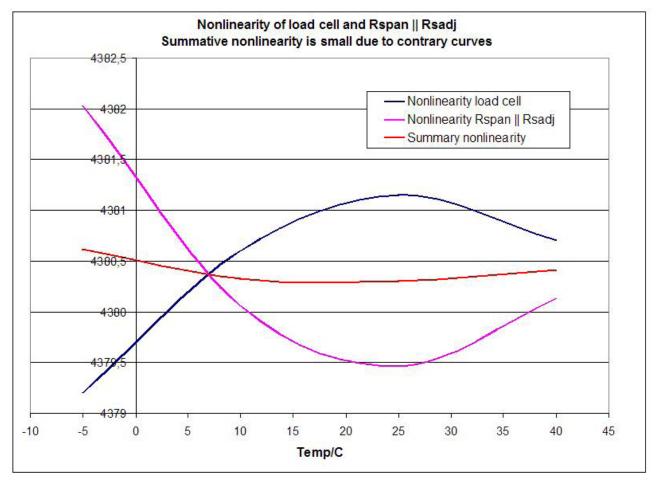
Independently of the PICOSTRAIN gain drift compensation we have always a nonlinearity of the load cell over temperature. This nonlinearity generally has two causes, the nonlinearity of the load cell itself (material, glue, wiring, etc.) and a nonlinearity coming from the paralleling of the Rspan resistor with its adjustment resistor (Rsadj). Normally these two effects are in opposite direction, so that overall nonlinearity can be reduced. In other words, the nonlinearity introduced by the paralleling of the resistors is compensating to some degree the nonlinearity coming from the load cell itself.

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Please see the following diagram illustrating the effect:

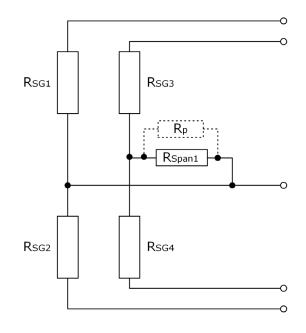
Figure 3.29 Non-linearity



However there is a change in behavior if the adjustment resistor (Rsadj) is missing at all. There is no longer an effect of compensating the nonlinearity In the basic set-up of a PICOSTRAIN bridge with 1 Rspan there is no further adjustment resistor needed and therefore missing. This is not a problem if the load cell's nonlinearity itself is very low. But if it has a nonlinearity not neglectable, it may be necessary to add a parallel resistor to compensate for the nonlinearity. Please note that the purpose of this parallel resistor (Rp) is compensation of the non-linearity but not correcting Rspan in its resistor's value.



Figure 3.30 Rp placement



There are several criteria to decide whether a parallel resistor (Rp) should be used or not. Please find a detailed description in our dedicated Whitepaper WPOO2. Recommendations of whether the use of Rp is recommended or not and the size of it is automatically calculated by an Excel-Sheet available from acam. If it is recommended to add an Rp resistor it can be an ordinary fixed resistor with no special requirements.

#### 3.6.5 Gain-Drift of PSØ81 itself – Optimization with Mult\_PP

The PSØ81 has a very low gain drift of ~ 1ppm/K in case the Mult\_PP factor is set properly. The reason for this gain drift is different than in an A/D-Converter. Because of this, we give some back-ground information in this section to understand the cause of the gain drift of PSØ81 and also we give some hints how to measure it properly.

Background: In a classical A/D converter application the temperature drift of the resistors of the operational amplifier have to match very exactly. A mismatch is seen as gain drift. In PSØ81 the physical reasons are totally different. PSØ81 has a TD-Converter with no preamplifier. The gain drift of the PSO81 electronics comes mainly from the delay time of the comparator. In Wheatstone mode the analog multiplexer is part of this delay time and therefore the selected type of the analog multiplexer affects this value. When setting pptemp = 1 in register 2 the PSO81 can measure the delay by means of the two resistors at ports PSEP1 and PSEP2. The determined correction factor can be adjusted by factor Mult\_PP

The delay depends on the value of the low-pass capacitor which is parallel to the collector resistor of the comparator transistor. We recommend 3.3 kOhm for the collector resistor and 3.3 nF for the parallel capacitor. If this capacitor is changed, the optimum Mult\_PP factor changes, too. This is the main dependency of Mult\_PP from the hardware, besides the general selection between external and internal comparator.

PS081

#### Optimizing Gain Drift with Mult\_PP

With our hardware recommendations the system has a remaining gain error of approximately 8 ppm/K if Mult\_PP is set to 1.0 or not used. This remaining gain error can be reduced to < 1 ppm by choosing the right Mult\_PP factor.

<u>Once established during the development phase, this value can be used for the whole series produc-</u> <u>tion. It is definitely not necessary to adjust every single electronic.</u>

#### Note:

The gain drift of the PSO81 itself is very close to zero. The remaining gain drift comes mainly from the nonlinear part of the delay time of the comparator. This nonlinear part itself results mainly from the low-pass filter behind the first stage of the comparator (3.3 kOhm II 3.3 nF). It can be significantly reduced by the Mult\_PP value. Because the low pass filter can be reproduced very accurately also the compensation is very stable over production and needs no adjustment.

With the recommended hardware we determined following Mult_PP factors:			
• Wheatstone bridge with external comparator and analog mux TS5A3160 (TI) :		1.28	
• Wheatstone bridge with external comparator and analog mux 74LVC1G3157(TI) :	1.14		
<ul> <li>PICOSTRAIN standard wiring, external comparator, our recommended values:</li> </ul>		1.28	

For Wheatstone Mode we recommend TS5A3160 because it has a good behavior also at lower supply voltages < 2.7 V, but 74LVC1G3157 is a good choice, too, for supply voltages of 3.0 V or higher. If own hardware settings are used, especially if the low pass filter is changed, the MULT\_PP factor may change and has to be determined. The value for this hardware setting is valid for the whole production and is independent from production batches. For more details see application note AN018.

#### 3.6.6 Zero Drift of PSO81 itself

Also the zero drift of the PSO81 originates from a reason other than the drift of an AD-Converter. The reason of the remaining zero drift of our PICOSTRAIN products are parasitic resistor paths that



are not or not perfectly compensated. Mainly in the packaged version of PSO81 differences in the bond wires are not compensated.

Because of the nature of the remaining zero drift, the value of this drift depends on the value of the strain gage resistor. The lower the strain gage resistor the higher is the remaining drift. E.g. with a 1 kOhm strain gage the zero drift is approximately 1/3 of the drift of a 350 Ohm strain gage with the same chip.

For best offset drift behavior we recommend the standard full bridge connection. The systematic offset drift in this mode is approx.  $\pm 10$  nV/V/K and lies therefore in the 50% limit of OIML 10000. It is possible to use PS081 in high end scales, please see also Application Note AN018 for further details.

In all PICOSTRAIN modes the sensor wire resistance is part of the zero drift. To minimize the drift please have a close look on the length of these wires to the load cell. The most critical part is normally the PCB, a few millimeters of missmatch can be well seen in the offset drift. The cable to the load cell is not as critical because the wires have a much bigger diameter.

A special case is Wheatstone mode. In this mode nearly 100% of the remaining parasitic resistances are compensated because of the kind of the measurement. Therefore, in Wheatstone mode the zero drift of PS081 is close to zero and can be improved to < 1 nV/V/K also if the wires are not matched.

For comparison:

- To comply with OIML 3000 specifications the zero drift of the complete scale must not exceed 133 nV/V/K
- To comply with OIML 10000 specifications the zero drift of the complete scale must not exceed 40 nV/V/K

Following table gives an overview of the typical offset drift of PSO81. To get a good idea of the min./ max. values multiply the typical values by the factor of 3. You get a good estimation over the distribution of a production lot (not a guarantee).

Typical drift in different modes

Mode	350 Ohm SG	1 kOhm SG	OIML 10000
Fullbridge Standard *	±10 nV/V/K	±4 nV/V/K	±40 nV/V/K
Wheatstone	<±1 nV/V/K	<<±1 nV/V/K	±40 nV/V/K

\*with cross-matched traces on the PCB, please refer to below explanation.



#### Zero Drift of Full Bridge Standard Wiring

In the packaged version of PSO81 there is some systematic offset drift due to different bond wire lengths. This zero drift is  $\pm 10$  nV/V/K and the same for every chip. Because of the nature of this drift it can be easily compensated on the PCB by cross-matching the different bond wire length on the PCB.

To compensate this systematical drift the trace from SG-B1 to the connection pad of the load cell wire should be (t.b.d.) mm longer than the trace from SG-A2 to the connection pad. SG-A1 and SG-B2 should have the same length.

Please note: In any case, the main source of the drift is not the electronic. PICOSTRAIN and also a good AD-converter have 5 to 10 times better drift values than a good load cell. Therefore, if the system performance should be significantly increased, the drift of the load cell has to be reduced. PSO81 can solve this task by software with the Mult\_TKO possibility.

#### 3.6.7 Mult\_UB - Power Supply Rejection

PSO81 measures frequently the supply voltage. The measured voltage can be used to correct the dependency of the gain from the voltage. It is switched on by configuration bit mult\_en\_ub = 1. Factor mult\_ub[7:0] defines the control ratio of the voltage measurement. The control ratio is generally very low. The result of the strain measurement will be corrected according to

 $HB = HB/(1 + UB^*[-128 \dots 127] / 2^{21}).$ 

The standard setting for Mult\_UB is 0xF7.



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# **FICO**STRAIN

## PSØ81

## 4 Peripheral Components & Special Settings

4.1 Oscillators

PSØ81 has an internal low-current 10 kHz oscillator which is used for basic timer functions and for the definition of the cycle time in stretched modes and measuring range 1.

Further, PSØ81 has an oscillator driver for an external 4 MHz ceramic resonator. This one is used for the time measurement and for the definition of the cycle time in non-stretched modes. It needs about 130  $\mu$ A @ 3.0 V.

Configuration:

Register 3, Bits 17 to 19: sel\_start\_osz

- O = Switch off oscillator
- 1 = oscillator continuously on
- 2 = Measurement started with 100  $\mu$ s delay after switching on the oscillator
- 3 = Measurement started with 200  $\mu s$  delay after switching on the oscillator
- 4 = Measurement started with 300  $\mu$ s delay after switching on the oscillator
- 5 = Measurement started with 400  $\mu s$  delay after switching on the oscillator 6
- & 7 are not connected
- Register 2, Bit 0: auto10k

This oscillator can be switched on continuously or only for the duration of the measurement, including some lead time to reach the full oscillation amplitude (sel\_start\_osz[2:0]). The startup time for the 4MHz oscillator is about 50 µs to 100 µs and slightly depends on the supply voltage.

#### Auto-calibration:

The internal 10 kHz oscillator may be automatically calibrated by means of the 4 MHz oscillator. The frequency varies with temperature and voltage. This would impact the update rate and sampling rate as the 10 kHz is the basis for the TDC conversion counter and in stretched mode also the cycle time. It is recommend to use the auto-calibration option setting auto10k = 1.

#### Note:

#### Auto-calibration should not be used in stretched single conversion modes

#### Layout Considerations:

The oscillator should be placed close to the PSØ81. The area arround the oscillator should be flooded by a ground plane. The SPI wires should not cross the oscillator lines. The 4 MHz should have an additional 1 MOhm pull-down resistor to avoid cross currents during switch-off. The resistor reduces the oscillator current and is urgently needed in solar applications.



#### 4.2 LCD-Driver

The LCD driver has the following features:

- 18 pins for
  - 1/4 duty with maximum 6 digits including comma and 8 special characters
  - 1/3 duty with maximum 5 digits including comma and 5 special characters
  - 1/2 duty with maximum 4 digits including comma
- Stabilization of the display voltage to 3 V, 2.5V and 2V
- Integrated voltage doubler for 3 V and 2.5 V displays
- Energy efficient 2 V operation without voltage doubling
- Operation at un-stabilized supply voltage like lithium batteries or solar cells
- Currentless stand-by
- Driver strength adjustable to segment size and current consumption
- Outputs configurable so that existing displays can be connected
- Implemented conversion tables for 7 segment digits
- Implemented ROM code for 24 Bit number conversions

#### 4.2.1 Basic Configuration

With Icd\_duty the LCD is switched on and set to a specific multiplex mode

lcd\_duty = 0 off

- = 1 2x multiplex
- = 2 3x multiplex
- = 3 4x multiplex mode

lcd\_freq controls the switch-on time of the pixels. The longer a pixel is on the less current is needed because of the lower number of reloads. For a flicker-free display an update rate > 30 Hz is recommended. Therefore the switch-on time depends on the selected multiplex mode.

lcd_freq[2:0]	=		Pixel	Multipl	Multiplex mode	
			on-time	1/4	1/3	1/2
		0	8.0 ms	15	20	31 Hz
		1	4.8 ms	26	34	52 Hz
		2	4.0 ms	31	42	62 Hz
		3	3.2 ms	30	52	78 Hz
		4	2.4 ms	52	69	104 Hz
		5	2.0 ms	62	82	125 Hz

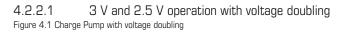
## PSØ81

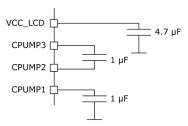
4.2.2 LCD-Power supply

The PSØ81 has an integrated charge pump to double and stabilize the voltage for driving 3 V and								
2.5 V LCD displays. 2 V displays need no voltage doubling. The choice for the external capacitors								
depends on the size or capacitance of the display.								
Configuration:	Registe	r 11: lcd_standby, lcd_vlt						
Register 16: en_noise_lcd, lcd_direct_drive, use_10kHz_lcd								
	Registe	r 17: lcd_pulsed, c10_div_lcd						
lcd_standby	The dis	play has a stand-by mode. I this mode the display is switched off, but						
	the volt	the voltage generation is switched high resistive. So it is possible to switch on						
	the disp	lay very fast. This might be helpful in auto-on mode.						
	= 0	LDC on						
	= 1	Standby						
lcd_vlt[1:0]	Selectio	n of LCD supply voltage						
	= 0	2.0 V						
	= 1	2.5 V						
	= 2	3.0 V						
	= 3	2.0 V without voltage doubling						
lcd_directdrive	LCD direct drive selection							
	= 0	off						
	= 1	LCD is driven directly from Vcc without regulation and charge pump.						
		This reduces the LCD current and should be used in solar applications.						
lcd_dis_chargm	1 =	Suppresses the recharging of the charge pump capacitors during a						
		measurement. This option is reasonable only in stretched modes (here						
		it is recommended) and single conversion mode (at low internal avera-						
		ging (avrate $<$ 10), the time between measurements must be sufficient						
		to recharge the capacitors, duty 1:3).						
		This option works only in combination with a pulsed 4 MHz oscillator						
use_10kHz_lcd	1 =	Select the low power 10 kHz oscillator for the LCD charge pump.						
		1 = recommended						
	0 =	Charge pump clock derived from 4 MHz, divider can be set in the ran-						
		ge 480 to 512. The selection avoids a fixed relation between charge						
		pump and measurement and therefore reduced distortions of the mea-						
		surement.						
c10_div_lcd[5:0]	5 bit di	vider factor for deriving the 10kHz from the 4 MHz in continuous						
	mode.							



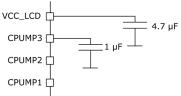
divider factor = $448 + c10$ _div_lcd								
lcd_pulsed[3:0]	Automatically pulsed display, especially for stand-by in solar applications							
		Defines	the period betwee	n the LCI	) switch-on as well as the on-time.			
		OOxx	300 ms	300 ms blinking period				
		O1xx	600 ms	blinking	period			
		10xx	1 s		blinking period			
		11xx	2 s		blinking period			
		xx00	off		on-time			
		xxO1	100 ms	on-time				
		xx10	200 ms	on-time				
		xx11	400 ms	on-time				
en_noise_C10_lc	d	= 0	off					
		= 1	Adding noise to t	he divideı	r factor specified in c10_div_lcd.			





In a first step both capacitors are charged to half the display voltage, 1.5 V or 1.25 V. This voltage can be seen at pins CPUMP1 and CPUMP3. In a second step both capacitors are switched into series. Pin CPUMP3 then shows the full LCD voltage while pins CPUMP1 and CPUMP2 show half the LCD voltage.





In this mode the LCD voltage is stabilized from an un-stabilized supply voltage charging the capacitor to the LCD voltage. The supply voltage may not drop below 2 V in this mode.

## PSØ81

#### 4.2.2.3 Direct Drive

A third option is to drive the LCD directly from the power supply without regulation. Therefore no external capacitors are needed and the output drivers are set low resistive.

 $lcd_r_const = 0$  (10 kOhm).

 $lcd_vlt[1:0] = 0 2.0 V$ 

Nonetheless, it might be helpful to have 1  $\mu F$  capacitors at CPUMP1 and CPUMP2 for better noise reduction, as shown in figure 4.2.

In Direct Drive mode it is recommended to use an LCD frequency as low as possible, e.g.

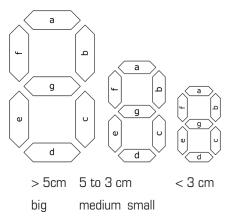
 $lcd_freq = 1$ . The direct drive mode is generally the recommended operation mode for driving an LCD with the internal LCD-driver.

#### 4.2.2.4 LCD Output Driver Configuration

The internal resistance of the output drivers can be adopted to the size of the display. By this means the current consumption can be optimized. The size of the display influences

- The inner resistance of the drivers
- The minimum charge time of the charge pump
- The reload time of the display

Figure 4.3 LCD Segmentsize



Configuration:				
Config.bit	big med	ium smal	l Functior	1
lcd_fastId[1:0]	3	2	1	Configures the number of fastload periods
				(10ms) with low-ohmic voltage divider
lcd_swload1k	1	1	1	$O = charge \ capacitors \ by \ 200 \ Ohm \ resistors$
				1 = charge capacitors by 1 kOhm resistors
				not relevant in direct drive mode



lcd_r_const[1:0] 1	2	3	Defines	the cross resistance of the LCD voltage
				divider
				0 = 30  k
				1 = 50 k
				2 = 200 k
				3 = 800 k
lcd_charge[1:0] 0	2	3	Selects	how many LCD clock cycles it is waited
				before recharging
				O = each cycle
				1 = second cycle
				2 = fourth cycle
	0	0	0	Zero is mandatory in stretched modes, not relevant in
				direct drive mode
lcd_r_fastld	3	2	1	Configures the number of fast-load periods(10ms)
				with low-resistance voltage divider

#### 4.2.2.5 Crosstalk LCD Charge Pump - Measurement

The LCD charge pump might have a negative impact on the measurement quality due to crosstalk from the charge pump. Typically, this becomes obvious by periodic oscillations of the measurement result.

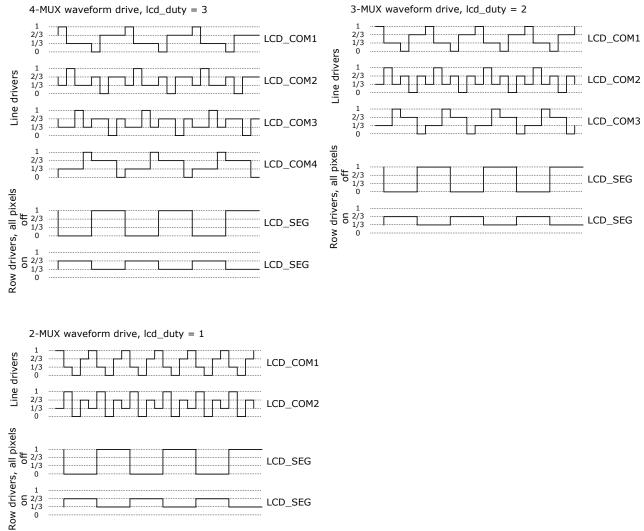
PSØ81 offers several configuration options to overcome this. In the following we show some measures. There is not a unique solution but a need to select the right one for the application. In any case of uncertainty please contact acam for support.

- In Direct Drive Mode the LCD does not affect the measurement.
- Selecting the right LCD frequency in many cases solves the problem. In general, the higher the frequency the lower the distortion. Testing the different lcd\_freq values will show the best choice. The current consumption might be a little bit higher. In battery driven system this will not be a problem. In solar applications we recommend direct drive, anyway.
- LCD voltage divider resistors should be selected as high as possible. This might be in conflict to measure 2, and segments to be off can be seen. The right choice has to be proven by experiment.
- The blocking capacitor at VCC\_LCD can be increased. As a standard we recommend 4.7 µF. In case of problems an increase up to 22 µF shows obvious improvements.

#### 4.2.3 LCD driving methods

In each mode the outputs drive 4 voltage levels, 0, 1/3, 2/3 and full LCD voltage.

#### Figure 4.4 LCD driving





#### 4.2.4 LCD Control

A digit is made of 8 segments. Each segment is named by a character from a to g. The dot is named h.

The single segments are switched on or off by setting the bits in the configuration registers 13, 14 and 15 to " $^{1"}$  or " $^{0"}$ . The assignment does not depend from the multiplex mode. It looks like the following:

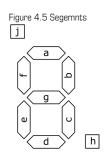


Table 4.1

Digit	Segment		Hex Value	Position in the Configuration Memory:					
	hgfe	dcba		In 2x multiplex the lower 32 bit of lcd_segment are used.					
"O"	0011	1111	ЗF	In 3x multiplex each digit is represented by a 3x3 matrix, including one additional special character. The lower 40 bits of lcd_segment					
"1"	0000	0110	06	are used for the 5 digits. The special signs are controlled by bits					
"2"	0101	1011	5B	40 to 44.					
"3"	0100	1111	4F						
"4"	0110	0110	66						
"5"	0110	1101	6D						
"6"	0111	1101	7D	]					
"7"	0000	0111	07	]					
"8"	0111	1111	7F						
"9"	0110	1111	6F						

Table 4.2

Digit	lcd_segment	configreg	Used with
6	[55:48]	15	1/4
5	[47:40]	14	1/4, 1/3
4	[39:32]	14	1/4, 1/3
3	[31:24]	14	1/4, 1/3,1/2
2	[23:16]	13	1/4, 1/3,1/2
1	[15:8]	13	1/4, 1/3,1/2
0	[7:0]	13	1/4, 1/3,1/2

With dez2lcd (D) there is a special code for the processor to convert decimal data to characters  $\ensuremath{\mathsf{O}}$ 

to 9. It converts the lowest four bit of the addressed accumulator (representing 0 to 9) into standard 7 segment code.

For further comfort, in the ROM code there is a subroutine for a complete conversion of a 24 bit number.

In the assembler the subroutine is represented by opcodes no2lcd, no2lcdAccu. The value of the Xaccumulator is converted and written into the lower 48 bit of the LCD memory (lcd\_segment[39:0]. The signed original is written back to the X-accumulator and can be used to set the sign on the display. The position of the comma is shown in the Y-accumulator. Leading zero's are suppressed. The

LCD driver ignores the upper 2 digits in 2x multiplex and the upper digit in 3x multiplex. The special characters in 3x and 4x multiplex will not be changed (lcd\_segment[55:48]). In 2x multiplex the comma of the display might be used for special characters. In this case they must be restored after the conversion.

Note:

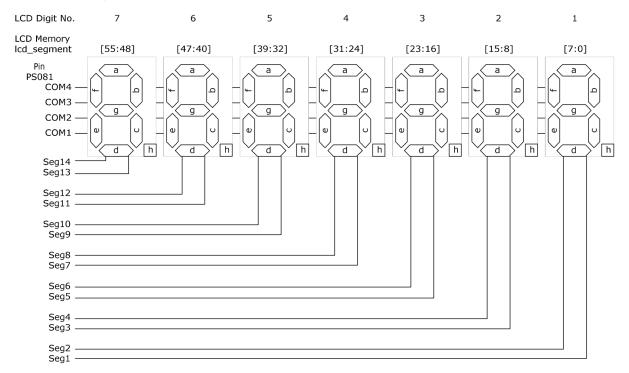
It is necessary to inform the LCD driver separately about new data in the LCD register 13 to 15. This is done by opcode newlcd.

Code snippet:

ramadr 20	; HBO result					
move x,r	; Load x-accumulator with the result					
move y, 2	; Load y-accumulator with the comma position					
no2lcd	; Convert into 7-Segment display format					
newlcd	; Update LCD					
clrwdt	; Set back the watchdog					
stop	; Stop the $\mu C$					

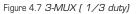
- 4.2.5 Connecting Schemes
- 4.2.5.1 4-MUX (1/4 duty)

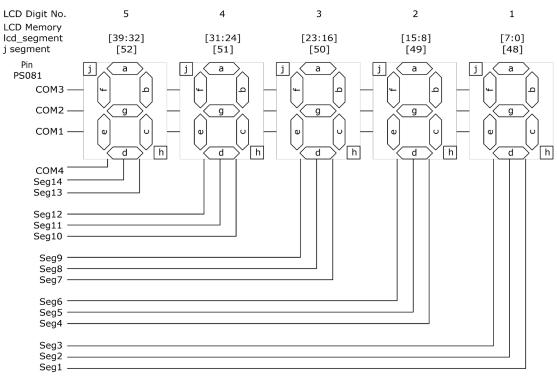
Figure 4.6 4-MUX (1/4 duty)

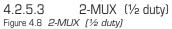


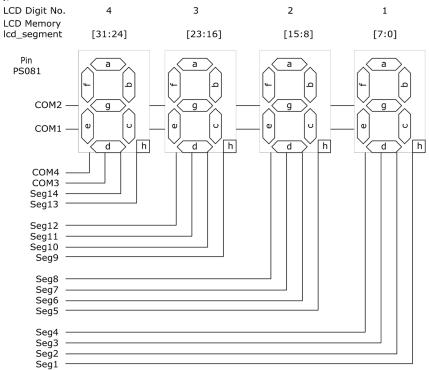


#### 4.2.5.2 3-MUX ( 1/3 duty)









## PSØ81

#### 4.2.6 Setting the Segment Position

Each segment of the configuration bits lcd\_segment can be linked to an arbitrary crossing of the line and common drivers. This offers a high flexibility and allows to connect existing LCD's. Limitations:

The <u>segment lines</u> and eventually common lines 3,4 have to be connected to the right digit of the display. The order within one digit is free. Otherwise the command no2lcd will mix up the digits.

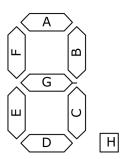
In register lcd\_segment the program sets the segments to be displayed. lcd\_pos defines which bit in lcd\_segment refers to the one out of the 8 target segments.

#### Example: 4xMux Display

Dorado										
	Last digit to the left Seg Seg							Last digit to the right		
			Seg	Seg				Seg	Seg	
	14	13	12	11				2	1	
Com1	lcd_pos [1412]	lcd_pos (20)	lcd_pos [1412]	lcd_pos [20]		•••		lcd_pos [1412]	lcd_pos [20]	
Com2	lcd_pos [1715]	lcd_pos (53)	lcd_pos [1715]	lcd_pos (53)				lcd_pos [1715]	lcd_pos (53)	
Com3	lcd_pos (2018)	lcd_pos (86)	lcd_pos (2018)	lcd_pos [86]				lcd_pos (2018)	lcd_pos (86)	
Com4	lcd_pos (2321)	lcd_pos [119]	lcd_pos (2321)	lcd_pos [119]				lcd_pos (2321)	lcd_pos [119]	

Defaut Wiring for the PSØ81:

Figure 4.9 4mux-digit.gif



for segment	lcd_pos[]=
а	0
b	1
С	2
d	3
е	4
f	5
g	6
h	7
i	8

Examp					Example 2:						
LCD s tion	pecifica-			lcd_pos va	LCD s tion	pecifica-			lcd_pos va	lues	
	Seg 2,4,6	Seg 1,3,5		Seg 2,4,6	Seg 1,3,5		Seg 2,4,6	Seg 1,3,5		Seg 2,4,6	Seg 1,3,5
Com1	е	а	then	lcd_pos [1412] = 4	lcd_pos [20] = 0	Com1	g	а	then	lcd_pos [1412] = 6	lcd_pos [20] = 0
Com2	f	b		lcd_pos [1715] = 5	lcd_pos [53] = 1	Com2	b	f		lcd_pos [1715] = 1	lcd_pos [53] = 5
Com3	g	С		lcd_pos [2018] = 6	lcd_pos [86] = 2	Com3	е	е		lcd_pos [2018] = 2	lcd_pos [86] = 4
Com4	h	d		lcd_pos [2321] = 7	lcd_pos [119] = 3	Com4	h	d		lcd_pos [2321] = 7	lcd_pos [119] = 3
lcd_pos	lcd_pos[230] = 111110101100011010001000 lcd_pos[230] = 111010001110011100101000										

= 0xFAC688

= 0xE8E728

Example: 3xMux Display

Default wiring for PSØ81:

	Last digit to the left						Last digit to the right		
	Com	Seg	Seg				Seg	Seg	Seg
	4	14	13				3	2	1
Com1	lcd_pos (2018)	lcd_pos [119]	lcd_pos [20]				lcd_pos [2018]	lcd_pos [119]	lcd_pos [20]
Com2	lcd_pos [2321]	lcd_pos [1412]	lcd_pos [53]				lcd_pos [2321]	lcd_pos [1412]	lcd_pos [53]
Com3	**	lcd_pos [1715]	lcd_pos [86]				**	lcd_pos [1715]	lcd_pos [86]

LCD speci			ification			lcd_pos values		
Example1:		Seg	Seg	Seg		Seg	Seg	Seg
		3,6,9	2,5,8	1,4,7		3,6,9	2,5,8	1,4,7
	Com1	g	d	а	then	lcd_pos [2018] = 6	lcd_pos [119] = 3	lcd_pos [20] = 0
	Com2	h	е	b		lcd_pos [2321] = 7	lcd_pos [1412] = 4	lcd_pos [53] = 1
	Com3	i	f	С		**	lcd_pos [1715] = 5	lcd_pos [86] = 2

 $lcd\_pos[23...0] = 111110101100011010001000$ 

= 0xFAC688

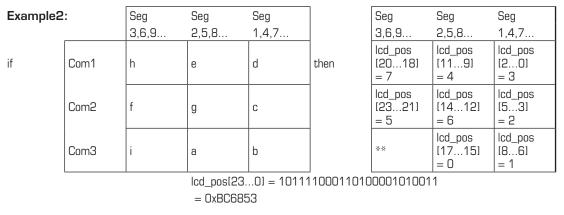
\*\* Special symbols are fixed by LCD designand can not be rearranged. It has to be take care that those segments are connected to Com3 and

Seg3,6,9... Lines

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\*\* Special symbols are fixed by LCD design and can not be rearranged. It has to be taken care that those segments are connected to Com3 and Seg3,6,9... Lines

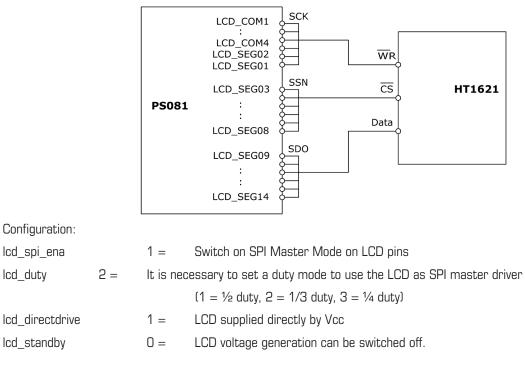
4.3 Support of an External LCD Driver

PSØ81 offers the possibility to control an external LCD driver. Therefore a simplified SPI master mode was implemented, especially adopted to Holtek HT1621 and FM µpd7225 devices.

For the SPI interface pins of the LCD driver are used. Up to 6 pins have to be used in parallel to have enough driver power.

Connecting an external LCD driver circuit:

Figure 4.10 External LCD Driver





lcd_spi_out[2:0]	Set the LCD pins as SPI outputs, 6 pins in parallel each.					
	xx1	switch on LCD_COM1LCD_COM4,LCD_SEG1,LCD_SEG2 as SCK				
	x1x	switch on LCD_SEG3LCD_SEG8 as SSN				
	1xx	switch on LCD_SEG9LCD_SEG14 as SDO				
spi_delay[2:0]	Sets the timing for the LCD SPI master interface					
	0 =	fast (about 500 ns period)				
	:					
	7 =	slow (about 10 µs period)				

Programming:

After a no2lcd opcode the registers 61 and 62 hold the pixel data according to standard segments.

The re-arrangement according to lcd\_pos is done in the LCD driver. After opcode newlcd the re-ar-

ranged data can be read from RAM addresses:

reg\_lcd\_pix\_sort61= 64+32+2 = 98

reg\_lcd\_pix\_sort62= 64+32+3 = 99

It is reasonable to wait a few cycles after the new\_lcd command.

There are new opcodes that support the LCD SPI master:

ssnPulseGenerates a positive pulse on the "SSN" line (lines LCD\_SEG3...LCD\_SEG8)

ssnSet Sets "SSN" to HIGH.

spi2lcd This opcode sends the content of accumuator y to the SPI interface. The second parameter defines, how many bits are transmitted. This function is mainly needed when operating an external LCD driver via SPI.

Note:

- no2lcd opcode formats the number for output on the external LCD. It always has to be used in combination with newlcd opcode
- Maybe you need to adapt lcd\_pos in register 12 according to your LCD
- Please be aware that accumulator x, y and z are used and modified by no2lcd and spi2lcd opcodes.
- There is no possibility to connect both the internal and external LCD. Only one mode at a time can be driven.

Example:

; initialization jsub init\_holtek ; measurement ramadr 20 ;HBO move x, r no2lcd x, 1 newlcd jsub driver\_4 ; further routines

Please see code snippet in the appendix, explaining sub-routines 'driver\_4' and 'init\_holtek'. Basically, the holtek driver needs to be initialized and after the newlod opcode the content is sent to the LCD by the sub-routine 'driver\_4' (MUX4 LCD).

4.4 I/O-pins

PSØ81 has six I/O pins:

0 - SPI_DO_IOO	Serial data out (SDO) or multipurpose I/O
1 - SPI_DI_IO1	Serial data in (SDO) or multipurpose I/O
2 - SPI_CLK_IO2	Serial clock (SDO) or multipurpose I/O
3 - MULT_103	In Wheatstone application used for the analog multiplexer, interrupt.
	Otherwise, output or multipurpose I/O
4 - MULT_104	Multipurpose I/O
5 - MULT_105	Multipurpose I/O

The pins can be programmed as inputs or outputs with pull-up or pull-down resistors in case the chip is in stand-alone mode (SPI interface not used, SPI\_ENA=0). Pin MULT\_IO3 can be used as input/ output only when Wheatstone mode is not used. If none of the pins is configured as an output, the number of inputs can be increased up to 21 as described later on.

Additionally, Pin 24, SPI\_CSN\_RST can be used as reset input in case the SPI interface is not used (SPI\_ENA = 0). The reset is high active.

4.4.1 Configuration

SPI_DO_IOO	Configreg_11, bit 16,17	io_en_0_sdo
SPI_DI_IO1	Configreg_11, bit 18,19	io_en_1_sdi
SPI_CLK_IO2	Configreg_11, bit 20,21	io_en_2_sck
MULT_IO3	Configreg_11, bit 22,23	io_en_3_mio
MULT_IO4	Configreg_17, bit 2,3	en_io4
MULT _105	Configreg_17, bit 4,5	en_io5



4.4.2 Port definition

00 = output

- 01 = input with pull-up
- 10 = input with pull-down
- 11 = input

MULT\_IO4 & O5 are set by default as inputs. MULT\_IO4 is set to O1 because in PSØ8 this pin is connected to Vcc. This way, the pin compatibility is kept.

## 4.4.3 Output – write

The outputs are set in configuration register 0 and register 17:

SPI_DO_IOO	Configreg_0, bit 10	io_alO]
SPI_DI_IO1	Configreg_0, bit 11	io_a[1]
SPI_CLK_IO2	Configreg_0, bit 12	io_a[2]
MULT _IO3	Configreg_0, bit 13	io_a[3]
MULT_IO4	Configreg_17, bit 6	io_a[O]
MULT _105	Configreg_17, bit 7	io_a[1]

## 4.4.4 Increasing the number of Inputs

By means of external diodes, the maximum number of inputs is 21, <u>as long as no output is used</u>. In dependency of how many pins you connect, the number of maximum inputs varies. The following table and illustration show the conection of the inputs. Please note, that in Wheatstone mode there is a natural reduction of 1 pin, as I/O3 is used to control an external switch in Wheatstone mode.

Table 4.3 Number of I/Os

# of pins	# of inputs
6	21
5	15
4	10
3	6

The combination of 2 input lines gives another input. The 2 lines are connected over diodes electrically. Please see the follwing picture showing the maximum number of combinations (21). The possibility of increasing the number of inputs makes only sense if you want to have more than 4 inputs, otherwise you can use Mult IO 0 to Mult IO 3 directly.

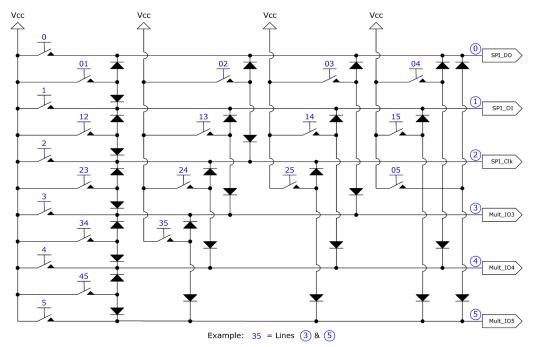
The recognition of synchronously pressed buttons is timing sensitive. Therefore the status register RAM address 26 to 28 have implemented the following features:

 Simultaneously pressed buttons are detected only if the single buttons haven't been pressed before.

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#### Figure 4.11 Maximum Number of Inputs



- If a Simultaneous key is recognized, then the single button information is ignored.
- Only one pair of simultaneously pressed buttons can be detected at once. Further buttons will be ignored.
- More than one buttons can be pressed, but only subsequently, not at once.

Please note: If you connect several inputs to each pin according to the suggested method you must check the status of the inputs in register 26 to 28. You can NOT use register 22 in this case!

4.4.5 Input – read
4.4.5.1 4 inputs or less / inputs and outputs mixed
The flags of the inputs IOO to IO3 are shown in status register, address 22. There is an indication of the rising edge, falling edge or whether the button was pressed:
Status information RAM address 22\* (like in former PSØ8)
Status[23]= flg\_io3\_mio
Status[21]= flg\_io2\_sck
Status[21]= flg\_io1\_sdi
Status[20]= flg\_io\_sdo
Status[07]= flg\_io3\_mio\_r Rising edge
Status[06]= flg\_io2\_sck\_r Rising edge

\*) Important: Please use RAM registers 26 to 28 to look for the button status if you use more than 6 I/Os. If you have less than 6 I/Os you can check the status at RAM address 22.





Status[05]= flg\_io1\_sdi\_r Rising edge Status[04]= flg\_io0\_sdo\_r Rising edge Status[03]= flg\_io3\_mio\_f Falling edge Status[02]= flg\_io2\_sck\_f Falling edge Status[01]= flg\_io1\_sdi\_f Falling edge Status[00]= flg\_io0\_sdo\_f Falling edge

4.4.5.2 More than 4 inputs, no outputs

The status of the inputs can be queried from the status registers at RAM address 26 to 28.

The status information is updated every time the program jumps into the EEPROM (bug fix PSØ8).

Status_F, address 26:	Falling edges status
Status_R, address 27:	Rising edges status
Status_P, address 28:	Pressed edges status

Bit:	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Input:	05	15	04	25	14	03	35	24	13	02	45	34	23	12	01	5	4	3	2	1	0

If two inputs are active at the same time, the PSØ81 handles this like an additional button. E.g., if buttons MULT\_IO3 and MULT\_IO4 are high at the same time, then bit [14] will be set in Status\_R and Status\_P. This allows the use of up to 21 buttons (see below).

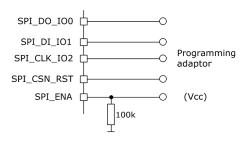
### 4.5 SPI-Interface

### 4.5.1 Interfacing

The SPI interface is used to write the program, configuration and calibration data into the EEPROM. It can further be used to operate the PSØ81 as a pure converter chip by means of an external microcontroller. In this case the pull-down resistors are no longer necessary.

Pulling SPI\_ENA high switches the SPI interface on, the pins are used for the SPI interface and no longer as I/O ports. It is necessary to send a positive pulse on the CSN line before each opcode.

Figure 4.12 SPI interfacing





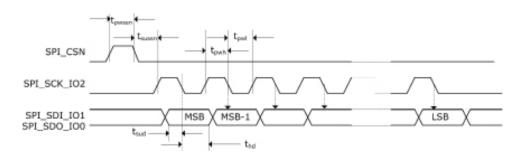
## 4.5.2 SPI Timing

Here we describe only the SPI timing for operation as a pure converter that communicates with an external microcontroller. PSØ81 supports only 1 mode out of 4 possible ones:

Clock Phase Bit = 1, Clock Polarity Bit = 0

Data transfer with the falling edge of the clock. The clock starts from low.

Figure 4.13 SPI timing



#### Table 4.4 SPI Timings

Time:	Description:	t <sub>min</sub> [ns]
tpwssn	Pulse width SSN	500
tsussn	Setup time SSN / SCK	500
tpwh	Pulse width SCK high	500
tpwl	Pulse width SCK low	500
tsud	Setup time data	30
thd	Hold time data	30

tpwh and tpwl together define the clock frequency of the SPI interface. Consequently, 1 $\mu$ s corresponds to a clock rate of 1 MHz to run the SPI transmission. After sending a reset through the SPI, it is necessary to wait for 200  $\mu$ s before sending the next opcode. If auto-configuration is on, it is necessary to wait for 1 ms. After writing to the RAM via SPI it is necessary to wait for 10  $\mu$ s.

4.5.3 4.5.3.1	SPI - Instructions RAM Access			
RAM Write	= b0	0000000	= h00	
RAM Read	= b0	1000000	= h40	
New_LCD	= b0	1000110		= h46
Power reset	= b1	1110000	= hFO	
lnit reset	= b1	1000000	= hCO	
Start_new_cy	cle = b11001100	D = hCC		(continuous)
Start_TDC_cy	ycle = b11001110	D = hCE	(single a	conversion)
watch_dog_o	ff = b1	0011110	= h9E	
watch_dog_o	n = b1	0011111	= h9F	



### 4.5.3.2 EEPROM Access:

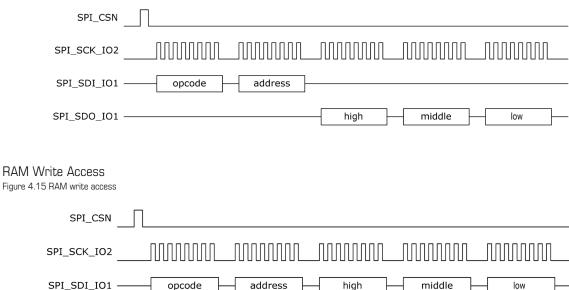
EEprom_bgap_off	= b10000110		= h86	
EEprom_bgap_on	= b10000111		= h87	
EEprom_enable_off	= b10010000		= h90	
EEprom_enable_on	= b10010001		= h91	
EEprom_read	= b10100000		= hAO	(protected read)
EEprom_write	= b10100001		= hA1	
EEprom_bwrite	= b10100011		= hA3	(block write)
EEprom_berase	= b10100100		= hA4	(block erase)
userEEprom_read= b101	= hA5		address 2000-2047	

It is necessary to switch on the bandgap and to enable the access before writing to or reading from

the EEPROM.(send EEprom\_bgap\_on, EEprom\_enable\_on)

### RAM Read Access

Figure 4.14 RAM read access



## EEPROM Read Access / Read Protection

The PSØ81 EEPROM is protected against unauthorized reading. It is only possible to compare known data with the EEPROM content. When accessed through the interface, the EEPROM is addressed word-wise, thus giving 2 bytes (16 bits) per address. Reading from the EEPROM checks 8 bytes at once. The address therefore jumps by 4, the lower two bit should be always zero. The chip compares

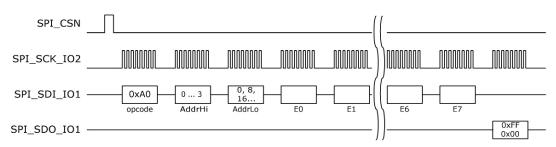
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the transmitted data with the EEPROM content. The result is available after 1 ms on the SDO port. =xFF stands for correct data, 0x00 for wrong data.

An unauthorized person has to test all possible combinations. This will last for  $2^64$  bits \* 10 ns = 5849 years just for one read.

Figure 4.16 Read protection

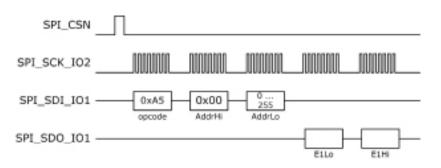


NOTE: EO, E2...E6 are the lower byte, E1, E3....E7 are the corresponding higher bytes in a word.

### User-EEPROM Read Access

The upper 48 bytes of the EEPROM, address 2000 to 2047, are specified as userEEPROM. The user EEPROM is also accessed word-wise (16 bits) when addressed through the SPI interface. It is possible to read from these cells by means of opcode userEEPROM\_read. userEEPROM\_read reads

back one 16 bit word. Figure 4.17 User-EEPROM read access



#### **EEPROM Write Access**

The EEPROM is split into four blocks of 512 bytes or 256 words. The blocks are addressed by the lowest two bits of the first sent address byte. All write commands are followed by 16 bit data words with the lower 8 bits to be sent first. Programming is started by a sixth data word and stopped 4 ms later by a seventh data byte.

It is not possible to write a word into an EEPROM cell that is not empty. So it is not possible to fill up a word to OxFFFF (additional measure to protect from unauthorized reading).



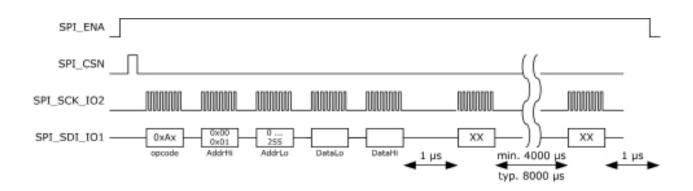


Figure 4.18 EEPROM write access

EEProm\_berase:

Erase the complete block addressed in AddrHi. Looks the same as EEProm\_write but the AddrLo and data bytes are ignored. For erasing the complete EEPROM this command has to be sent four times (AddrHi = 0, 1, 2 & 3).

4.5.4 Run PSO81 with external µC via SPI (non-steady configuration) Before starting: Please make sure the EEPROM is empty. Sequence of commands to configrue the chip and start the measurement: Power Reset (OxFO) Watchdog off (Ox9E) Configure PSO81 in RAM: RAM Write (0x00) + add + 3x8BitWrite RAM address 48..66 Important: all epr\_xxx\_xxx bits to 0 (configreg\_1, bit 0-2) Optional: Control read of RAM config RAM Read (0x40) of RAM address 48..64 Configuration done. Init Reset (OxCO) Start New Cycle (OxCC) Poll / Interrupt SPI\_DO: New measurement value is indicated by SPI\_DO 1 -> 0 Either poll it with  $\mu$ C or use interrupt pin of  $\mu$ C. When SPI\_DO goes from 1 to 0, toggle SPI\_CS from 0 -> 1 -> 0 (this way SPI\_DO is enabled for SPI communication): Read HBO result at RAM address O (RAM Read, 0x40)

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Annotations:

- You should make sure to erase the EEPROM before starting the sequence
- SPI\_ENA must be HIGH. This enables the SPI-Slave mode and the SPI interface.
- When the measurement is started, new data is indicated by SPI\_DO. Connect this wire to an input
  of your microcontroller and poll this pin. Alternatively connect it to an interrupt pin.
- When the interrupt is triggered please toggle the SPI\_CSN pin in order to switch the SPI\_DO wire from interrupt to communication mode (see pictures below)
- The hex-numbers in braces are the SPI opcodes. Please see chapter 4.5 SPI-Interface of the PS081 data sheet for an overview.
- There is also a way to store the configuration steadily in the EEPROM and only activate it by a power reset. Ask us for further information if you want to realize this way.
- Erasing the EEPROM, if required, can be done the following way:

### Power reset (OxFO)

Erase EEPROM: Bgap on (0x87)

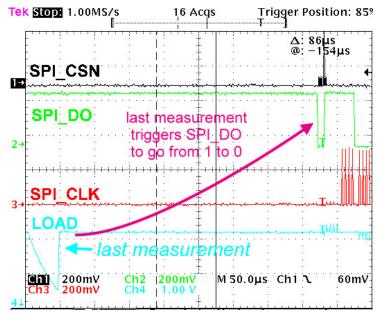
EEPROM enable on (0x91) EEPROM block erase 0 (0xA4, AddHi = 0) EEPROM block erase 1 (0xA4, AddHi = 1) EEPROM block erase 2 (0xA4, AddHi = 2) EEPROM block erase 3 (0xA4, AddHi = 3) Bgap off (0x86) EEPROM enable off (0x90)

It is recommended to read the HBO result from RAM address O. Reading from RAM address 20 (also HBO result) can result in a adress pointer conflict which is avoided when reading on address O. Please note, that the HBO result is automatically copied to RAM address O as long as there is no program in the EEPROM (pure Front-End converter operation). If you have an additional EEPROM program (e.g. pre-processing) you need to copy the HBO result from address 20 to address O manually!

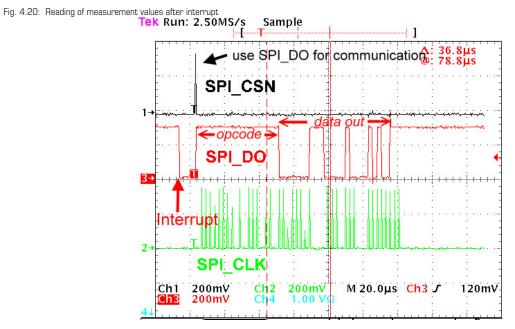




Fig. 4.19: Oscillograph of LOAD and SPI signals



In Fig. 19 you can see that SPI\_DO gives an interrupt after the last discharging cycle of the measurement was done.



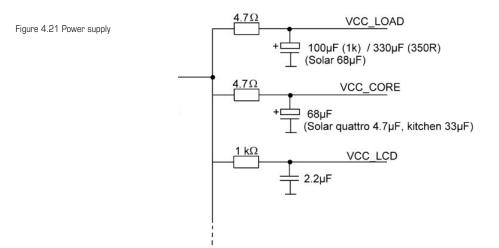
This oscillograph shows again the SPI\_DO interrupt from 1 -> 0 and the response from the external microcontroller with SPI\_CSN. This short pulse on SPI\_CSN switches SPI\_DO to communication mode. Then the opcode is sent to PSO8 (not in the chart, this appears on line SPI\_DI) and after 2 bytes the measurement results (3 bytes) is transmitted via SPI\_DO (marked in the graph by ,data out').

## PSØ81

### 4.6 Power Supply

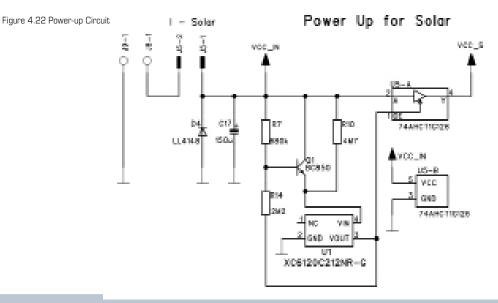
For a good measurement quality it is mandatory to follow some rules for the power supply.

There are several supply areas in the chip, VCC\_LOAD, VCC\_CORE and VCC\_LCD. It is necessary to feed them with voltages decoupled by low-pass filters. Further, those pins need sufficient blocking capacitance mounted close to the chip.



In case of solar applications without any additional battery it is necessary to implement a power-up circuit. It provides a good start-up behaviour when the scale comes from total darkness. A solar panel delivers only a few microampere at poor light conditions and still has to start up the circuit.

The following figure shows a power-up circuit that is optimized for kitchen scales. To start up the scale it needs only about 3  $\mu$ A @ 3.6 V. For other applications it might be necessary to change some values of the components.





### Short description of the function:

Coming from total darkness, all capacitors are discharged and the output of U5 is high-Z. The input voltage of U4 is zero. PS081 is not supplied by voltage. If light is switched on, the current from the solar panel charges C17 and supplies the voltage detection. The voltage detection (R7,R14,Q1,U3) is dimensioned so that U1 switches when the voltage at C17 passes 3.5 V. At that moment, the output of U5 leaves high-Z and goes to the voltage of C17. U4 is supplied with 3.5 V and regulates to 2.5 V for the PS081. PS081 begins to work. Because all capacitors behind VCC\_R have now to be charged to the voltage at C17, this voltage drops down as only C17 can supply the necessary current. The solar panel is to weak for such a high current pulse. The voltage at C17 must not be lower than 2.55 V. Otherwise U4 cannot regulate 2.5 V for the PS081. C17 is also the buffer capacitor for low light situation. With the selected dimension under very bad light condition (20 Lux) the scale can operate for minimum 1 minute if it is well charged before. Therefore 1000  $\mu$ F is the recommended value for C17 (minimum 680  $\mu$ F).

Avoid to go below 680  $\mu$ F. The circuit cannot start up if C17 is too low. The circuit will work with higher values, too, but the start-up time from darkness will increase because the charging time for C17 increases. The circuit is evaluated in detail and it is strongly recommended to follow the recommended values for a correct operation. For further information, see application note ANO22 and design guide DG\_Solar\_POR.

### 4.6.1 Filtering / Recommendations LDO

In most circuits the voltage is regulated by a voltage regulator (LDO, low drop-out regulator). Of course this component has a noise which basically influences the measurement quality. Therefore it is crucial to choose suitable LDOs with a low-noise behavior, still keeping in mind that some applications need a low-current regulator as well. In this section we will give some recommendations which LDOs to choose.

The critical factor to watch out for is the ,output noise'. The noise figures can normally be found in the datasheet of the LDO and is given as a summary value over the whole frequency range, e.g. 500 $\mu$ V RMS or in dependency of the frequency in  $\mu$ V /  $\sqrt{Hz}$  or as a diagram. A low output noise is desired, the figures can easily vary by factor 10 (e.g. Linear LT1761-BYP has 20 $\mu$ V RMS (with by-pass capacitor) vs. TI TPS71501 which has 575 $\mu$ V RMS).

NOTE : We do NOT recommend switching regulators in any case, please use linear voltage regulators only as per the following recommendations.

### Recommendations:

Table 4.4 LDO Recommendations

LDO	Features	Low-pass filter	Applications
Torex XC2206	medium noise, low cur- rent	use good low-pass filter	Solar
Micrel MC5205	medium noise, cheap solution	use medium low-pass filter	Low-cost solutions
Linear LT1761-BYP	very low noise, costly solution	use standard low-pass filter	High-end applications
TI TPS71501	very high noise	-	NOT RECOMMENDED!!!

Of course this list is far away from being complete. It shall just give some recommendations accor-

ding to our experience in practical tests. Basically every low-noise, low-current LDO is suitable to use.

Caution: Please do NOT use the TI TPS71501 LDO as we saw major problems due to the noise of this regulator!

The additional low-pass filtering can help to reduce the noise getting through to the chip. Different types of low-pass filters can be used before decoupling the voltages:

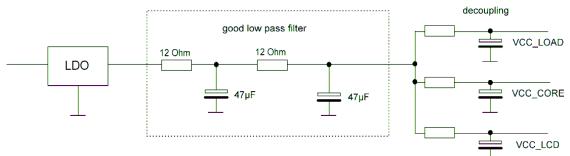


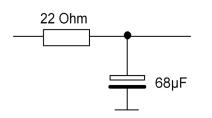
Figure 4.21 Example for a good low pass filtering

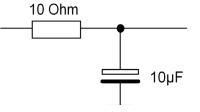
The good low-pass filter can reduce the noise coming from the LDO so that in combination with the decoupling of the voltages supplying the PSO81 are widely noise-free or at least minimized. If the noise from the LDO is lower (like with the Linear or Micrel type i.e.) a simpler lowpass filter can be used, like the following:

Figure 4.22 Example for medium and standard low pass filtering

### medium low pass filter

### standard low pass filter







In the acam-circuits like those of the evaluation-kit or the examples for solar-quattro scales these insights are already put to practice. When building up your own circuit please make sure you follow the recommendations as they will contribute to a good overall measurement quality.

### 4.6.2 Voltage Measurement

An internal bandgap reference is used for measuring the voltage. This is done 40 times per second. The result is stored in the RAM at address 25, UBATT. It is calculated as Voltage =  $2.0 V + 1.6 V^*$  UBATT/64.

The result can be used for low-battery detection:

the level is set in configuration register low\_batt[2:0]:

low_batt	0	1	2	3	4	5	6	7
Level (V)	2.2	2.3	2.4	2.5	2.6	2.7	2.8	2.9

Flag flg\_ub\_low in the status register indicates if the voltage is below the set level .

- Power supply rejection: The measured voltage can be used to correct the dependency of the gain from the voltage. It is switched on by setting configuration bits mult\_en\_ub = 1 and mult\_ub[7:0]. The result of the strain measurement will be corrected according to HB = HB/(1 + UB\*[-128 ... 127]/2^21).
- EEPROM protection: when the voltage is below 2.4 V the automatic EEPROM write (putepr) is prohibited. This protects the EEPROM against corrupt data.

Caution: If the supply voltage goes below 2.1 V the voltage measurement will be wrong (the displayed value is too high) and the measured values cannot be used. In 1.5 V systems there is no possibility to measure the supply voltage with PSØ81.

## PSØ81



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5.3	List of configuration registers	5-6

#### 5 **Configuration Registers**

PSØ81 has 18 configuration registers of 24 Bit width, to be addressed in the RAM from address 48 to 66. The configuration registers control the whole chip including the strain measurement and the LCD controller. The configuration settings are mirrored in the EEPROM and the configuration is made by configuring EEPROM bytes 0 to 47 (48 bytes of configuration).

It is possible to write into the configuration registers

- By the internal microprocessor during operation •
- Through the SPI interface from an external processor •
- During the Power-on reset transferring a basic configuration from the EEPROM ۲

#### 5.1 Overview

Configuration Register	RAM address	EEPROM	bytes		PSØ8 vs. PSØ81 change
Configreg_00	48	2	1	0	no
Configreg_01	49	5	4	3	no
Configreg_02	50	8	7	6	no
Configreg_03	51	11	10	9	no
Configreg_04	52	14	13	12	no
Configreg_05	53	17	16	15	no
Configreg_06	54	20	19	18	no
Configreg_07	55	23	22	21	no
Configreg_08	56	26	25	24	no
Configreg_09	57	29	28	27	no
Configreg_10	58	32	31	30	no
Configreg_11	59	35	34	33	no
Configreg_12	60	38	37	36	no
Configreg_13	61	not mirro	red in EEP	ROM	no
Configreg_14	62	not mirro	red in EEP	ROM	no
Configreg_15	63	not mirro	red in EEP	ROM	no
Configreg_16	64	41	40	39	YES
Configreg_17	65	44	43	42	NEW
Configreg_18	66	47	46	45	NEW

Table 5

Internal microprocessor:

Configuration of registers is done in EEPROM and then mirrored to RAM. LCD segements are not configured in the EEPROM but written directly to the RAM address 61-63.

External microprocessor:

Don't use the EEPROM. Configure directly in the RAM addresses and set the paranetrs epr pwr cfg, epr\_pwr\_prg and epr\_usr\_prg to 0 (Configreg\_01, Bits[2:0]).



## 5.2 Alphanumeric listing of configuration parameters

#### Table 5.2 Alphanumeric listing of configuration Parameters

Parameter	Register	Bits	Recommended Value
abgl_hr	1	1922	5
auto10k	2	0	1
avrate	2	1423	>1
bridge	3	0,1	
calcor	10	1623	20
clkdivepr	16	14,15	1
clksyc	17	0,1	1
con_comp	11	0,1	
cpu_speed	0	1,2	2
cytime	2	413	
c10_div_lcd	17	1115	
dis_haltpp_ps	0	0	0
dis_noise4	3	14	1
dis_osc_startup	0	3	1
dis_pp_cycle_mod	11	14	1
dis_startdel	11	15	0
en_avcal	1	9	0
en_fullbr_p	16	17	0
en_io4	17	2,3	2
en_io5	17	4,5	2
en_noise_c10_lcd	16	23	1
en_wheatstone	3	21	
ena_nonlin	16	16	0
epr_pwr_cfg	1	2	
epr_pwr_prg	1	1	
epr_usr_prg	1	0	
fha_en	16	11	0
force_unused_port	11	13	0
high_res	16	1	1
io_a	0	1013	
io_a	17	6,7	
io_en_O_sdo	11	16,17	
io_en_1_sdi	11	18,19	
io_en_2_sck	11	20,21	
io_en_3_mio	11	22,23	
lcd_duty	1	15,16	

Parameter	Register	Bits	Recommended Value
lcd_charge	16	20,21	
lcd_directdrive	16	19	
lcd_dis_chargem	1	11	
lcd_fastld	11	8,9	1
lcd_freq	1	1214	
lcd_pos	12	023	
lcd_pulsed	17	1619	
lcd_r_const	11	6,7	2
lcd_r_fastld	11	3,4	1
lcd_segment	13	023	
lcd_segment	14	023	
lcd_segment	15	07	
lcd_spi_ena	16	22	0
lcd_spi_out	17	810	0
lcd_standby	11	12	
lcd_swload1k	11	5	
lcd_vlt	11	10,11	3
low_batt	1	35	
messb2	1	18	1
mfake	3	2,3	2
mod_caltdc	3	23	0
mod_rspan	1	6	
mult_en_pp	1	7	
mult_en_ub	1	10	
Mult_Hb1	4	023	
Mult_Hb2	5	023	
Mult_Hb3	6	023	
Mult_Hb4	7	023	
Mult_NLK	18	023	0
multio_sel	16	03	
Mult_PP	10	07	
Mult_TkG	8	023	
Mult_TkO	9	023	
Mult_Ub	10	815	
neg_sense	3	15	0
osz10khz_fsos	0	49	50
portpat	2	1	1
pptemp	2	3	1
ps_dis_phaseshift	3	11	0



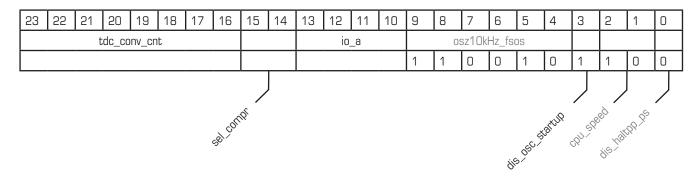
Parameter	Register	Bits	Recommended Value
ps081adjust	3	49	33
ps_sel_calper	3	10	0
ps_speed	16	12,13	0
rspan_by_temp	1	8	
run_la_cont	16	4	0
sel_compint	11	2	
sel_compr	0	14,15	0
sel_qha	16	79	2
sel_speed_mh	16	5	0
sel_start_osz	3	1719	
sense_discharge	16	10	1
single_conversion	2	2	
speed_talu	1	23	0
spi_delay	17	2123	3
stop_osz	3	20	0
stretch	3	12,13	
tdc_conv_cnt	0	1623	
tdc_sleepmode	1	17	
use_10kHz_lcd	16	18	1

## 5.3 List of configuration registers

Bit number $ ightarrow$	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
parameter $ ightarrow$			paran	n1			para	m2								
Recommended value $  ightarrow $							1	1	0	0	1	0	1	0	1	0

gray\_labels = acam internal bits, use recommended settings (line below)

Configreg\_00: RAM address 48 EEPROM bytes 0 - 2



Parameter	Recommended Value	Description	Settings
tdc_conv _cnt	-	Single Conversion Timer based on 10 kHz/64 = 156.25 Hz	
sel_compr	00	Selects comparator working resistor	00 = 10k 01 = 10k 10 = 7k 11 = 4.1k
io_a	-	Setting/reading MULT_IOO to MULT_IO3 Output: output value, can be read back Input: read input value	
dis_osc_startup	1	Reduce current when starting the oscillator	$ \begin{array}{l} 1 = \text{ on} \\ 0 = \text{ off} \end{array} $

	Configreg_01:	RAM address 49	El	EPROM bytes 3	- 5										
	23 22 21 20	19 18 17 16	15	14 13 12	11	10	9	8	7	6	5	4 3	2	1	0
	abgl_hr			lcd_freq							low	/_batt			
	0 0 1 0	1													
													J		
all				A	~	100	/			/		<u> </u>	, 19	67	
speed tall	<	RESERFRONDE IN DUN		Led dischargen rult	ST JL &	No No	TELL.	er Prof	Ĵgl.			epr pur cho	Mr File	s X	
Q1	<u>ک</u> ړ	geo.		ddis mult	ç¢	ipan .	MILL	MOL				els, els,	°Ú,		
	N°														
	Parameter	Recommended Value		ription						Sett					_
	messb2	1		DC measurement	-					1 = 0					_
	tdc_sleepmode	-	remen	without TDC or st at, to be used for e the scale is off,	scann	ing bu	ttons			1 = 0 0 = 0					
	lcd_duty	-	LCD d	uty cycle definition	n					0 = 0					_
										2 = 1	/2duty /3duty				
										3 = 1	/4duty				_
	lcd_freq		Select	: LCD frequency (s	switch	on tır- Pixe		pixels) Time	М	ultinle	x mode				
									1/	/4	1/3	1/2	Hz		_
						0		8.0ms 4.8ms	15 26		20 34	31 52	Hz Hz		-
						2		4.0ms	3		42	62	Hz		-
						2 3 4 5 6 7		3.2ms	30	כ	52	78	Hz		_
						4		2.4ms	52	2	69	104	Hz		_
						<u>כ</u> 6		2.0ms 1.6ms	62 78	2	83	125 176	Hz Hz		-
						7		1.2ms	10		138	208	Hz		-
	lcd_dis_chargem			n off LCD charge p Jrement	oump	during	j the								
	mult_en_ub		Enable correc	e multiplications fo	or sup	ply vo	ltage			1 = E	nabled				_
	rspan_by_temp			emperature measi for temperature				of		1 = a	ictive				_
	mult_en_pp		Enable	e multiplications ir	n gain	corre	ction			1 = E	nabled				
	mod_rspan			e internal multiplic tion resistor Rspa		of gaiı	n com	1-		1 = E	nabled				
	lowbatt			he voltage level fo n and EEpromwrit		batter	ry de-					2.4 V to 1 V * low_b			_
	epr_pwr_cfg		· ·	juration in the EEp er-on reset	prom i	s useo	d afte	r			ontend : I-alone :				_
	epr_pwr_prg			user code at EEPI a power-on reset	ROM	addres	ss 48				ontend : I-alone :	-			_
	epr_usr_prg			user code at EEPf a measurement	ROM	addres	ss 48				ontend : I-alone :				

С	onfig	ireg_	_02:		RAM	addr	ress 5	i0	E	EPRO	M by	/tes 6	- 8										
Γ	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1
					avi	rate									су	time							
					_																1		1
																			Č	hoter ,	P onversio	port pe	autonol
_	Para	ame	ter		Re Val		nend	ed	Desc	cripti	on						Se	tting	S				
_	avrat	e					-					iternal					> 1						
_	cytim	1e					-					Iltiples Id, stre			M H	z perio	od, st	retch	= 0)	or of	100		
_	pptei	np					1			e gain ureme		r and t	empe	rature			1 =	= Enab	led				
	singl	e_co	nversi	on			-		Selec	t oper	ation	mode						= Cont = Singl			e on mo	de	
-	auto'	10k					-		oscilla	ator e	very (	ation c D.6 s b scillato	iy mea					y not gle ma		ed in	streto	hed	
С	onfig	jreg	_03		RAM	l addr	ress 5	51		EPR	DM b	ytes 9	9 - 11										
-	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6 1adju	5	4	3	2	1
	0			0					0	1					1	0	0			1	1	0	
L	Τ			Τ	1					Τ						1	1						
IN IN IN	neatst	JINE ST	JOP DEL	GEI STR	5052	not	, used a	ense dis f	0158A	stretch	in phase	ps sel	alper								Intake	- Vi	, doe
	Para					comn	nende		Desc								Set	tting	6				
6	en_w	heat	estone	9		-	-		Enable	e Whe	atest	cone m	ode				1 =	enab	ed				
ę	stop_	OSZ				-	-		Stop t if ther	the os re is n	cillato o inte	or by c errupt a	omma after /	and (e. AutoOr	g. 1)		1 =	active	9				
					+																		

Sets delay from start of 4 MHz oscil-

lator to start of measurement

0 = off

0 = 00 1 = continously on 2 = 100µs 3 = 200µs 4 = 300µs 5 = 400µs 6 & 7 are not supported

sel\_start\_osz

\_



Parameter	Recommended Value	Description	Settings
stretch	-	Select stretch mode	0 = off 1 = single R measurement 2 = 2xR (half bridge), 200 μs delay 3 = 2xR (half bridge) 300 μs delay
mfake	10	Sets the number of fake measu- rements	
bridge	-	Sets the number of half bridges that are measured	0 = one half bridge (not reasonable) 1 = 2 half bridges 2 = not supported 3 = 4 half bridges

## Configreg\_04 RAM address 52 EEPROM bytes 12 - 14

23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
											Mult	_Hb1											

Parameter	Recommended Value	Description	Settings
Mult_Hb1	-	Multiplication factor for HB1 result h1 := h1 * [-2^23 to 2^23-1]/ 2^20	

Configreg\_05 RAM address 53 EEPROM bytes 15 - 17

23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
											Mult	_Hb2											

Par	amet	er		Rec Valu		nende	ed	Desc	riptio	on						s	ettin	gs					
	;_Hb2				-		•							; 20									_
Confi	Ault_Hb2     -     Multiplication factor for HB2 result h1 := h1 * [-2^23 to 2^23-1]/ 2^20       ponfigreg_06     RAM address 54     EEPROM bytes 18 - 20																						
23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
											Mult_	Hb3											

Parameter	Recommended Value	Description	Settings
Mult_Hb3		Multiplication factor for HB3 result h1 := h1 * [-2^23 to 2^23-1]/ 2^20	



Confi	greg_	_07		RAM	addı	ress 5	55	E	EPRO	DM by	/tes 2	21 - 2	3										
23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
											Mult	:_Hb4											
											1		1										
Par	ame	ter		Rec Valu		nend	ed	Desc	ript	ion													
Mult	;_Hb4					-		Multip h1 :=		ion fac [-2^2													
Confi	greg_	_08		RAN	1 add	lress	56	E	EPRO	DM by	/tes 2	24 - 2	6										
23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
											Mult	t_TkG					_						
Parameter     Recommended Value     Description       Mult_TkG     -     Multiplication factor for Rspan correction Rs := Rs * [-2^23 to 2^23-1]/ 2^20																							
Mult	;_TkG					-		Multip Rs :=	olicati Rs *	ion fac [-2^2	tor foi 23 to 2	r Rspa 2^23-	an corr 1]/ 2⁄	ection 20	n								
Confi	greg_	_09		RAM	1 add	lress	57	E	EPRO	DM by	/tes 2	27 - 2	9										
23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
				-							Mult	t_TkO		-			_						
Par	ame	ter		Rec Valu		nend	ed	Desc	ript	ion													
Mult	;_TkO					-		Offset	; valu	e for F	Rspan,	direc	tly sub	strac	ted								
Confi	greg_	_10		RAM	addı	ress 5	58	E	EPRO	DM by	/tes 3	80 - 3	2										
23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
			cal	cor							Mul	t_Ub							Mu	lt_PP			

Parameter	Recommended Value	Description
Mult_Ub	-	Multiplication factor for gain compensation by means of voltage measu- rement. hb := hb/(1 + ub*[-128 to 127]/2^21)
Mult_PP	-	Multiplication factor for gain correction. $g := g * [0 to 255]/2^7$

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0

0

0

1

0

1

0

0



	Confi	greg_	11		RAM	addro	ess 5	9	E	EPRO	M by	tes 3	3 - 35	ō										
	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
									0	1	0		1	1	0	1	1	0		0	1			
			/	ļ	/	ļ	/	ļ			),						/	J		/	J			
10 an 3 mil	.(0 <sup>)</sup>	n.2.50t	.0.	en la construction de la construcción de la constru	. <sub>10</sub> ,	n D salt	dis-P	torce ,	ind nused .	ud sta	hidby	NO TO		lod fast	\$ \$	LS CORE	icd Switt	100 Jacobs	L. Fast	Sel C	noint	n.comp		

Parameter	Recommended Value	Description	Settings
io_en_O_sdo	-	Port definition	00 = output 01 = input with pull-up 10 = input with pull down 11 = input
io_en_1_sdi		Port definition	00 = output 01 = input with pull-up 10 = input with pull down 11 = input
io_en_2_sck		Port definition	00 = output 01 = input with pull-up 10 = input with pull down 11 = input
io_en_3_mio		Port definition	00 = output 01 = input with pull-up 10 = input with pull down 11 = input
lcd_standby		LCD status	0 = LCD active 1 = LCD voltage supply in stand-by
lcd_vlt		LCD supply voltage	0 = 2V 1 = 2.5V 2 = 3V 3 = 2V without pump
lcd_fastld		Configures the number of fastload periods (10ms) with low-resi- stance voltage divider	
lcd_r_const		Defines the cross resistance of the LCD voltage divider	$\begin{array}{l} 0 = 30 \ \text{k}\Omega \\ 1 = 50 \ \text{k}\Omega \\ 2 = 200 \ \text{k}\Omega \\ 3 = 800 \ \text{k}\Omega \end{array}$
lcd_swload1k		LCD driver's voltage doubler uses 1 $k\Omega$ instead of 200 $\Omega$ to charge capacitor	

lcd_r_fastId		Selects the resistor for fast char- ging the LCD pixels	$\begin{array}{l} 0 = 30 \ \text{k}\Omega \\ 1 = 50 \ \text{k}\Omega \\ 2 = 200 \ \text{k}\Omega \\ 3 = 800 \ \text{k}\Omega \end{array}$
sel_compint		Select internal comparator	1 = Selected
con_comp		Controls the comparators switch- off mode.	<ul> <li>OO = off</li> <li>O1 = off between single measurements</li> <li>10 = off during loading and between single measurements</li> <li>11 = always on</li> </ul>
Configreg_12:	RAM address 60	EEPROM bytes 36 - 38	

lcd_pos	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0

Para	amet	er		Rec Valu		nende	ed	Desc	riptio	on					Se	tting	S						
lcd_p	oos (	23:0	]		-			Positi	on of I	cd se	gment	S											
Config	greg_	_13:	F	RAM	addre	ess 6 <sup>.</sup>	1	N	<u>OT</u> m	iirrore	ed in t	the E	EPRO	M !									
23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
											cd_se	gmen	t										

Parameter	Recommended Value	Description	Settings
lcd_segment [23:0]	-	Display segment digits 2 to 0	
Configreg_14: RAM a	ddress 62 <u>N</u>	<u>DT</u> mirrored in the EEPROM !	
23 22 21 20 19	18 17 16 15	14 13 12 11 10 9 8	7 6 5 4 3 2 1 0
		lcd_segment	

Parameter	Recommended Value	Description	Settings
lcd_segment [47:24]	-	Display segment digits 5 to 3	



## Configreg\_15: RAM address 63 NOT mirrored in the EEPROM !

23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	lcd_segment																						

Parameter	Recommended Value	Description	Settings
lcd_segment [55:48]	-	Display segments special characters (1/3 duty ans 1/4 duty)	

Configreg\_16: RAM address 64 EEPROM bytes 39 - 41

	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
																selqha	9					multi	io_sel	
	1	0.				1	0	0	0	1	0	0	0	1	0	1	0	1.	0	0				
	$\mathcal{T}$	$\mathcal{T}$	/	ļ	$\sum$	$\mathcal{T}$	$\sum$	$\sum$					$\mathbf{r}$	$\mathbf{r}$				$\sum$	$\mathbf{r}$	$\sum$				
windse ud at	ena	d charc	e directiv	drive ADHH	en full	Jr . Pena	nonlin	ikdive pr	<	ps spee	Gener	dische	l <sub>Qe</sub>			Inultihit	el spec	n 10 cc	n <sup>t</sup>					
		amet	ter		1	Reco	mme	nder	i In	escr							ls	ettin	an					

Parameter	Recommended Value	Description	Settings
en_noise_c10_lcd	1	In case the 10 kHz for the LCD charge pump is derived from the 4 MHz, this bit adds noise to the divider factor	1 = activated
lcd_spi_ena	0	Uses integrated LCD driver as SPI Interface for an external LCD driver Circuit	1 = enables external LCD dri- ver control via SPI 0 = use internal LCD driver
lcd_charge[1:0]	-	Selects number of LCD cycles befo- re recharging	$ \begin{array}{l} 0 = \text{recharging each cycle} \\ 1 = \text{recharging each } 2^{\text{nd}} \text{ cycle} \\ 2 = \text{recharging each } 3^{\text{rd}} \text{ cycle} \\ 3 = \text{recharging each } 4^{\text{th}} \text{ cycle} \end{array} $
lcd_direct_drive	-	Drive LCD directly from supply voltage	1 = enabled
use_10kHz_lcd	1	Clock selection for LCD charge pump	<ul> <li>0 = Charge pump clock derived from 4 MHz, divider can be set in the range 480 to 512. The selection avoids a fixed relation between charge pump and mea- surement and therefore reduced distortions of the measurement</li> <li>1 = Use the internal 10kHz oscillator</li> </ul>



sense_discharge	1	Set fast discharge of comparator's low pass capacitor	1 = enabled
multio_sel(3:0)	-	Use mMULTIOO3 pin for diagnoses	0 = multiple I/O 1 11 = internal use 12 = interrupt

Configreg_17:	RAM address 65 EEPROM bytes 42 - 44
oonngrog_r/.	

23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
S	pi_dela	ау			lcd_p	oulsed			c1(	D_div_	lcd		lcd_	.spi_o	ut	ic	_a	en_i	io5	en_	_io4	clks	syc
0	1	1											0	0	0			1	0	1	0	1	0
		C.																					
Par	ame	ter			Reco Valu		ende	d C	Descr	iptio	n					Sett	ings						
spi	delav[	2:01				3		S	ets th	e timi	na for	the L	CD S	PI		0 = f	ast (a	bout 5	500ns	perio	d)		

	value		
spi_delay[2:0]	3	Sets the timing for the LCD SPI master interface	0 = fast (about 500ns period)
			7 = slow (about 10µs period)
lcd_pulsed[3:0]	-	Automatically pulsed display, especially for stand-by in solar applications	00xx = 300  msblinking period $01xx = 600  ms$ blinking period $10xx = 1  s$ blinking period $11xx = 2  s$ blinking period $xx00 =  of $ on-time $xx01 = 100  ms$ on-time $xx10 = 200  ms$ on-time $xx11 = 400  ms$ on-time
c10_div_lcd[5:0]	-	5 bit divider factor for deriving the 10kHz from the 4 MHz. Divider factor = 480+c10_div_lcd	
lcd_spi_out[2:0]	1	Set the LCD pins as SPI out- puts, 6 pins in parallel each	xx1 = switch on LCD_COM1 LCD_COM4,LCD_SEG1, LCD_SEG2 as SCK x1x = switch on LCD_SEG3 LCD_SEG8 as SSN 1xx = switch on LCD_SEG9 LCD_SEG14 as SD0
io_a[1:0]	-	Setting/reading MULT_IO4 and MULT_IO5. Output: output value, can be read back Input: read input value	



en_io4[1:0]	2	Port definition for MULT_IO4	00 = output 01 = input with pull-up 10 = input with pull-down 11 = input
enio5[1:0]	2	Port definition for MULT_IO5	00 = output 01 = input with pull-up 10 = input with pull-down 11 = input
clksyc[1:0]	1	Speed of key Synchronization	

## Configreg\_18: RAM address 66 EEPROM bytes 45 - 47

23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
											Mult	NLK											

## PSØ81



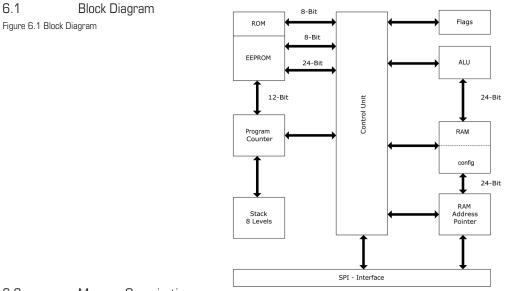
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# **FICO**STRAIN

## 6 Central Processing Unit (CPU)



## 6.2 Memory Organization

## 6.2.1 ROM and EEPROM Organization

Table 6.1

5119	ROM Program Memory
5119	
2048	
2047	Program Memory
 2000	User EEPROM 48 bytes
1999	Program Memory
	EEPROM 1.952 bytes
48	Program entry
4745	Config Reg 18 (mirrored)
4442	Config Reg 17 (mirrored)
4139	Config Reg 16 (mirrored)
3835	Config Reg 12 (mirrored)
53	Config Reg 1 (mirrored)
20	Config Reg O (mirrored)

The ROM area is starting at address 2048. All computation routines needed for the PICOSTRAIN measuring method reside here. There are also further helpful routines that are frequently needed in weight scale applications, e.g. decimal to 7-segment code conversion, averaging, median filter, rounding and hysteresis. These routines can be called by a program in the EEPROM. The program can also jump back from the ROM to the EEPROM when configured.

The EEPROM is 2048 bytes big, split in 4 blocks of 512 bytes. The program memory occupies 1952 bytes starting from address 48. Each jump from the ROM into the EEPROM starts at address 48.



The program in the EEPROM may find out the reason for the jump by means of the status information in register 22.

The lower 48 bytes in the EEPROM are reserved for an automatic configuration of the PSØ81 during a power-on reset. 3 successive bytes are added to a 24 bit word. So there are 16 words of 24 bit that can be read by the program code. They are used for configuration register 0 to 12 and 16 to 18. During a power- on reset they are copied into RAM address 48 to 66.

EEPROM cells 2000 to 2047 are freely accessible. The processor can write to and read from those cells during operation (putepr and getepr, using addresses 0 to 15). They can be used for saving calibration data.

127	User RAM 127	
 112	User RAM 112	Temporarily used by some ROM-routines like median or sinc filter (starting from address 112)
111  100 9998 97	Shadow RAM (used by converter and ALU) Content of LCD segments (external)	
 67	Shadow RAM (used by converter and ALU)	
66	Config Reg 18	
48	Config Reg O	
47	User RAM 47	
 32	User RAM 32	
31 30 29 28 27 26 25 24 23 22 21 20 21 20 19 18 17 16	- - Timer I/O status Pressed I/O status Falling edges I/O status Rising edges UBATT CAL HB1+ Flags (p1-p2)/p2 HB0 = (A-B)+(C-D)+()/(A+B)+(C+D)+() * HB4 = (G-H)/(G+H) HB3 = (E-F)/(E+F) HB2 = (C-D)/(C+D) HB1 = (A-B)/(A+B) Hard E	
15 	User RAM 15	
0	User RAM O	

6.2.2 RAM Organization

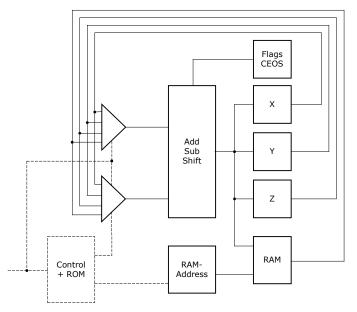
Table 6.2

## PSØ81

### 6.2.3 RAM Address Pointer

The RAM has its own address bus with 127 addresses. The width of 24 bit corresponds to the register width of the ALU. By means of the RAM address pointer a single RAM address is mapped into the ALU. It then acts as a fourth accumulator register. Changing the RAM address pointer does not effect the content of the addressed RAM. The RAM address pointer is modified by separate opcodes (ramadr, incramadr,...)

6.2.4 Arithmetic Logic Unit (ALU) Figure 6.2 ALU block diagram



### 6.2.5 Accumulators

The ALU has three 24-Bit accumulators, X, Y and Z. The RAM is addressed by the RAM address pointer and the addressed RAM cell is used as forth accumulator. A single RAM address is mapped into the ALU by the ram address pointer. So in total there are 4 accumulators. All transfer operations (move, swap) and arithmetic–operations (shift, add, mult24...) can be applied to all accumulators.

### 6.2.6 Flags

The processor controls 4 flags with each operation. Not-Equal and Sign flags are set with each write access to one of the accumulators (incl. RAM). Additionally, the Carry and Overflow flags are set in case of a calculation (Add/Sub/shiftR). It is possible to query each flag by a jump instruction.

## 6.2.6.1 Carry

Shows the carry over in an addition or subtraction. With shift operations (shiftL, rotR etc.) it shows the postponed bit.



## 6.2.6.2 Not-equal zero

This flag is set to zero in case a new result unequal zero is written into an accumulator (add,sub,move,swap etc.).

6.2.6.3 Sign

The sign is set when a new result is written into an accumulator (add,sub,move,swap etc.) and the highest bit (MSB) is 1.

6.2.6.4 Overflow

Indicates an overflow during an addition or subtraction of two numbers in the meaning of two's complement.

- 6.3 Status and Result Registers
- 6.3.1 Result Registers

Content of the RAM result registers at the end of a measurement:

ram=16	: HB1=(A-B) / (A+B)	HB1 un-compensated
ram=17	: HB2=(C-D) / (C+D)	HB2 un-compensated
ram=18	: HB3=(E-F) / (E+F)	HB3 un-compensated
ram=19	: HB4=(G-H) / (G+H)	HB4 un-compensated
ram=20	: HBO=(A-B)+(C-D)+()/	
(A+B)+(C+D)+() HB0 compensated sum		
ram=21	: TMP=(p1-p2) / p2	Temperature
ram=22	: Status	See 6.3.2
ram=23	: HB1+	Time measurement TDC at SG_A1, Pin11
ram=24	: CAL	Resolution TDC
ram=25	: UBATT	Measured supply voltage
ram=26 : Status	s_F	Indicates I/Os and pairs of I/Os with HIGH-to-LOW
ram=27 : Status	s_R	Indicates I/Os and pairs of I/Os with LOW-to-HIGH
ram=28 : Status	s_P	Indicates I/Os and pairs of I/Os with HIGH
ram=29 : Timer		
ram=30,31	: NC	Free, can be used temporarily, will be overwritten
		during measurement
x-Accu	: HBO	Value of ram=20
y-Accu	: Temp	Value of ram=21
z-Accu	: Flags	Value of ram=63
ramadr	: 0	Value of RAM address pointer

#### Descriptions:

A :	Discharge time measurement at SG_A1
B :	Discharge time measurement at SG_A2
C :	Discharge time measurement at SG_B1
D :	Discharge time measurement at SG_B2
E :	Discharge time measurement at SG_C1
F :	Discharge time measurement at SG_C2
G :	Discharge time measurement at SG_D1
H :	Discharge time measurement at SG_D2 $$
P1:	Discharge time measurement at TMP_1
P2:	Discharge time measurement at TMP_2

#### Formats:

HB1:	Result in 100 ppm, HB1/100 = result in ppm
HB2:	Result in 100 ppm, HB2/100 = result in ppm
HB3:	Result in 100 ppm, HB3/100 = result in ppm
HB4:	Result in 100 ppm, HB4/100 = result in ppm
HBO:	Result in 100 ppm, HBO/100 = result in ppm
TMP:	Result(Tmp) = TMP/ $2^{24}$
Status:	See above
HB1+:	Result (HB1+)/ns = 250 * HB1+ $/2^{14}$ [4MHz clock]
CAL:	$\label{eq:result} \mbox{Result (Cal)/ps} \ = 250,000 \ / \ \mbox{CAL} \qquad \mbox{[4MHz clock]}$
UBATT:	Result (UBATT)/V = $2.0+1.6*$ UBATT/64

HB1, HB2, HB3, HB4, HB0 and TMP are given as two's complement. MSB = 1 indicates a negative value. To get the positive value calculate  $X - 2^{24}$ .

#### Explanation:

Based on a standard extension of a load cell (2 mV/V) the resistance variation is 0.2 %, e.g. 2  $\Omega$  at a 1000  $\Omega$  load cell. The change of 0.2 % corresponds to 2000 ppm. For reasons of internal calculations and accuracy, the result is given in x100 of 2000 ppm (= 200,000 ppm). Please note, that the value in this register depends not only on the load cell's sensitivity but also on the Mult\_HBx setting in PS081. This explanation is based on Mult\_HBx = 1.



Examples:

1.5 mV/V load cell, PICOSTRAIN wiring,  $Mult_HBx = 1$ :

1.5 mV/V = 1500 ppm  $\rightarrow$  result in PS081 at maximum strain: 150,000 (0x0249F0)

2 mV/V load cell, Wheatstone wiring,  $Mult_HBx = 1$ :

2 mV/V means 1.333 mV/V in Wheatstone = 1333 ppm (due to a reduction in strain)  $\rightarrow$  result in PSO81 at maximum strain: 133,333 (0x0208D5)

1 mV/V load cell, Picostrain wiring,  $Mult_HBx = 4$ :

1 mV/V = 1000 ppm  $\rightarrow$  result in PSO81 at max. strain: 400,000 (0x061A80)

#### 6.3.2 Status Register

Table 6.3 Status Register (RAM Address 22)

Bit	Description
Status[23]= flg_io3_mio	Pin26(32)
Status[22]= flg_io2_sck	Pin20(25)
Status[21]= flg_io1_sdi	Pin19(24)
Status[20]= flg_io0_sdo	Pin18(23)
Status[19]= flg_rstpwr	1 = Power-on reset caused jump into EEPROM
Status[18]= flg_rstssn	1 = Pushed button caused jump into EEPROM
Status[17]= flg_wdtalt	1 = Watchdog interrupt caused jump into EEPROM
Status[16]= flg_endavg	1 = End of measurement caused jump into EEPROM
Status[15]= flg_intav0	1 = Jump into EEPROM in sleep mode
Status[14]= flg_ub_low	1 = Low voltage
Status[13]= flg_errtdc	1 = TDC error
Status[12]= flg_pslock[1]	1 = Phase shifter locked
Status[11]= flg_pslock[0]	1 = Phase shifter locked
Status[10]= flg_errprt	1 = Error at strain gauge ports
Status[09]= flg_timout	1 = Timeout TDC
Status[08]= error_dspclk	1 = Collision between TDC and DSP
Status[07]= flg_io3_mio_r	1 = Rising edge at Pin26(32), 0 = no edge
Status[06]= flg_io2_sck_r	1 = Rising edge at Pin2O(25), 0 = no edge
Status[05]= flg_io1_sdi_r	1 = Rising edge at Pin19(24), 0 = no edge
Status[04]= flg_io0_sdo_r	1 = Rising edge at Pin18(23), 0 = no edge
Status[03]= flg_io3_mio_f	1 = Falling edge at Pin26(32), 0 = no edge
Status[02]= flg_io2_sck_f	1 = Falling edge at Pin2O(25), O = no edge
Status[01]= flg_io1_sdi_f	1 = Falling edge at Pin19(24), 0 = no edge
Status[00]= flg_io0_sdo_f	1 = Falling edge at Pin18(23), 0 = no edge

Pin numbers in brackets = dice

The status of the inputs can be queried from the status regsiters at RAM addres 26 to 28. Please see chapter 4.4.4 on page 4-17 for more details

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#### 6.4 Instruction Set

The complete instruction set of the PSØ81 consists of 94 core instructions that have unique op-code decoded by the CPU. Further there are emulated instructions like no2lcd that are replaced automatically by the assembler and call a subroutines in the ROM code.

The variety of the instruction set allows to write comprehensive programs that cope with the 2 K size of the EEPROM.

#### 6.4.1 Branch instructions

There are 3 principles of jumping within the code:

- Jump. Absolute addressing with 12 Bit within the whole address space.
- Branch. Relative to the actual address with 8 Bit in the range of -128 to +127 bit addresses.
- Skip. Jump ahead up to 3 op-codes (3 to 15 bytes).

The assembler puts together jump and branch into goto-instructions.

It is possible to jump into subroutines only by means of absolute jumps and without any condition.

#### 6.4.2 Arithmetic operations

The RAM is organized in 24 Bit words. All instructions are based on two's complement operations. An arithmetic command combines two accumulators and writes back the result into the first mentioned accumulator. The RAM address pointer shows the RAM address that is handled in the same way as an accumulator. Each operation on the accumulator affects the four flags. The flags refer to the last operation.

#### Table 6.4 Instruction set

Simple Arithmetic	Complex Arithmetic	Shift & Rotate	RAM access
abs	div24	cIrC	clear
add	divmod	rotl	decramadr
compare	mult24	rotR	incramadr
compl	mult48	setC	move
decr		shiftL	ramadr
getflag		shiftR	swap
incr			
sign			
sub			

Logic	Bitwise	LCD display	EEPROM access
and	bitclr	clrLCD	equal
eor	bitinv	dez2lcd	getepr
nor	bitset	newlcd	putepr
invert		no2lcd	useEprInit
nand		no2LcdAccu	
nor		setLCD	
or		spi2lcd	



Unconditional jump	Skip on Flag	Miscellaneous
goto	skip	clk10kHz
gotoBitC	skipBitC	clrwdt
gotoBitS	skipBitS	gr2st
gotoCarC	skipCarC	hysterises
gotoCarS	skipCarS	initAvg
gotoEQ	skipEQ	initTDC
gotoNE	skipNE	median
gotoNeg	skipNeg	newcyc
gotoOvrC	skipOvrC	nop
gotoOvrS	skipOvrS	rollAvg
gotoPos	skipPos	round
jsub		ssnPulse
jsubret		ssnSet
		stop

abs	Absolute value of register
Syntax:	abs p1
Parameters:	p1 = ACCU [x,y,z,r]
Calculus:	p1 :=   p1
Flags affected:	COSZ
Bytes:	2
Cycles:	2
Description:	Absolute value of register
Category:	Simple arithmetic
add	Addition
Syntax:	add p1,p2
Parameters:	p1 = ACCU [x,y,z,r] p2 = ACCU [x,y,z,r] or 24-Bit number
Calculus:	p1 := p1 + p2
Flags affected:	COSZ
Bytes:	2 (p2 = ACCU) 4 (p2 = number)
Cycles:	2 (p2 = ACCU) 4 (p2 = number)
Description:	Addition of two registers or addition of a constant to a register
Category:	Simple arithmetic

and	Logic AND
Syntax:	and p1,p2
Parameters:	p1 = ACCU [x,y,z,r]
	p2 = ACCU [x,y,z,r]  or  24-Bit number
Calculus:	p1 := p1 AND p2
Flags affected:	SZ
Bytes:	2 (p2 = ACCU)
Quala	5 (p2 = number)
Cycles:	3 (p2 = ACCU) 6 (p2 = number)
Description:	Logic AND of 2 registers or Logic AND of register and constant
Category:	
bitclr	Clear single bit
Syntax:	bitclr p1,p2
Parameters:	p1 = ACCU [x,y,z,r]
	p2 = number 0 to 23
Calculus:	p1:=p1 and not (1< <p2)< td=""></p2)<>
Flags affected:	SZ
Bytes:	2
Cycles:	2
Description:	Clear a single bit in the destination register
Category:	Bitwise
bitinv	Invert single bit
Syntax:	bitinv p1,p2
Parameters:	p1 = ACCU [x,y,z,r] p2 = number 0 to 23
Calculus:	p1:=p1 eor (1< <p2)< td=""></p2)<>
Flags affected:	SZ
Bytes:	2
Cycles:	2
Description:	Invert a single bit in the destination register
Category:	Bitwise
1.5.	
bitset	Set single bit
Syntax:	bitset p1,p2
Parameters:	p1 = ACCU [x,y,z,r] $p2 = number 0 to 23$
Calculus:	p1:=p1 or (1< <p2)< td=""></p2)<>
Flags affected:	SZ
Bytes:	2
Cycles:	2
Description:	Set a single bit in the destination register
0 0 p 0 . 0	



clear	Clear register
Syntax:	clear p1
Parameters:	p1 = ACCU [x,y,z,r]
Calculus:	p1 := 0
Flags affected:	SZ
Bytes:	1
Cycles:	1
Description:	Clear addressed register to O
Category:	RAM access
clk10khz	Clock source 10 kHz
Syntax:	clk10khz p1
Parameters:	p1 = number 0 or 1
Calculus:	-
Flags affected:	-
Bytes:	2
Cycles:	3
Description:	Change clock source of processor to 10 kHz. The clock of the processor is switched to the slower 10 kHz clock instead of the 40 MHz. The 10 kHz clock is still stable to variations in temperature and supply voltage. If p1 is set to 1 the 10 kHz clock is on, if p1 == 0 the 10 kHz clock is off.
Category:	Miscellaneous
clrC	Clear flags
Syntax:	clrC
Parameters:	-
Calculus:	-
Flags affected:	CO
Bytes:	1
Cycles:	1
Description:	Clear Carry and Overflow flags
Category:	Shift and Rotate
clrLCD	Clear LCD
Syntax:	cirLCD
Parameters:	-
Calculus:	-
Flags affected:	-
Bytes:	1
Cycles:	Subroutine call
Description:	Clear LCD registers 61 & 62. Use this opcode in combination with ,newlcd' to switch off all LCD segments. In real a subroutine in the ROM code is called. The assembler converts this com-
	mand to the corresponding jump command.

clrwdt	Clear watchdog
Syntax:	clrwdt
Parameters:	-
Calculus:	-
Flags affected:	-
Bytes:	2
Cycles:	
Description:	Clear watchdog. This opcode is used to clear the watchdog at the end of a program run. Apply this opcode right before ,stop'.
Category:	Miscellaneous
compare	Compare two values
Syntax:	compare p1,p2
Parameters:	p1 = ACCU [x,y,z,r] p2 = ACCU [x,y,z,r]  or 24-Bit number
Calculus:	:=p2-p1 only the flags are changed but not the registers
Flags affected:	COSZ
Bytes:	1 (p1=ACCU, p2=ACCU) 4 (p1=ACCU, p2=NUMBER)
Cycles:	1 (p1=ACCU, p2=ACCU) 4 (p1=ACCU, p2=NUMBER)
Description:	Compare of 2 registers by subtraction Compare of a constant with a register by subtraction The flags are changed according to the subtraction result, but not the registers contents themselves
Category:	Simple arithmetic
compl	Complement
Syntax:	compl p1
Parameters:	p1 = ACCU [x,y,z,r]
Calculus:	p1 := -p1 = not p1 + 1
Flags affected:	SZ
Bytes:	2
Cycles:	2
Description:	two's complement of register
Category:	Simple arithmetic
decr	Decrement
Syntax:	decr p1
Parameters:	p1 = ACCU [x,y,z,r]
Calculus:	p1 := p1 - 1
Flags affected:	COSZ
Bytes:	1
Cycles:	1
Description:	Decrement register
Category:	Simple arithmetic



decramadr	Decrement RAM address pointer
Syntax:	decramadr
Parameters:	•
Calculus:	-
Flags affected:	-
Bytes:	1
Cycles:	1
Description:	Decrement RAM address pointer by one
Category:	Ram Access
dez2lcd	Decimal to segment code
Syntax:	dez2lcd p1
Parameters:	p1 = ACCU [x,y,z,r]
Calculus:	-
Flags affected:	-
Bytes:	2
Cycles:	3
Description:	Converts decimal code in register p1 to 7 segment code. A decimal number from 0 to 9 of the addressed register p1 is converted to standard 7 segment code (digits a-h). This opcode may be used for advanced LCD conversions routines, where op- code no2lcd is not sufficient dec hgfe dcba 0> 0b00111111=0x3F 1> 0b00000110=0x06 2> 0b0011011=0x3B 3> 0b01001111=0x4F 4> 0b01100110=0x66 5> 0b01101101=0x6D 6> 0b01111101=0x7D 7> 0b00000111=0x07 8> 0b0111111=0x7F 9> 0b01101111=0x6F LCD Display
div24	Signed division 24 Bit
Syntax:	div24 p1,p2
Parameters:	p1 = ACCU [x,y,z,r] $p2 = ACCU [x,y,z,r]$
Calculus:	p1 := ( p1 << 24 ) / p2 (if  p1  <  p2/2  )
Flags affected:	S & Z of p1
Bytes:	2
Cycles:	20
Description:	Signed division of 2 registers 24 bits of the division of 2 registers, result is assigned to p1
Category:	Complex arithmetic

divmod	Signed modulo division
Syntax:	divmod p1,p2
Parameters:	p1 = ACCU [x,y,z,r] p2 = ACCU [x,y,z,r]
Calculus:	p1 := p1 / p2 and p2 := p1 % p2
Flags affected:	SZ
Bytes:	2
Cycles:	
Description:	Signed modulo division of 2 registers 24 higher bits of the division of 2 registers, result is assigned to p1 the rest is placed to p2
Category:	Complex arithmetic

eor	Exclusive OR
Syntax:	eor p1,p2
Parameters:	p1 = ACCU [x,y,z,r] p2 = ACCU [x,y,z,r] or 24-Bit number
Calculus:	p1 := p1 xor p2 bit combination $0 / 0$ and $1 / 1$ returns 0 bit combination $0 / 1$ and $1 / 0$ returns 1
Flags affected:	SZ
Bytes:	2 (p1=ACCU, p2=ACCU) 5 (p1=ACCU, p2=NUMBER)
Cycles:	3 (p1=ACCU, p2=ACCU) 6 (p1=ACCU, p2=NUMBER)
Description:	Logic XOR (exclusive OR, antivalence) of the 2 given registers Logic XOR (exclusive OR, antivalence) of register with constant
Category:	Logic
eorn	Exclusive NOR
Syntax:	eorn p1,p2
Parameters:	p1 = ACCU [x,y,z,r] p2 = ACCU [x,y,z,r] or 24-Bit number
Calculus:	p1 := p1 xnor p2 bit combination 0 / 0 and 1 / 1 return 1 bit combination 0 / 1 and 1 / 0 return 0
Flags affected:	SZ
Bytes:	2 (p1=ACCU, p2=ACCU) 5 (p1=ACCU, p2=NUMBER)
Cycles:	3 (p1=ACCU, p2=ACCU) 6 (p1=ACCU, p2=NUMBER)
Description:	Logic XNOR (exclusive NOR, equivalence) of the 2 given registers
	Logic XNOR (exclusive NOR, equivalence) of register with constant



equal	Write 3 Bytes to EEPROM
Syntax:	equal p1
Parameters:	p1 = 24-Bit number
Calculus:	-
Flags affected:	-
Bytes:	3
Cycles:	
Description:	Write 3 bytes (p1) to configuration register of EEPROM. The equal opcode is used to write 3 bytes of configuration data directly to an EEPROM register. Therefore the opcode is simply used 16 times in the beginning of the assembler listing, fed with the configuration data given through p1. Like ,putepr' the configuration of the EEPROM is done in the lower area from byte 047, combined in 16x 24bit registers. From byte 48 upwards, the user code is written to the EEPROM. Use this opcode to provide your own configuration instead of the standard configuration.
Category:	EEPROM access

getepr	Get EEPROM content
Syntax:	getepr p1
Parameters:	p1 = ACCU [x,y,z,r]
Calculus:	p1 := EEPROM register content (addressed by RAM address pointer)
Flags affected:	SZ
Bytes:	1
Cycles:	6
Description:	Get EEPROM into register. The addressed register p1 gets the EEPROM register content which is addressed by the RAM address pointer. This opcode needs temporarily a place in the program counter stack (explanation see below).
Category:	EEPROM Access
getflag	Set S and Z flags
Syntax:	getflag p1
Parameters:	p1 = ACCU [x,y,z,r]
Calculus:	signum := set if p1 < 0 notequalzero := set if p1 <> 0
Flags affected:	SZ
Bytes:	1
Cycles:	1
Description:	Set the signum and notequalzero flag according to the addressed register, content of the register is not affected
Category:	Simple arithmetic

goto	Jump without condition
Syntax:	goto p1
Parameters:	p1 = JUMPLABEL
Calculus:	PC:= p1
Flags affected:	-
Bytes:	2 (relative jump) 3 (absolute jump)
Cycles:	3 (relative jump) 4 (absolute jump)
Description:	Jump without condition. Program counter is set to target address. The target ad- dress is given by using a jump label. See examples section for how to introduce a jump label.
Category:	Unconditional jump

gotoBitC	Jump on bit clear
Syntax:	gotoBitC p1, p2, p3
Parameters:	p1 = ACCU [x,y,z,r] p2 = NUMBER [023] p3 = JUMPLABEL
Calculus:	if (bit p2 of register p1 == 0) PC := p3
Flags affected:	-
Bytes:	3
Cycles:	4
Description:	Jump on bit clear. Program counter will be set to target address if selected bit in register p1 is clear. The target address is given by using a jump label. See examples section for how to introduce a jump label.
Category:	Bitwise
gotoBitS	Jump on bit set
Syntax: Parameters:	gotoBitS p1, p2, p3 p1 = ACCU [x,y,z,r] p2 = NUMBER [023] p3 = JUMPLABEL
Calculus:	if (bit p2 of register p1 == 1) PC := p3
Flags affected:	-
Bytes:	3
Cycles:	4
Description:	Jump on bit set. Program counter will be set to target address if selected bit in
	register p1 is set. The target address is given by using a jump label. See examples section for how to introduce a jump label.



gotoCarC	Jump on carry clear
Syntax:	gotoCarC p1
Parameters:	p1 = JUMPLABEL
Calculus:	if (carry == 0) $PC := p1$
Flags affected:	-
Bytes:	2 (relative jump) 3 (absolute jump)
Cycles:	3 (relative jump) 4 (absolute jump)
Description:	Jump on carry clear. Program counter will be set to target address if carry is clear. The target address is given by using a jump label. See examples section for how to introduce a jump label.
Category:	Goto on flag

gotoCarS	Jump on carry set
Syntax:	gotoCarS p1
Parameters:	p1 = JUMPLABEL
Calculus:	if (carry == 1) PC := p1
Flags affected:	-
Bytes:	2 (relative jump) 3 (absolute jump)
Cycles:	3 (relative jump) 4 (absolute jump)
Description:	Jump on carry set. Program counter will be set to target address if carry is set. The target address is given by using a jump label. See examples section for how to introduce a jump label.
Category:	Goto on flag

gotoEQ	Jump on equal zero
Syntax:	gotoEQ p1
Parameters:	p1 = JUMPLABEL
Calculus:	if $(Z == 0)$ PC := p1
Flags affected:	-
Bytes:	2 (relative jump) 3 (absolute jump)
Cycles:	3 (relative jump) 4 (absolute jump)
Description:	Jump on equal zero. Program counter will be set to target address if the forego- ing result is equal to zero. The target address is given by using a jump label. See examples section for how to introduce a jump label.
Category:	Goto on flag

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gotoNE	Jump on not equal zero
Syntax:	gotoNE p1
Parameters:	p1 = JUMPLABEL
Calculus:	if $(Z == 1)$ PC := p1
Flags affected:	-
Bytes:	2 (relative jump) 3 (absolute jump)
Cycles:	3 (relative jump) 4 (absolute jump)
Description:	Jump on not equal zero. Program counter will be set to target address if the forego- ing result is not equal to zero. The target address is given by using a jump label. See examples section for how to introduce a jump label.
Category:	Goto on flag

gotoNeg	Jump on negative
Syntax:	gotoNeg p1
Parameters:	p1 = JUMPLABEL
Calculus:	if (S == 1) PC := p1
Flags affected:	-
Bytes:	2 (relative jump) 3 (absolute jump)
Cycles:	3 (relative jump) 4 (absolute jump)
Description:	Jump on negative. Program counter will be set to target address if the foregoing result is negative. The target address is given by using a jump label. See examples section for how to introduce a jump label.
Category:	Goto on flag
gotoOvrC	Jump on overflow clear
Syntax:	gotoOvrC p1
Parameters:	p1 = JUMPLABEL
Calculus:	if (0 == 0) PC := p1
Flags affected:	-
Bytes:	2 (relative jump) 3 (absolute jump)
Cycles:	3 (relative jump) 4 (absolute jump)
Description:	Jump on overflow clear. Program counter will be set to target address if the over- flow flag of the foregoing operation is clear. The target address is given by using a jump label. See examples section for how to introduce a jump label.
Category:	Goto on flag

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gotoOvrS	Jump on overflow set
Syntax:	gotoOvrS p1
Parameters:	p1 = JUMPLABEL
Calculus:	if (O == 1) PC := p1
Flags affected:	-
Bytes:	2 (relative jump) 3 (absolute jump)
Cycles:	3 (relative jump) 4 (absolute jump)
Description:	Jump on overflow set. Program counter will be set to target address if the overflow flag of the foregoing operation is set. The target address is given by using a jump label. See examples section for how to introduce a jump label.
Category:	Goto on flag

gotoPos	Jump on positive
Syntax:	gotoPos p1
Parameters:	p1 = JUMPLABEL
Calculus:	if $(S == 0)$ PC := p1
Flags affected:	-
Bytes:	2 (relative jump) 3 (absolute jump)
Cycles:	3 (relative jump) 4 (absolute jump)
Description:	Jump on positive. Program counter will be set to target address if the foregoing result is positive. The target address is given by using a jump label. See examples section for how to introduce a jump label.
Category:	Goto on flag

gr2st	Gram to Stone Conversion
Syntax:	gr2st p1
Parameters:	p1 = ACCU [x]
Calculus:	p1 = stone (p1)
Flags affected:	-
Bytes:	3
Cycles:	185
Description:	Converts weight in multiples of 100mg to stone. The result is given with 2 positions in stone, the rest in pounds. The value can be directly used with no2lcd.
Category:	Miscellaneous

hysteresis	Hysteresis
Syntax:	hysteresis p1,p2,p3
Parameters:	p1 = ACCU [x] p2 = NUMBER [half scale division] p2 = NUMBER [half scale division + half hysteresis]
Calculus:	p1 = hysteresis (p1)
Flags affected:	-
Bytes:	10
Cycles:	subroutine call
Description:	This opcode provides a hysteresis function. By parameter p3 you can define a value range which is considered as "tolerance" for the variation of the actual measurement value. In other words, although another division normally would be displayed already, the current division is kept. This opcode contains also the round opcode. The round function is set by parameter p2. See also the explanation further down on this page.
Category:	Miscellaneous
incr	Increment
Syntax:	incr p1
Parameters:	p1 = ACCU [x,y,z,r]
Calculus:	p1 := p1 + 1
Flags affected:	COSZ
Bytes:	1
Cycles:	1
Description:	Increment register
Category:	Simple arithmetic
incramadr	Increment RAM address
Syntax:	incramadr
Parameters:	-
Calculus:	•
Flags affected:	•
Bytes:	1
Cycles:	1
Description:	Increment RAM address pointer by 1
Category:	RAM access
nitAvg	Initialize rolling average
Syntax:	initAvg p1,p2
Parameters:	p1 = ACCU[x] p2 = number from 3 to 17
Calculus:	-
lags affected:	-
Bytes:	2
Cycles:	Subroutine call
Description:	Initialization of the rolling average subroutine. p1 sets the default value for the calcu- lus. p2 defines the number of data points for the rolling average. In real a subroutine in the ROM code is called. The assembler converts this com-
	mand to the corresponding jump command.



initTDC	Initialize TDC
Syntax:	initTDC
Parameters:	-
Calculus:	-
Flags affected:	-
Bytes:	2
Cycles:	3
Description:	Initialization reset of the TDC (time-to-digital converter). Should be sent after configu- ration of registers. The initTDC preserves all configurations .
Category:	Miscellaneous
invert	Bitwise inversion
Syntax:	invert p1
Parameters:	p1 = ACCU [x,y,z,r]
Calculus:	p1 := not p1
Flags affected:	SZ
Bytes:	2
Cycles:	2
Description:	Bitwise inversion of register
Category:	Logic
jsub	Unconditional jump
Syntax:	jsub p1
Parameters:	p1 = JUMPLABEL
Calculus:	PC := p1
Flags affected:	COSZ
Bytes:	3
Cycles:	4
Description:	Jump to subroutine without condition. The program counter is loaded by the address given through the jump label. The subroutine is processed until the keyword ,jsubret' occurs. Then a jump back is performed and the next command after the jsub-call is executed. This opcode needs temporarily a place in the program counter stack (explanation see below).
Category:	Unconditional Jump
jsubret	Return from subroutine
Syntax:	jsubret
Parameters:	-
Calculus:	PC := PC from jsub-call
Flags affected:	-
Bytes:	1
Cycles:	3
Description:	Return from subroutine. A subroutine can be called via ,jsub' and exited by using jsubret. The program is continued at the next command following the jsub-call. You have to close a subroutine with jsubret - otherwise there will be no jump back.
Category:	Unconditional Jump

median	Median Filter
Syntax:	median p1,p2
Parameters:	p1 = ACCU [x] p2 = NUMBER [3 to 15, uneven]
Calculus:	p1 = median [p1+r(32)+r(33)++r(32+p2-2)]
Flags affected:	S Z (of result p1)
Bytes:	7
Cycles:	subroutine call
Description:	Applies median filter with configured depth. The number to be added is given by the Accu X. The number defines the depth of the filter, only uneven numbers are valid. To use this opcode the corresponding RAM-cells need to be initialized, this can be done by initAvg
Category:	Miscellaneous
move	Move
Syntax:	move p1,p2
Parameters:	p1 = ACCU [x,y,z,r] p2 = ACCU [x,y,z,r]  or  24-bit number
Calculus:	p1 := p2
Flags affected:	SZ
Bytes:	1 (p1=ACCU, p2=ACCU) 4 (p1=ACCU, p2=NUMBER)
Cycles:	1 (p1=ACCU, p2=ACCU) 4 (p1=ACCU, p2=NUMBER)
Description:	Move content of p2 to p1 (p1=ACCU, p2=ACCU) Move constant to p1 (p1=ACCU, p2=NUMBER)
Category:	RAM access
mult24	Signed 24-Bit multiplication
Syntax:	mult24 p1,p2
Parameters:	p1 = ACCU [x,y,z,r] $p2 = ACCU [x,y,z,r]$
Calculus:	p1 := (p1 * p2) >> 24
Flags affected:	S & Z of p1
Bytes:	2
Cycles:	30
Description:	Signed multiplication of 2 registers like mult48, but only the 24 higher bits of the multiplication of 2 registers, result is stored in p1
Category:	Complex arithmetic
mult48	Signed 48-Bit multiplication
Syntax:	mult48 p1,p2
Parameters:	p1 = ACCU [x,y,z,r] $p2 = ACCU [x,y,z,r]$
Calculus:	p1,p2 := p1 * p2
Flags affected:	S & Z of p1
Bytes:	2
Cycles:	30
Description:	Signed multiplication of 2 registers Higher 24 bits of the multiplication is placed to p1 Lower 24 bits of the multiplication is placed to p2
Category:	Complex arithmetic



Logic NAND
nand p1,p2
p1 = ACCU [x,y,z,r] p1 = ACCU [x,y,z,r]  or  24-Bit number
p1 := p1 nand p2 returns only 0 in case of bit combination 1 / 1
SZ
2 (p1=ACCU, p2=ACCU) 5 (p1=ACCU, p2=NUMBER)
3 (p1=ACCU, p2=ACCU) 6 (p1=ACCU, p2=NUMBER)
Logic NAND (negated AND) of the 2 given registers Logic NAND (negated AND) of register with constant
Logic
Start TDC
newcyc
-
2
3
Start of TDC. This opcode can be used after configuration and initialization of the
PSØ81 to start a new measurement cycle. Normally this is done by the PSØ81 ROM routines itself, but in case of custom-designed reset procedures this opcode can play a role.
Miscellaneous
Load new LCD data
newlcd
-
-
-
2
3
Load new LCD data. New segment data from register 61-63 is written to the LCD driver. Refreshes the display.
driver. Refreshes the display.
driver. Refreshes the display. LCD display
driver. Refreshes the display. LCD display Covert 6 digits to LCD code
driver. Refreshes the display.         LCD display         Covert 6 digits to LCD code         no2lcd p1,p2         p1 = ACCU[x]
driver. Refreshes the display.         LCD display         Covert 6 digits to LCD code         no2lcd p1,p2         p1 = ACCU[x]
driver. Refreshes the display.         LCD display         Covert 6 digits to LCD code         no2lcd p1,p2         p1 = ACCU[x]
driver. Refreshes the display.         LCD display         Covert 6 digits to LCD code         no2lcd p1,p2         p1 = ACCU[x]         p2 = number 1 to 6         -

no2lcdAccu	Covert 6 digits to LCD code
Syntax:	no2lcd p1,p2
Parameters:	p1 = ACCU[x] p1 = ACCU[Y]
Calculus:	-
Flags affected:	-
Bytes:	3
Cycles:	subroutine call
Description:	Converts the 6 digits of the decimal number in register x into 7-segment code. The position of the decimal point is determined with p2. Leading zeros before the decimal point are cleared. The conversion result is directly written to the LCD register 61-62 Use this opcode in combination with ,newlcd'.
Category:	LCD display

nop	No operation
Syntax:	-
Parameters:	-
Calculus:	-
Flags affected:	-
Bytes:	1
Cycles:	1
Description:	Placeholder code or timing adjust (no function)
Category:	Miscellaneous
nor	Logic NOR
Syntax:	nor p1,p2
Parameters:	p1 = ACCU [x,y,z,r] p2 = ACCU [x,y,z,r]  or  24-Bit number
Calculus:	p1 := p1 nor p2 returns only 1 in case of bit combination 0 / 0
Flags affected:	SZ
Bytes:	2 (p1=ACCU, p2=ACCU) 5 (p1=ACCU, p2=NUMBER)
Cycles:	3 (p1=ACCU, p2=ACCU) 6 (p1=ACCU, p2=NUMBER)
Description:	Logic NOR (negated OR) of the 2 given registers Logic NOR (negated OR) of register with constant
Category:	Logic



or	Logic OR
Syntax:	or p1,p2
Parameters:	p1 = ACCU [x,y,z,r] p2 = ACCU [x,y,z,r]  or  24-Bit  number
Calculus:	p1 := p1 or p2 returns only 0 in case of bit combination 0 / 0
Flags affected:	SZ
Bytes:	2 (p1=ACCU, p2=ACCU) 5 (p1=ACCU, p2=NUMBER)
Cycles:	3 (p1=ACCU, p2=ACCU) 6 (p1=ACCU, p2=NUMBER)
Description:	Logic OR of the 2 given registers Logic OR of register with constant
Category:	Logic

putepr	Put register to EEPROM
Syntax:	putepr p1
Parameters:	p1 = ACCU [x,y,z,r]
Calculus:	EEPROM register (addressed by RAM address pointer) := p1
Flags affected:	-
Bytes:	4
Cycles:	65536 = ~50ms
Description:	Put register into EEPROM. The content of the addressed register p1 is moved to the EEPROM (the EEPROM register address is set by the RAM address pointer). EEPROM bytes 2000 to 2047 are accessible via ,putepr', setting the RAM address pointer to addresses 0 to 15. This opcode needs temporarily a place in the program counter stack (explanation see below). ,putepr' should not be combined with the skip-opcodes due to the long execution time of this opcode (approx.: 50ms)
Category:	EEPROM access
ramadr	Set RAM address pointer
Syntax:	ramadr p1
Parameters:	p1 = 5-Bit number
Calculus:	-
Flags affected:	-
Bytes:	1
Cycles:	1
Description:	Set pointer to RAM address (range: 065)
Category:	RAM access

rollAvg	Calculate rolling average
Syntax:	rollAvg p1,p2
Parameters:	p1 = ACCUIx1 p2 = number from 3 to 17
Calculus:	ACCU[y] = ACCU[x] old p1 = rolling average result
Flags affected:	-
Bytes:	2
Cycles:	Subroutine call
Description:	Feeds p1 as new value into the rolling average subroutine. p2 defines the number of data points for the rolling average. The value falling out of the rolling average is stored on RAM address 13. The result is stored in the x ACCU. The previous result is stored in the y ACCU. In real a subroutine in the ROM code is called. The assembler converts this com- mand to the corresponding jump command.
Category:	Miscellaneous

rotL	Rotate left
Syntax:	rotL p1(,p2)
Parameters:	p1 = ACCU [x,y,z,r] p2 = 4-Bit number or none
Calculus:	<pre>p1 := p1&lt;&lt; 1+ carry; carry:=MSB(x) (in case rotL p1, without p2) p1 := repeat (p2) rotL p1 (in case rotL p1,p2)</pre>
Flags affected:	C O S Z (of the last step)
Bytes:	1 (p1=ACCU, p2=none) 2 (p1=ACCU, p2=NUMBER)
Cycles:	1 (p1=ACCU, p2=none) 1+p2 (p1=ACCU, p2=NUMBER)
Description:	Rotate p1 left> shift p1 register to the left, fill LSB with carry, MSB is placed in carry register
	Rotate p1 left p2 times with carry> shift p1 register p2 times to the left, in each step fill LSB with the carry and place the MSB in the carry
Category:	Shift and rotate



rotR	Rotate right
Syntax:	rotR p1(,p2)
Parameters:	p1 = ACCU [x,y,z,r] p2 = 4-Bit number or none
Calculus:	p1 := p1>> 1+ carry; carry: =MSB(x) (in case rotR p1, without p2) p1 := repeat (p2) rotR p1 (in case rotR p1,p2)
Flags affected:	C O S Z (of the last step)
Bytes:	1 (p1=ACCU, p2=none) 2 (p1=ACCU, p2=NUMBER)
Cycles:	1 (p1=ACCU, p2=none) 1+p2 (p1=ACCU, p2=NUMBER)
Description:	Rotate p1 right> shift p1 register to the right, fill MSB with carry, LSB is placed in carry register Rotate p1 right p2 times with carry> shift p1 register p2 times to the right, in
	each step fill MSB with the carry and place the LSB in the carry
Category:	Shift and rotate

round	Rounding
Syntax:	round p1,p2
Parameters:	p1 = ACCU [x] p2 = NUMBER [half scale division]
Calculus:	p1 = round (p1, p2)
Flags affected:	
Bytes:	7
Cycles:	subroutine call
Description:	Rounds the number in x. Depending on the configured ,half scale division' the number stored in x will be rounded down or up (down <5, up $>= 5$ ).
Category:	Miscellaneous

setC	Set carry flag
Syntax:	setC
Parameters:	-
Calculus:	-
Flags affected:	CO
Bytes:	1
Cycles:	1
Description:	Set carry flag and clear overflow flag
Category:	Shift and Rotate

shiftL	Shift Left
Syntax:	shiftL p1,(p2)
Parameters:	p1 = ACCU [x,y,z,r]
	p2 = 4-Bit number or none
Calculus:	p1 := p1 << 1; carry :=MSB(x) (in case rotL p1, without p2)
	p1 := repeat (p2) shiftL p1 (in case rotL p1,p2)
lags affected:	COSZ
Bytes:	1 (p1=ACCU, p2=none) 2 (p1=ACCU, p2=NUMBER)
Cycles:	1 (p1=ACCU, p2=none) 1 + p2 (p1=ACCU, p2=NUMBER)
Description:	Shift p1 left> shift p1 register to the left, fill LSB with 0, MSB is placed in carry register Shift p1 left p2 times> shift p1 register p2 times to the left, in each step fill LSB with the 0 and place the MSB in the carry
Category:	Shift and rotate
setLCD	Set LCD
Syntax:	setLCD
Parameters:	-
Calculus:	-
lags affected:	-
Bytes:	1
Cycles:	Subroutine call
Description:	Sets all LCD register 61 & 62 bits to 1. Use this opcode in combination with ,newlcd' for showing all LCD segments. In real a subroutine in the ROM code is called. The assembler converts this com- mand to the corresponding jump command.
Category:	LCD Display
shiftR	Shift right
Syntax:	shiftR p1,(p2)
Parameters:	p1 = ACCU [x,y,z,r] p2 = 4-Bit number or none
Calculus:	p1 := p1>> 1; carry:=MSB(x) (in case rotL p1, without p2) p1 := repeat (p2) shiftL p1 (in case rotL p1,p2)
Flags affected:	COSZ
Bytes:	1 (p1=ACCU, p2=none) 2 (p1=ACCU, p2=NUMBER)
Cycles:	1 (p1=ACCU, p2=none) 1 + p2 (p1=ACCU, p2=NUMBER)
Description:	Signed shift right of p1> shift p1 right, MSB is duplicated according to whether the number is positive or negative Signed shift p1 right p2 times> shift p1 register p2 times to the right, MSB is duplicated according to whether the number is positive or negative
Category:	Shift and rotate



sign	Sign
Syntax:	sign p1
Parameters:	p1 = ACCU [x,y,z,r]
Calculus:	p1 := p1 /  p1  p1 := 1 = 0x000001 if $p1 >= 0p1 := -1 = 0xFFFFFF$ if $p1 < 0$
Flags affected:	SZ
Bytes:	2
Cycles:	2
Description:	Sign of addressed register in complement of two notation. A positive value returns 1, a negative value returns -1 Zero is assumed to be positive
Category:	Simple arithmetic
skip	Skip
Syntax:	skip p1
Parameters:	p1 = NUMBER [1,2,3]
Calculus:	PC := PC + bytes of next p1 lines
Flags affected:	
Bytes:	1
Cycles:	1 + skipped commands
Description:	Skip p1 without conditions
Category:	Unconditional jump
Category.	
skipBitC	Conditional skip
Syntax:	skipBitC p1,p2,p3
Parameters:	p1 = ACCU [x,y,z,r] p2 = NUMBER[023] p2 = NUMBER[1,2,3]
Calculus:	if (bit p2 of register p1 == 0) PC := PC + bytes of next p3 lines
Flags affected:	-
Bytes:	1
Cycles:	1 + skipped commands
Description:	Skip p3 commands if bit p2 of register p1 is clear
Category:	Bitwise
skipBitS	Conditional skip
Syntax:	skipBitS p1,p2,p3
Parameters:	p1 = ACCU [x,y,z,r] $p2 = NUMBER[023]$ $p2 = NUMBER[1,2,3]$
Calculus:	if (bit p2 of register p1 == 1) PC := PC + bytes of next p3 lines
Flags affected:	-
Bytes:	1
Cycles:	1 + skipped commands
Description:	Skip p3 commands if bit p2 of register p1 is set

skipCarC	Skip carry clear
Syntax:	skipCarC p1
Parameters:	p1 = NUMBER [1,2,3]
Calculus:	if (carry == 0) PC := PC + bytes of next p1 lines
Flags affected:	-
Bytes:	1
Cycles:	1 + skipped commands
Description:	Skip p1 commands if carry clear
Category:	Skip on flag
skipCarS	Skip carry set
Syntax:	skipCarS p1
Parameters:	p1 = NUMBER [1,2,3]
Calculus:	if (carry == 1) PC := PC + bytes of next p1 lines
Flags affected:	-
Bytes:	1
Cycles:	1 + skipped commands
Description:	Skip p1 commands if carry set
Category:	Skip on flag
skipEQ	Skip on zero
Syntax:	skipEQ p1
Parameters:	p1 = NUMBER[1,2,3]
Calculus:	if (notequalzero == 0) PC := PC + bytes of next p1 lines
Flags affected:	-
Bytes:	1
Cycles:	1 + skipped commands
Description:	Skip p1 commands if result of previous operation is equal to zero
Category:	Skip on flag
skipNE	Skip on non-zero
Syntax:	skipNE p1
Parameters:	p1 = NUMBER[1,2,3]
Calquius:	if (notogualzana 1)

if (notequalzero == 1)
PC := PC + bytes of next p1 lines
-
1
1 + skipped commands
Skip p1 commands if result of previous operation is not equal to zero
Skip on flag

# mess · electronic

skipNeg	Skip on negative
Syntax:	skipNeg p1
Parameters:	p1 = NUMBER[1,2,3]
Calculus:	if (signum == 1) PC := PC + bytes of next p1 lines
Flags affected:	-
Bytes:	1
Cycles:	1 + skipped commands
Description:	Skip p1 commands if result of previous operation was smaller than O
Category:	Skip on flag

skipOvrC	Skip on overflow
Syntax:	skipOvrC p1
Parameters:	p1 = NUMBER[1,2,3]
Calculus:	if (overflow == 0) PC := PC + bytes of next p1 lines
Flags affected:	-
Bytes:	1
Cycles:	1 + skipped commands
Description:	Skip p1 commands if overflow is clear
Category:	Skip on flag

skipOvrS	Skip on overflow
Syntax:	skipOvrS p1
Parameters:	p1 = NUMBER[1,2,3]
Calculus:	if (overflow == 1) PC := PC + bytes of next p1 lines
Flags affected:	-
Bytes:	1
Cycles:	1 + skipped commands
Description:	Skip p1 commands if overflow is set
Category:	Skip on flag

skipPos	Skip on positive
Syntax:	skipPos p1
Parameters:	p1 = NUMBER[1,2,3]
Calculus:	if (signum == 0) PC := PC + bytes of next p1 lines
Flags affected:	-
Bytes:	1
Cycles:	1 + skipped commands
Description:	Skip p1 commands if result of previous operation was greater or equal to O
Category:	Skip on flag

Cuptov:	Send LCD display value to SPI
Syntax:	spi2lcd p1,p2 p1 = ACCU [v]
Parameters:	$p^{2} = ACCU [y]$ $p^{2} = NUMBER [number of bits to transmit]$
Calculus:	-
Flags affected:	-
Bytes:	7
Cycles:	subroutine call
Description:	This opcode sends the content of accu y to the SPI interface for external LCD con- troller. The second parameter defines, how many bits are transmitted. This function is mainly needed when operating an external LCD driver via SPI. <u>Please note:</u> This opcode requires a special configuration of PSØ81 and also needs succeeding opcodes to work properly. Please see chapter 4.3 "Support of an external LCD driver" for mor deteils.
Category:	LCD display
ssnPulse	Send Pulse on SSN for external LCD controller
Syntax:	ssnPulse
Parameters:	-
Calculus:	SSN -> 0 -> 1 -> 1
Flags affected:	-
Bytes:	3
Cycles:	
Description:	Generates positive pulse on SSN (pins LCD_SEG38), ends in logic O
Category:	Miscellaneous
Category.	
ssnSet	Set SSN to HIGH for external LCD controller
Suptor	
JyiildX.	ssnSet
,	ssnSet -
Parameters:	ssnSet           -           SSN -> 1
Parameters: Calculus:	-
Parameters: Calculus: Flags affected:	-
Parameters: Calculus: Flags affected: Bytes: Cycles:	- SSN -> 1 - 3
Parameters: Calculus: Flags affected: Bytes: Cycles:	- SSN -> 1 -
Parameters: Calculus: Flags affected: Bytes: Cycles: Description:	- SSN -> 1 - 3
Parameters: Calculus: Flags affected: Bytes: Cycles: Description: Category:	
Parameters: Calculus: Flags affected: Bytes: Cycles: Description: Category: stop	
Parameters: Calculus: Flags affected: Bytes: Cycles: Description: Category: Stop Syntax:	
Parameters: Calculus: Flags affected: Bytes: Cycles: Description: Category: stop Syntax: Parameters:	-         SSN -> 1           -         3           Sets pin SSN (pins LCD_SEG38) to HIGH           Miscellaneous           Stop           stop
Parameters: Calculus: Flags affected: Bytes: Cycles: Description: Category: Stop Syntax: Parameters: Calculus:	-         SSN -> 1         -         3         Sets pin SSN (pins LCD_SEG38) to HIGH         Miscellaneous         Stop         -         -
Parameters: Calculus: Flags affected: Bytes: Cycles: Description: Category: <b>stop</b> Syntax: Parameters: Calculus: Flags affected:	-         SSN -> 1         -         3         Sets pin SSN (pins LCD_SEG38) to HIGH         Miscellaneous         Stop         -         -         -         -         -
Parameters: Calculus: Flags affected: Bytes: Cycles: Description: Category: <b>stop</b> Syntax: Parameters: Calculus: Flags affected: Bytes:	-         SSN -> 1         -         3         Sets pin SSN (pins LCD_SEG38) to HIGH         Miscellaneous         Stop         -         -         -         -         -         -         -         -         -         -         -         -         -
Syntax: Parameters: Calculus: Flags affected: Bytes: Cycles: Description: Category: stop Syntax: Parameters: Calculus: Flags affected: Bytes: Cycles: Description:	-         SSN -> 1         -         3         Sets pin SSN (pins LCD_SEG38) to HIGH         Miscellaneous         Stop         -         -         -         1



sub	Substraction
Syntax:	sub p1,p2
Parameters:	p1 = NUMBER[1,2,3] p2 = NUMBER[1,2,3] or 24-Bit number
Calculus:	p1:= p2 - p1
Flags affected:	COSZ
Bytes:	1 (p1=ACCU, p2=ACCU) 4 (p1=ACCU, p2=NUMBER)
Cycles:	1 (p1=ACCU, p2=ACCU) 4 (p1=ACCU, p2=NUMBER)
Description:	Subtraction of 2 registers Subtraction of register from constant
Category:	Simple arithmetic
swap	Swap
Syntax:	swap p1,p2
Parameters:	p1 = ACCU [x,y,r] p2 = ACCU [x,y,r]
Calculus:	p1 := p2 and p2 := p1
Flags affected:	-
Bytes:	1
Cycles:	3
Description:	Swap of 2 registers The value of two registers is exchanged between each other. Not possible with ACCU[z]
Category:	RAM Access
useEprInit	Initialize User - EEPROM
Syntax:	usrEprInit p1, p2
Parameters:	p1 = EEPROM CELL [0 to 15] p2 = NUMBER [24-bit]
Calculus:	EEPROM $(p1) = p2$
Flags affected:	-
Bytes:	1
Cycles:	3
Description:	This opcode initializes the User programmable EEPROM space from address 2000 to 2047. In total there are 16 EEPROM cells á 24-bit programmable. <u>Please note:</u> This opcode is only for INITIALIZATION. For writing / reading from the user EEPROM cells from the program you have to use putepr / getepr opcodes
Category:	EEPROM access

6.5 System Reset, Sleep Mode and Auto-configuration

ALU activity is requested by a reset (power-on, watchdog), the end of measurement or in sleep mode the end of the conversion counter. A reset has priority over the last two items. First the ALU jumps into the ROM code starting with address 2048. There a first check is done whether the ALU was activated after a reset or not.

In case of a reset the flag epr\_pwr\_cfg is checked to decide whether the auto-configuration data from the EEPROM have to be copied into the RAM or not.

In the following flag epr\_pwr\_prg is checked to decide whether EEPROM code (starting at address 48) shall be executed. In stand alone operation this is reasonable and epr\_pwr\_cfg bit should be 1. In front end operation this is unlikely and with epr\_pwr\_cfg = 0 the  $\mu$ P is stopped.

In case the ALU is started not by a reset the TDC unit starts a measurement or, in sleep mode, the conversion counter is started without a measurement. Afterwards the flag epr\_usr\_prg is checked to decide about a jump into the EEPROM (address 48). Again, in stand-alone operation epr\_usr\_prg =1 is reasonable, in front-end operation epr\_usr\_prg = 0 will be more likely.

In the EEPROM code first the flag flg\_rstpwr should be checked to see whether the reason for the jump was a reset. If yes, a detailed check is recommended to see whether the reset comes from a power-on reset, a pushed button, the watchdog interrupt.

Otherwise a check of flag flg\_intavO will indicate if the chip is still in sleep mode or if an active strain measurement is running.

At the end the ALU is stopped. This implements a complete reset of the ALU including the start flags. Also the program stack is reset. Only the RAM data remain unchanged.

#### 6.5.1 Power On Reset

When applying the supply voltage to the chip a power-on reset is generated. The whole chip is reset, only the RAM remains unchanged.

In case  $epr_pwr_prg = 1$  the user code at EEPROM address 48 is started.

#### 6.5.2 Watchdog Reset

A power-on reset can also be triggered by the watchdog timer. This happens in case the microprocessor is started four times without being reset by the opcode "clrwdt". Status bit flg\_wdtalt in register 22, bit 17, indicates a timeout of the watchdog timer.

In case  $epr_pwr_prg = 1$  the user code at EEPROM address 48 is started.

#### 6.5.3 External Reset on Pin 27

In stand-alone mode (SPI\_ENA = 0) it is possible to apply an external power-on at pin 27 (SPI\_CSN\_ RST). This can be used for a reset button. The status of the button can be requested from status bit



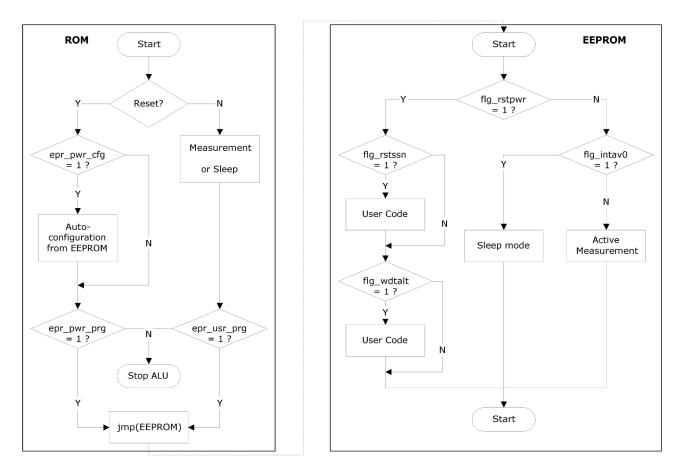


Figure 6.3 Flow chart

flg\_rstssn in register 22, bit 18.

In case  $epr_pwr_prg = 1$  the user code at EEPROM address 48 is started.

#### 6.5.4 Sleep Mode

In sleep mode only the 10 kHz oscillator is running. At regular intervals the microprocessor is waked up but without doing a measurement. In this phase it can check the I/O's. A start-up of the microprocessor from sleep mode is indicated by status bit flg\_intavO in register 22, bit 22.

Configuration:

1: tdc\_sleepmode

Register 1, Bit 17

tdc\_conv\_cnt[11:0] Reg0, Bits 23 to 14

Sleep mode is activated by setting  $tdc_sleepmode = 1$ . This is equivalent to set avrate = 0.

In sleep mode the conversion counter tdc\_cnv\_cnt () is running to the end and then immediately star-

ting the user program beginning at address 48 in the EEPROM.

After running in sleep mode the TDC has to be reinitialized for measurements.

### PSØ81

#### 6.5.5 CPU Clock Generation

The basic clock for the system is the internal, low-current 10 kHz oscillator. It is used

- to trigger measurements in single conversion mode
- for the TDC unit in measurement range 2 as pre-counter
- as basis for the cycle time in stretched modes

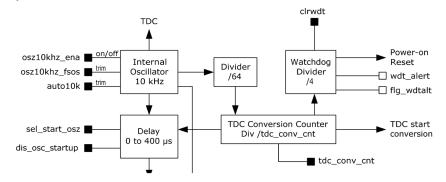


figure 6.4 Clock Generation

#### 6.5.6 Watchdog Counter and Single Conversion Counter

The TDC conversion counter starts a measurement in single conversion mode. It is running continuously. The single conversion rate is given by 10 kHz / 64 / tdc\_conv\_cnt.

With the beginning of a measurement the watchdog counter is increased. The watchdog counts the conversions. At the end of a measurement the microprocessor starts to run the user code. In normal operation the watchdog has to be reset by CLRWDT before the user code ends. The watchdog causes a power-on reset in case the TDC doesn't finish its measurement because of an error or the EEPROM code does not run to end.

It is possible to switch off the watchdog when controlling the PSØ81 by the SPI interface (SPI\_ENA = 1) sending SPI opcode watch\_dog\_off. Further the watchdog is reset by each signal edge at the SPI\_CSN\_RST pin.

#### 6.5.7 Timer

PSØ81has a real time counter that counts autonmatically after a power-on reset in periods of 10 ms. The actual position of this counter can be read from RAM address 29. The counter rolls over at 2<sup>24</sup> bit, which corresponds to a period of 46 hours. The counter can be reset by opcode clearTimer.



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### 7 Miscellaneous

#### 7.1 Migration from PS08 to PS081

The following table shows the differences between PSO8 and PSO81:

	PS08	PS081
EEPROM Program Space:	1Kx8 bit	2Kx8 bit
EEPROM User Space:	2x24 bit	16x24 bit
RAM User Space:	32x24 bit	48x24 bit
Inputs:	max. 5	max. 21
GPIOs (Mult_IO):	1	3
Configuration Registers:	17	19
External LCD via SPI:	no	yes
Opcodes:		same as PSO8 plus:
		- Anti vibration filter
		- Hysteresis
		- Round
		- Gramm to Stone conversion
Package:	QFN56	QFN56
Dice:	2770x2520µm²	2370x3470µm <sup>2</sup>
	Pad: 116µm x 90µm	Pad: 116µm x 90µm

#### Hardware changes:

From a hardware point of view the changes are rather small. If the packaged version is used (QFN56), PS08 can be replaced by PS081 on existing PCBs. Only thing to pay attention to is that Pin 13 and 15 have changed, this is Pin 13 from VCC --> Mult\_IO5 and Pin 15 GND --> Mult\_IO4. So to replace PS08 by PS081 on an existing PCB, there are 2 possibilities:

- don't connect pin 13 and 15 with PS081
- or: connect them, but configure them both as inputs (configreg\_17, en\_io4 and en\_io5)

#### Software changes:

PSO8 has 17 configuration registers (configreg\_00 to configreg\_16). PSO81 has 2 more and configreg\_16 has changed. In other words, you have to put a configuration in the additional registers, in the first instance you can just take the default values recommended in the data sheet.

Some very few opcodes have changed, e.g. no2lcd in the way the parameters are given. In PSO81 there are additional opcodes available such as median, hysteresis or round. A description of the new opcodes and the changes you find in the online help of PSO81 Assembler version. There's also an updated version for the evaluation software.



Other changes:

SPI opcode "Read Access" has changed. In PSO81 the 4 EEPROM cells are addressed subsequently.

The parameter "PSO81Adjust" (configreg\_O3, bit [9:4]) needs to be set in PSO81, if the AV-rate setting is <10. PSO81adjust is thereby to set two times the AV-rate and a minimum of 8. E.g. the AV-rate is 6, then PSO81adjust would be 12.

#### 7.2 Bug Report

Date	Reported Bug	Solution (if any)				
Dec 2009	Cancelation of Full bridge parallel mode (zero drift	Use standard full bridge				
	optimized)	mode				
	Background:					
	This mode was introduced to reduce the zero drift of PSO81 by p	aralleling RDSON				
	resistors on the chip. Intensive tests of several bonding options did unfortunately					
	not show any better behavior, in some cases even worse. Please use standard full					
	bridge mode instead, the systematic offset drift lies here in the range of $\pm 6 nV/$					
	V/K and can be cross matched on the PCB.					
July 2010	If any I/O pin is used as output, a maximum of 4					
	inputs can be configured. In other words, to increase					
	the number of inputs up to 21 is only possible if no					
	output is configured.					
	Background:					
	To increase the number of inputs an internal logic was added to a	connect not only				
	the 6 physical I/Os directly, but also combination of the lines. Thi	s works fine as				
	long as only inputs are configured. In July 2010 it was observed	that as soon as				
	1 pin is configured as output, this internal logic does not work properly any longer.					
	This means, that the register 26, 27 and 28 which are normally	used to indicate				
	the rising, pressed or falling flags of the buttons are not updated properly.					
	So if an output is configured, there are still inputs available, but a	only 4 as maxi-				
	mum and their status need to be checked in status register 22 in	nstead of 26 to				
	28. In this sense, the maximum number of inputs and outputs when used mixed,					
	is input = 3 and output = 3. If you have an application with an up	date rate of >=				
	100 Hz there is another work-around option, please contact the support team of					
	acam in this case.					

May 2012	When exactly two of the six MultIOs are simultaneously '1' and the rest four are
	'O', then a multi input key(Section 4.4.4) is automatically detected. The condition of
	two MultilO pins being at '1' can happen due to any of the following reasons:
	1. For e.g. when two output ports are configured simultaneously to 1 from the
	program.
	2. When two inputs ports are set simultaneously to '1' externally.
	3. When two inputs are configured simultaneously (not one after another) with pull
	up resistors.
	4. When an input is switched simultaneously with an output.
	Regardless of how the condition occurs, as a result the outputs function normally.
	But the status registers showing the input status of MultIOO – MultIO5 (RAM
	address 22 and 26-28) are blocked by the falsely detected multi input. If it occurs
	during configuration then further configuration of the 4 other IOs are blocked.
	Once occurred, this condition can be resolved only by setting each of the previous-
	ly '1' MultIOs to 0.
	Workaround:
	Configure one MultIO port by default to 1 (either as output '1' or as pulled up input)
	permanently. This constant '1' on one MultilO port ensures the suppression of
	the unwanted multi input detection from all the error sources listed. This however
	leaves only 5 MultiIOs for effective usage.
7.3	Known issues and solutions

Issue: (known since July 2012)

where the chip does not react to the  $\ensuremath{\text{I/Os}}$  or interfaces anymore.

Solution:

When supply voltage is reduced, make sure it is reduced to true OV and not only to a level < 0.8V.

#### 7.4 Literature Guide

#### Datasheets

Title	Document-No	Date
PSØ81-EVA Evaluation System for PSØ81	DB_PS081_EVA V1.0	September 2009
ALCS-350 V2 Load Cell Simulator	DB_ALCS_V2 V0.1	August 2009
PicoProg Ø81	DB_PicoProg_Ø81_en_V0.1	January 2010



#### Whitepapers

Title	Document-No	Date
Construction Guideline for solar driven Scales	WP001 V2.0	October 2008
How to Lower Gain and Offset Drift Drift of a Load Cell by using TGGain and TKOff- set Factors of PSØ81	WP002 V1.1	February 2010
Temperature Measurement with PS08	WP003 V1.0	August 2009
How to build Digital Load Cells with PICOSTRAIN conveniently	WP004 V1.0	March 2010

#### **Application Notes**

Title	Document-No	Date
Metrological Investigations of PSØ81 Determining Zero Drift and Gain Drift	AN018 V1.0	July 2008
Strain Gauge Wiring with PICOSTRAIN	AN012 V1.0	August 2005
Rspan by Temp Compensation Compensation of Gain error for uncom- pensated Load Cells	AN021 V0.5	November 2009
Design Guidelines for Building a Solar Kitchen Scale	AN022 V1.3	March 2010
Design Guidelines for Building a Solar Body Scale	AN023 V1.3	September 2009
EMI Countermeasures for a Digital Load Cell	AN025 V1.0	June 2010

All available documents can be downloaded from the acam website at:

#### http://www.acam.de/download-section/picostrain

7.5 Document History

22.06.09	First release of preliminary version
09.07.09	Second release of preliminary version
31.08.09	Release of version VO.3. New Mult_pp factors, new POR circuit, minor corrections
04.09.09	Section 3.3, new figures for load cell wiring, section 5, register numbering
18.12.09	Release of Version V0.5, updating section 3.3 Connecting the SG, cancellation of
	fullbridge paralled mode
15.01.10	Section 4.6.1 added, section "Contacts/Distributors" moved to the end of the



document, literature guide completed

- 12.02.10 Relase version V0.6. Adding new sections 3.6.3 and 3.6.4
- 24.06.10 3.4.6 Resolution updated, 6.3.1 status register corrected, new section 7.1
- 03.08.10 Chapter 4, I/O revised. Chapter 7, bug report.
- 04.07.12 Chapter 4, Figures 4-13 and 4-17 corrected. Bug added to bug report in Chapter 7,

changed Section 7.3.



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## **FICO**STRAIN

PSØ81

### 8 Appendix

8.1 High-Resolution Investigations

To investigate the highest possible resolution of the converter we picked a high quality load cell from HBM and recorded the noise figures. The set up was as follows:

• HBM-SP4C3 load cell, modified to Picostrain wiring

- Only 1 Rspan was used, the other one shortened
- The supply voltage was 4.5 V
- The PCB was the high resolution plug-in module of the evaluation kit
- Median filter was used

Two figures were determined, the noise behavior and the stabilization time. Please see the following

table for an overview:

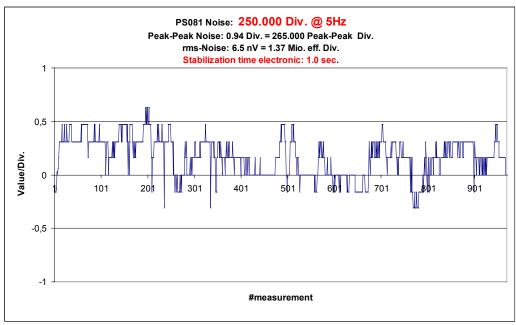
Table 8.1 Resolution

Divisions					
peak-peak	internal (eff.)	eff. Bits	Upate rate	Stabilization time	RMS-noise [nV]
250.000	1.370.000	20.3	5 Hz	1.0 sec.	6.5 nV
150.000	1.040.000	19.9	7.5 Hz	0.6 sec.	9 nV
100.000	680.000	19.3	12 Hz	0.35 sec.	13 nV
80.000	595.000	19.1	16.6 Hz	0.27 sec.	15 nV
60.000	385.000	18.5	30 Hz	0.15 sec.	24 nV

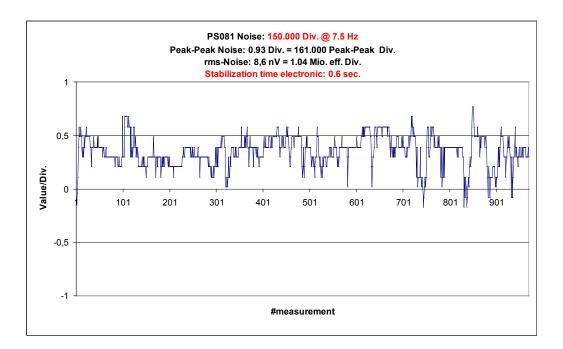
The following 3 noise diagrams show the noise behavior within 1 scale division. In the diagram title

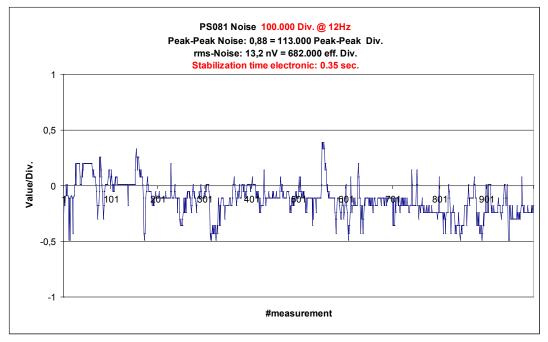
you can see the number of stable scale divisons set, in all cases the noise is deeply within 1 division.  $_{\rm Figure \ 8.1 \ Achievable \ Resolution}$ 

Annotations:

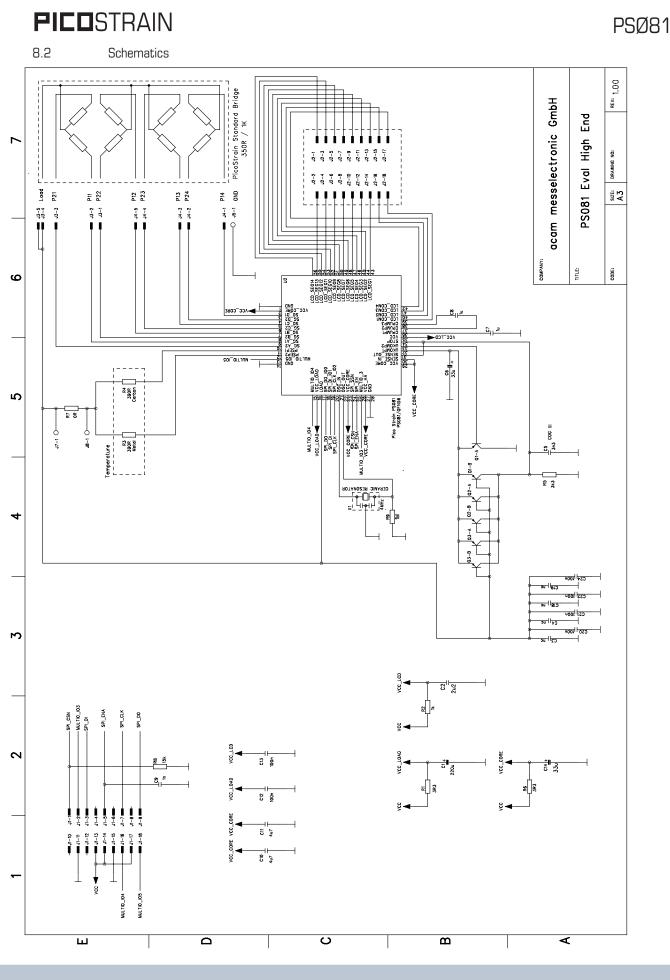








A high resolution as achieved with this set up requires always a good sensor, adapted software and hardware settings. Please contact the acam team in order to get more details when setting up such a high resolution application.



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8.3 Code snippet for external LCD driver In chapter 4 the support of an external LCD driver is explained. The following code snippet shows basically how to program the SPI access to the external LCD driver. A simple measurement example will be available in the assembler software soon. Configuration: equal 0x480540 ; Config Register 64  $\leftarrow$ equal OxEOO7OO  $\,$ ; Config Register 65  $\leftarrow$ equal 0x000000 ; Config Register 66 ← Constant declarations: CONST spi\_chip\_select 9 CONST spi\_data\_out 10 8 CONST spi\_clock 98 CONST lcd\_reg\_low\_read CONST lcd\_reg\_mid\_read 99 CONST spi bus 65 Initialization of Holtek HT1621 (realized as subroutine): init holtek: :set initial state ramadr 65 or r, 0x000700 ;set pins lcd\_spi\_out to 1 ;set duty cycle and number of common segments (Holtek) move y, 0x0004A1 jsub send\_command ;LSB of y is MSB to Holtek!!! ;turn on display (Holtek) move y, 0x000601 jsub send\_command ;turn on bias generator (Holtek) move y, 0x000401 jsub send\_command ;select crystal oscillator (Holtek) move y, 0x000141 jsub send\_command jsubret

```
;send command (fixed to 9+3 bits), supporting routine
send_command:
       ramadr 65
       bitinv r,spi_chip_select
       spi2lcd y, 0x00000C
       ramadr 65
       bitinv r,spi_chip_select
       jsubret
Sending data to Holtek, for 1/4 MUX LCD:
:-----
; 1/4 Multiplex Driver
;-----
;1/4 duty
driver_4:
       ramadr spi_bus
       bitinv r, spi_chip_select
       move y, 0x000005 ;opcode send data for Holtek, set adr 0
       spi2lcd y, 0x000009
       ;first 24 bits
       ramadr lcd_reg_low_read
                                ;reg 98
       move y, r
       spi2lcd y, 0x000018
       ;next 24 bits
       ramadr lcd_reg_mid_read ;reg 99
       move y, r
       spi2lcd y, 0x000018
       ;send last 8 bits, special chars
       ramadr lcd_reg_high
       move y, r
       spi2lcd y, 0x000008
       ramadr spi_bus
       or r, 0x000700 ;set SPI wires back to high
       jsubret
```



Call the subroutine(s):

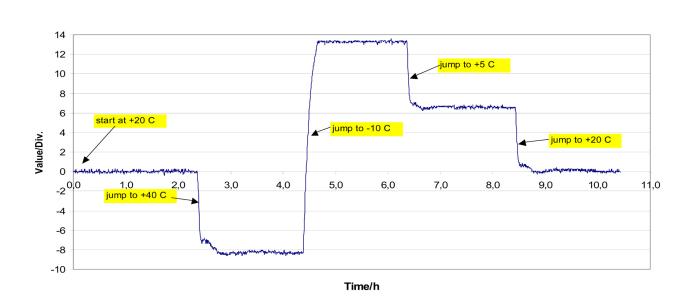
ramadr 20 ;HBO result move x, r no2lcd x, 1 ;------ displaying on external LCD -----newlcd jsub driver\_4

Note:

This code snippet show the relevant code to drive an external LCD via SPI. It's not a complete example. Please make sure that the LCD driver is connected properly (connect LCD pins in parallel as shown in chapter 4).

8.4 Long Term Offset-Drift Investigations

In August 2009 acam did some long-term offset drift investigations. In the setup the ports of the PSO8 were short-cutted (by a resistor) and the board put into the temperature chamber. In a 10 hours run the temperature cylce  $+20^{\circ}C \rightarrow +40^{\circ}C \rightarrow -10^{\circ}C \rightarrow +5^{\circ}C \rightarrow +20^{\circ}C$  was run. Please see in the following diagrams the results:



ZeroDrift PS08 with shortcutted ports on PS08; 2mV/V = 100.000 Div Temp Sequence: +20 C --> +40 C --> -10 C --> +5 C --> +20 C Duration of complete run: 10 h

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The offset drift is very low and lies deeply within OIML 6000 limits as shown in the following diagram:

